Quad Input, 10-Output, Dual DPLL, 1 pps Synchronizer and Jitter Cleaner

Data Sheet **AD9544**

FEATURES

- Dual DPLL synchronizes 1 Hz to 750 MHz physical layer clocks providing frequency translation with jitter cleaning of noisy references
- Complies with ITU-T G.8262 and Telcordia GR-253
- Supports Telcordia GR-1244, ITU-T G.812, G.813, G.823, G.824, and G.825
- Continuous frequency monitoring and reference validation for frequency deviation as low as 50 ppb
- Both DPLLs feature a 24-bit fractional divider with 24-bit programmable modulus
- Programmable digital loop filter bandwidth: 10^{-4} Hz to 1850 Hz
- Automatic and manual holdover and reference switchover, providing zero delay, hitless, or phase buildout operation
- Programmable priority-based reference switching with manual, automatic revertive, and automatic nonrevertive modes supported
- 5 pairs of clock output pins with each pair useable as differential LVDS/HCSL/CML or as 2 single-ended outputs (1 Hz to 500 MHz)
- 2 differential or 4 single-ended input references
- Crosspoint mux interconnects reference inputs to PLLs
- Supports embedded (modulated) input/output clock signals
- Fast DPLL locking modes
- Provides internal capability to combine the low phase noise of a crystal resonator or crystal oscillator with the frequency stability and accuracy of a TCXO or OCXO
- External EEPROM support for autonomous initialization
- Single 1.8 V power supply operation with internal regulation
- Built in temperature monitor/alarm and temperature compensation for enhanced zero delay performance

APPLICATIONS

- SyncE and GPS synchronization and jitter cleanup
- Optical transport networks (OTN), SDH, and macro and small cell base stations
- OTN mapping/demapping with jitter cleaning
- Small base station clocking, including baseband and radio
- Stratum 2, Stratum 3e, and Stratum 3 holdover, jitter cleanup, and phase transient control
- JESD204B support for analog-to-digital converter (ADC) and digital-to-analog converter (DAC) clocking
- Cable infrastructures
- Carrier Ethernet

GENERAL DESCRIPTION

The 10 clock outputs of the AD9544 are synchronized to any one of up to four input references. The digital phase-locked loops (DPLLs) reduce timing jitter associated with the external references. The digitally controlled loop and holdover circuitry continuously generate a low jitter output signal, even when all reference inputs fail.

The AD9544 is available in a 48-lead LFCSP (7 mm × 7 mm) package and operates over the −40°C to +85°C temperature range.

Note that throughout this data sheet, multifunction pins, such as SDO/M5, are referred to either by the entire pin name or by a single function of the pin, for example, M5, when only that function is relevant.

Rev. 0 Document Feedback
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781.329.4700 ©2017 Analog Devices, Inc. All rights reserved.
Technical Support www.analog.com

TABLE OF CONTENTS

Features ... 1
Applications ... 1
General Description ... 1
Revision History ... 3
Functional Block Diagram ... 4
Specifications ... 5
Supply Voltage ... 5
Supply Current ... 5
Power Dissipation ... 5
System Clock Inputs, XOA and XOB ... 6
Reference Inputs ... 7
Reference Monitors ... 8
DPLL Phase Characteristics ... 8
Distribution Clock Outputs ... 9
Time Duration of Digital Functions ... 10
Digital PLL (DPLL0, DPLL1) Specifications ... 10
Digital PLL Lock Detection Specifications ... 11
Holdover Specifications ... 11
Analog PLL (APLL0, APLL1) Specifications ... 11
Output Channel Divider Specifications ... 11
System Clock Compensation Specifications ... 12
Temperature Sensor Specifications ... 12
Serial Port Specifications ... 12
Logic Input Specifications (RESETB, M0 to M6) ... 14
Logic Output Specifications (M0 to M6) ... 14
Jitter Generation (Random Jitter) ... 14
Phase Noise ... 15
Absolute Maximum Ratings ... 19
Thermal Resistance ... 19
ESD Caution ... 19
Pin Configuration and Function Descriptions ... 20
Typical Performance Characteristics ... 22
Terminology ... 26
Theory of Operation ... 27
Overview ... 27
Reference Input Physical Connections ... 27
Input/Output Termination Recommendations ... 28
System Clock Inputs ... 28
Reference Clock Inputs ... 28
Clock Outputs ... 29
System Clock PLL ... 30
System Clock Input Frequency Declaration ... 30
System Clock Source ... 30
2× Frequency Multiplier ... 31
Prescale Divider ... 31
Feedback Divider ... 31
System Clock PLL Output Frequency ... 31
System Clock PLL Lock Detector ... 31
System Clock Stability Timer ... 31
System Clock Input Termination Recommendations ... 31
Digital PLL (DPLL) ... 32
Overview ... 32
DPLL Phase/Frequency Lock Detectors ... 32
DPLL Loop Controller ... 32
Applications Information ... 33
Optical Networking Line Card ... 33
Small Cell Base Station ... 34
Initialization Sequence ... 35
Status and Control Pins ... 38
Multifunction Pins at Reset/Power-Up ... 39
Status Functionality ... 39
Control Functionality ... 39
Interrupt Request (IRQ) ... 44
IRQ Monitor ... 44
IRQ Mask ... 44
IRQ Clear ... 44
Watchdog Timer ... 46
Lock Detectors ... 47
DPLL Lock Detectors ... 47
Phase Step Detector ... 49
Phase Step Limit ... 49
Skew Adjustment ... 50
EEPROM Usage ... 51
Overview ... 51
EEPROM Controller General Operation ... 51
EEPROM Instruction Set ... 52
Multidevice Support ... 54
Serial Control Port ... 56
SPI/I²C Port Selection ... 56
SPI Serial Port Operation ... 56

I²C Serial Port Operation 59
Outline Dimensions 62
Ordering Guide 62

REVISION HISTORY

10/2017—Revision 0: Initial Version

FUNCTIONAL BLOCK DIAGRAM

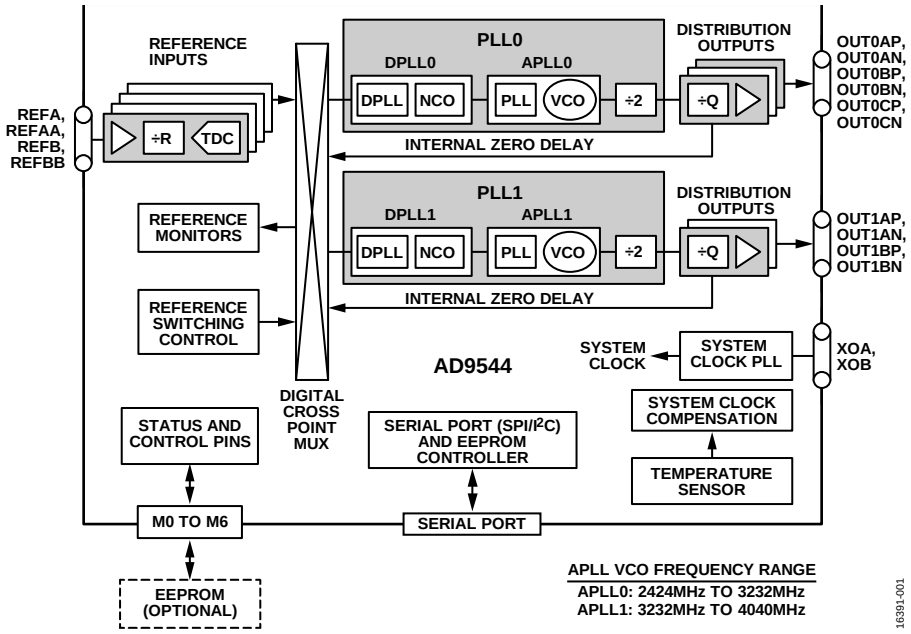


Figure 1.

SPECIFICATIONS

The minimum and maximum values apply for the full range of the supply voltage and operating temperature variations. The typical values apply for VDD = 1.8 V and T_A = 25°C, unless otherwise noted.

SUPPLY VOLTAGE

Table 1.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY VOLTAGE					
VDDIOA, VDDIOB	1.71	1.8	3.465	V	1.8 V, 2.5 V, and 3.3 V operation supported
VDD	1.71	1.8	1.89	V	

SUPPLY CURRENT

The maximum supply voltage values given in Table 1 are the basis for the maximum supply current specifications. The typical supply voltage values given in Table 1 are the basis for the typical supply current specifications. The minimum supply voltage values given in Table 1 are the basis for the minimum supply current specifications.

Table 2.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
SUPPLY CURRENT FOR TYPICAL CONFIGURATION					The Typical Configuration specification in Table 3 is the basis for the values shown in this section
I_{VDDIOx}		5	8	mA	Aggregate current for all VDDIOx pins (where x = A or B)
I_{VDD}	260	310	355	mA	Aggregate current for all VDD pins
SUPPLY CURRENT FOR ALL BLOCKS RUNNING CONFIGURATION					The All Blocks Running condition in Table 3 is the basis for the values shown in this section
I_{VDDIOx}		5	8	mA	Aggregate current for all VDDIOx pins (where x = A or B)
I_{VDD}	321	390	430	mA	Aggregate current for all VDD pins

POWER DISSIPATION

The typical values apply for VDD = 1.8 V, and the maximum values apply for VDD = 1.89 V.

Table 3.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
POWER DISSIPATION					
Typical Configuration	445	560	671	mW	System clock = 49.152 MHz crystal; two DPLLs active; two 19.44 MHz input references in differential mode; two ac-coupled PLL0 CML output drivers at 245.76 MHz; and two PLL1 CML output drivers at 156.25 MHz
All Blocks Running	548	700	813	mW	System clock = 49.152 MHz crystal; two DPLLs active; two 19.44 MHz input references in differential mode; three ac-coupled PLL0 HCSL output drivers at 400 MHz; and two PLL1 HCSL output drivers at 400 MHz
Full Power-Down		125		mW	Based on the Typical Configuration specification with the power down all bit set to Logic 1
Incremental Power Dissipation					Based on the Typical Configuration specification; the values in this section indicate the change in power due to the indicated operation relative to the Typical Configuration specification
Complete DPLL/APLL On/Off		200		mW	Change in dissipated power relative to the Typical Configuration specification; the blocks, powered down, consist of one reference input, one DPLL, one APLL, two channel dividers, and two output drivers
Incremental Power Dissipation					
Complete DPLL/APLL On/Off		200		mW	Based on the Typical Configuration specification; the values in this section indicate the change in power due to the indicated operation relative to the Typical Configuration specification; the blocks, powered down, consist of one reference input, one DPLL, one APLL, two channel dividers, and two output drivers

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Input Reference On/Off					
Differential (Normal Mode)		20		mW	f_{REF} = 19.44 MHz
Differential (DC-Coupled LVDS)		21		mW	f_{REF} = 19.44 MHz
Single-Ended		13		mW	f_{REF} = 19.44 MHz
Output Distribution Driver On/Off					At 156.25 MHz
15 mA Mode		30		mW	
12 mA Mode		23		mW	
7.5 mA Mode		15		mW	
Auxiliary DPLL On/Off		1		mW	

SYSTEM CLOCK INPUTS, XOA AND XOB

Table 4.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
SYSTEM CLOCK MULTIPLIER					
Output Frequency Range	2250		2415	MHz	The frequency range of the internal voltage controlled oscillator (VCO) places limits on the choice of the system clock input frequency
Phase Frequency Detector (PFD) Rate	20		300	MHz	
SYSTEM CLOCK REFERENCE INPUT PATH					System clock input must be ac-coupled
Input Frequency Range					
System Clock Input Doubler					
Disabled	20		300	MHz	Support of oven controlled crystal oscillators (OCXOs) < 20 MHz is possible using the auxiliary DPLL for system clock frequency compensation
Enabled	16		150	MHz	
Self Biased Common-Mode Voltage		0.75		V	Internally generated
Input Voltage					For dc-coupled, single-ended operation
High	0.9			V	
Low			0.5	V	
Differential Input Voltage Sensitivity	250			mV p-p	Minimum voltage swing required (as measured with a differential probe) across the XOA/XOB pins to ensure switching between logic states; the instantaneous voltage on either pin must not exceed 1.2 V; accommodate the single-ended input by ac grounding the complementary input; 800 mV p-p recommended for optimal jitter performance
Slew Rate for Sinusoidal Input	50			V/µs	Minimum input slew rate for device operation; oscillators with square wave outputs are recommended if not using a crystal
System Clock Input Divider (J Divider) Frequency	100			MHz	
System Clock Input Doubler Duty Cycle					Tolerable duty cycle variation on the system clock input when using the frequency doubler
20 MHz to 150 MHz	43	50	57	%	
16 MHz to 20 MHz	47	50	53	%	
Input Resistance		5		kΩ	
QUARTZ CRYSTAL RESONATOR PATH					
Resonator Frequency Range	25		60	MHz	Fundamental mode, AT cut crystal
Crystal Motional Resistance			100	Ω	A maximum motional resistance of 50 Ω , and maximum C_{LOAD} of 8 pF is strongly recommended for crystals >52 MHz

REFERENCE INPUTS

Table 5.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DIFFERENTIAL MODE					Differential mode specifications assume ac coupling of the input signal to the reference input pins
Frequency Range					
Sinusoidal Input			750	MHz	Lower limit dependent on input slew rate
LVPECL Input	1		750×10^6	Hz	Lower limit dependent on ac coupling; 1 Hz is equivalent to 1 pulse per second (pps)
LVDS Input	1		500×10^6	Hz	Assumes an LVDS minimum of 494 mV p-p differential amplitude; lower limit dependent on ac coupling
Slew Rate for Sinusoidal input	20			V/µs	Minimum input slew rate for device operation; jitter degradation may occur for slew rates < 35 V/µs
Common-Mode Input Voltage		0.64		V	Internally generated self bias voltage
Differential Input Amplitude					Peak-to-peak differential voltage swing across pins required to ensure switching between logic levels as measured with a differential probe; instantaneous voltage on either pin must not exceed 1.3 V
f_{IN} < 500 MHz	350		2100	mV p-p	
f_{IN} = 500 MHz to 750 MHz	500		2100	mV p-p	
Differential Input Voltage Hysteresis		55	100	mV	
Input Resistance		16		kΩ	Equivalent differential input resistance
Input Pulse Width					
LVPECL	600			ps	
LVDS	900			ps	
DC-COUPLED, LVDS-COMPATIBLE MODE					Applies for dc-coupling to an LVDS source
Frequency Range	1		450×10^6	Hz	
Common-Mode Input Voltage	1.125		1.375	V	
Differential Input Amplitude	400		1200	mV p-p	Differential voltage across pins required to ensure switching between logic levels; instantaneous voltage on either pin must not exceed the supply rails
Differential Input Voltage Hysteresis		55	100	mV	
Input Resistance		16		kΩ	
Input Pulse Width	1			ns	
SINGLE-ENDED MODE					Single-ended mode specifications assume dc coupling of the input signal to the reference input pins
Frequency Range					
1.2 V AC-Coupled	1		500×10^6	Hz	Lower limit dependent on ac-coupling
1.2 V and 1.8 V CMOS	1		500×10^6	Hz	CMOS specifications assume dc coupling of the input signal to the reference input pins
1.2 V AC-Coupled Common-Mode Voltage		610		mV	Internally generated self-bias voltage
Input Amplitude (Single-Ended, AC-Coupled Mode)	360		1200	mV p-p	Peak-to-peak single-ended voltage swing; instantaneous voltage must not exceed 1.3 V
1.2 V and 1.8 V CMOS Input Voltage					
High, V_{IH}	$0.65 \times V_{REF}$		$1.15 \times V_{REF}$	V	V_{REF} is determined by operating mode of the CMOS input receiver, 1.2 V or 1.8 V
Low, V_{IL}			$0.35 \times V_{REF}$	V	
Input Resistance					
DC-Coupled Single-Ended Mode		30		kΩ	
AC-Coupled Single-Ended Mode		15		kΩ	
Input Pulse Width	900			ps	

REFERENCE MONITORS

Table 6.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
REFERENCE MONITORS					
Reference Monitor					
Loss of Reference Detection Time		$4.9 + 0.13 \times t_{PFD}$		µs	t_{PFD} is the nominal phase detector period, R/f_{REF}, where R is the frequency division factor determined by the R divider, and f_{REF} is the frequency of the active reference
Frequency Out of Range Limits	50		1.5×10^7	ppb	Parts per billion (ppb) is defined as $\Delta f/f_{REF}$, where Δf is the frequency deviation, and f_{REF} is the reference input frequency; programmable with the lower bound, subject to quality of the system clock (or the source of system clock compensation); 1.5×10^7 is equivalent to 1.5%
Validation Timer	0.001		1048	sec	Programmable in 1 ms increments
Excess Jitter Alarm Threshold	1		65535	ns	Programmable in 1 ns increments

DPLL PHASE CHARACTERISTICS

Table 7.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
MAXIMUM OUTPUT PHASE PERTURBATION					Assumes a jitter free reference; satisfies Telcordia GR-1244-CORE requirements; 0 ppm frequency difference between references; reference switch initiated via register map (see the AD9544 Register Map Reference Manual) by faulting the active reference input
Phase Refinement Disabled					50 Hz DPLL loop bandwidth; normal phase margin mode; frequency translation = 19.44 MHz to 155.52 MHz; 49.152 MHz signal generator used for system clock source
Peak		±20	±140	ps	
Steady State					
Phase Buildout Operation		±18	±125	ps	
Hitless Operation		0		ps	
Phase Refinement Enabled					50 Hz DPLL loop bandwidth; high phase margin mode; phase refinement iterations = 4; frequency translation = 19.44 MHz to 155.52 MHz; 49.152 MHz signal generator used for system clock source
Peak		±5	±40	ps	
Steady State					
Phase Buildout Operation		±4	±35	ps	
Hitless Operation		0		ps	
PHASE SLEW LIMITER	0.001		250	µs/sec	See the AN-1420 Application Note, *Phase Buildout and Hitless Switchover with Digital Phase-Locked Loops (DPLLs)*

DISTRIBUTION CLOCK OUTPUTS

Table 8.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DIFFERENTIAL MODE					All testing is both ac-coupled and dc-coupled
Output Frequency					Frequency range determined by driver functionality; actual frequency synthesis may be limited by the APLL VCO frequency range
CML	1		500×10^6	Hz	Terminated per Figure 33
HCSL	1		500×10^6	Hz	Terminated per Figure 32
Differential Output Voltage Swing					Voltage between output pins measured with output driver static; peak-to-peak differential output amplitude is twice that shown when driver is toggling and measured using a differential probe
Output Current = 7.5 mA					
HCSL	312	368	402	mV	Terminated per Figure 32
CML	257	348	408	mV	Terminated to VDD (nominal 1.8 V) per Figure 33
Output Current = 15 mA					
HCSL	631	745	809	mV	Terminated per Figure 32
CML	578	729	818	mV	Terminated to VDD (nominal 1.8 V) per Figure 33
Common-Mode Output Voltage					
Output Current = 7.5 mA					
HCSL	155	184	201	mV	Terminated per Figure 32
CML	VDD − 208	VDD − 188	VDD − 169	mV	Terminated to VDD (nominal 1.8 V) per Figure 33 (maximum common-mode voltage case occurs at the minimum amplitude)
Output Current = 15 mA					
HCSL	316	372	405	mV	Terminated per Figure 32
CML	VDD − 416	VDD − 371	VDD − 327	mV	Terminated to VDD (nominal 1.8 V) per Figure 33 (maximum common-mode voltage case occurs at the minimum amplitude)
SINGLE-ENDED MODE					
Output Frequency	1		500×10^6	Hz	Frequency range determined by driver functionality; actual frequency synthesis may be limited by the APLL VCO frequency range
Output Current = 12 mA					
Voltage Swing (Peak-to-Peak)					
HCSL Driver Mode	509	584	634	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$
CML Driver Mode	456	565	644	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$ connected to VDD (nominal 1.8 V) instead of GND
Voltage Swing Midpoint					
HCSL Driver Mode	255	292	317	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$
CML Driver Mode	VDD − 325	VDD − 291	VDD − 266	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$ connected to VDD (nominal 1.8 V) instead of GND
Output Current = 15 mA					
Voltage Swing (Peak-to-Peak)					
HCSL Driver Mode	645	734	796	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$
CML Driver Mode	589	721	815	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$ connected to VDD (nominal 1.8 V) instead of GND
Voltage Swing Midpoint					
HCSL Driver Mode	322	367	398	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$
CML Driver Mode	VDD − 411	VDD − 367	VDD − 334	mV	Each output terminated per Figure 37 with $R_L = 50\ \Omega$ connected to VDD (nominal 1.8 V) instead of GND

TIME DURATION OF DIGITAL FUNCTIONS

Table 9.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
TIME DURATION OF DIGITAL FUNCTIONS					
EEPROM to Register Download Time		10		ms	Using the Typical Configuration from Table 3
Power-On Reset (POR)			25	ms	Time from power supplies > 80% to release of internal reset
Mx Pin to RESETB Rising Edge Setup Time			1	ns	Mx refers to Pin M0 through Pin M6
Mx Pin to RESETB Rising Edge Hold Time			2	ns	
Multiple Mx Pin Timing Skew			39	ns	Applies only to multibit Mx pin functions
RESETB Falling Edge to Mx Pin High-Z Time			14	ns	
TIME FROM START OF DPLL ACTIVATION TO ACTIVE PHASE DETECTOR OUTPUT					
Untagged Operation			10	t_{PFD}	t_{PFD} is the nominal phase detector period given by R/f_{REF}, where R is the frequency division factor determined by the R divider, and f_{REF} is the frequency of the active reference
Tagged Operation			10	Tag period	Tag period = (tag ratio/f_{TAG}), where f_{TAG} is either f_{REF} (for tagged reference mode) or $f_{FEEDBACK}$ (for all other tagged modes); the tag ratio corresponds to the selection of f_{TAG}

DIGITAL PLL (DPLL0, DPLL1) SPECIFICATIONS

Table 10.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DIGITAL PLL					
Digital Phase Detector (DPD) Input Frequency Range	1		2×10^5	Hz	
Loop Filter					
Profile 0					
Bandwidth	0.0001		1850	Hz	Programmable design parameter; (f_{PFD}/bandwidth) ≥ 20
Phase Margin		70		Degrees	
Closed-Loop Peaking		1.1		dB	
Profile 1					
Bandwidth	0.0001		305	Hz	Programmable design parameter; (f_{PFD}/bandwidth) ≥ 20
Phase Margin		88.5		Degrees	
Closed-Loop Peaking			0.1	dB	In accordance with Telcordia GR-253-CORE jitter transfer specifications
DIGITAL PLL NCO Division Ratio					These specifications cover limitations on the DPLLx frequency tuning word (FTW0); the AD9544 evaluation software frequency planning wizard sets these values automatically for the user, and the AD9544 evaluation software is available for download from the AD9544 product page; NCO division = 2^{48}/FTW0, which takes the form INT.FRAC, where INT is the integer portion, and FRAC is the fractional portion
NCO Integer	7		13		This is the integer portion of NCO division ratio
NCO Fraction	0.05		0.95		This is the fractional portion of NCO division ratio

DIGITAL PLL LOCK DETECTION SPECIFICATIONS

Table 11.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
PHASE LOCK DETECTOR					
Threshold Programming Range	10		$2^{24} - 1$	ps	
Threshold Resolution		1		ps	
FREQUENCY LOCK DETECTOR					
Threshold Programming Range	10		$2^{24} - 1$	ps	
Threshold Resolution		1		ps	
PHASE STEP DETECTOR					
Threshold Programming Range	100		$2^{32} - 1$	ps	Setting this value too low causes false triggers
Threshold Resolution		1		ps	

HOLDOVER SPECIFICATIONS

Table 12.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
HOLDOVER SPECIFICATIONS					
Initial Frequency Accuracy		±0.01	±0.1	ppb	AD9544 is configured using Configuration 1 from Table 21; excludes frequency drift of system clock (SYSCLK) source; excludes frequency drift of input reference prior to entering holdover; 160 ms history timer; history holdoff setting of 8; three holdover history features (bits) are enabled: delay history until frequency lock bit, delay history until phase lock bit, and delay holdover history accumulation until not phase slew limited bit
Relative Frequency Accuracy Between Channels					
Cascaded Operation		0		ppb	
History Averaging Window	0.001		268435	sec	

ANALOG PLL (APLL0, APLL1) SPECIFICATIONS

Table 13.

Parameter	Min	Typ	Max	Unit
VCO FREQUENCY RANGE				
Analog PLL0 (APLL0)	2424		3232	MHz
Analog PLL1 (APLL1)	3232		4040	MHz
PHASE FREQUENCY DETECTOR (PFD) INPUT FREQUENCY RANGE	162		350	MHz
LOOP BANDWIDTH		260		kHz
PHASE MARGIN		68		Degrees

OUTPUT CHANNEL DIVIDER SPECIFICATIONS

Table 14.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
OUTPUT PHASE ADJUST STEP SIZE	1			t_{VCO}	t_{VCO} = 1/(APLLx VCO frequency), where x = 0, 1

SYSTEM CLOCK COMPENSATION SPECIFICATIONS

Table 15.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DIRECT COMPENSATION					
Resolution		0.028		ppt	ppt is parts per trillion (10^{-12})
CLOSED-LOOP COMPENSATION (AUXILIARY DPLL)					
Phase Detector Frequency	2		200	kHz	
Loop Bandwidth	0.1		2×10^3	Hz	
Reference Monitor Threshold		5		%	

TEMPERATURE SENSOR SPECIFICATIONS

Table 16.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
TEMPERATURE					
Accuracy					T_A = −50°C to +110°C
Absolute		5		°C	
Relative		1.7		%	
Resolution		0.0078		°C	16-bit (signed) resolution
Conversion Time		0.18		ms	
REPEATABILITY		±0.02		°C	T_A = 25°C
DRIFT		0.1		°C	500 hour stress test at 100°C

SERIAL PORT SPECIFICATIONS

Serial Port Interface (SPI) Mode

Table 17.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
CSB					Valid for VDDIOA = 3.3 V, 1.8 V, and 2.5 V
Input Logic 1 Voltage	VDDIOA – 0.4			V	
Input Logic 0 Voltage			0.4	V	
Input Logic 1 Current		1		µA	
Input Logic 0 Current		1		µA	
SCLK					
Input Logic 1 Voltage	VDDIOA – 0.4			V	
Input Logic 0 Voltage			0.4	V	
Input Logic 1 Current		1		µA	
Input Logic 0 Current		1		µA	
SDIO					
As an Input					
Input Logic 1 Voltage	VDDIOA – 0.4			V	
Input Logic 0 Voltage			0.4	V	
Input Logic 1 Current		1		µA	
Input Logic 0 Current		1		µA	
As an Output					
Output Logic 1 Voltage	VDDIOA – 0.2			V	1 mA load current
Output Logic 0 Voltage			0.2	V	1 mA load current
SDO					
Output Logic 1 Voltage	VDDIOA – 0.2			V	1 mA load current
Output Logic 0 Voltage			0.2	V	1 mA load current
Leakage Current			±1	µA	SDO inactive (high impedance)

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
TIMING					Valid for VDDIOA = 3.3 V, 1.8 V, and 2.5 V
SCLK					
Clock Rate, $1/t_{CLK}$			50	MHz	
Pulse Width High, t_{HIGH}	5			ns	
Pulse Width Low, t_{LOW}	9			ns	
SDIO to SCLK Setup, t_{DS}	2.2			ns	
SCLK to SDIO Hold, t_{DH}	0			ns	
SCLK to Valid SDIO and SDO, t_{DV}			9	ns	
CSB to SCLK Setup, t_S	1.5			ns	
CSB to SCLK Hold, t_C	0			ns	
CSB Minimum Pulse Width High	1			t_{CLK}	

I²C Mode

Table 18.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
SDA, SCL (AS INPUTS)					Valid for VDDIOA = 3.3 V, 1.8 V, and 2.5 V
Input Logic 1 Voltage	70			% of VDDIOA	
Input Logic 0 Voltage			0.3 × VDDIOA	V	
Input Current	−10		+10	µA	For V_{IN} = 10% to 90% of VDDIOA
Hysteresis of Schmitt Trigger Inputs	1.5			% of VDDIOA	
SDA (AS OUTPUT)					
Output Logic 0 Voltage			0.2	V	I_{OUT} = 3 mA
Output Fall Time from V_{IH} Minimum to V_{IL} Maximum	$20 + 0.1 \times C_B$		250	ns	10 pF ≤ C_B ≤ 400 pF
TIMING					
SCL Clock Rate			400	kHz	
Bus Free Time Between a Stop and Start Condition, t_{BUF}	1.3			µs	
Repeated Start Condition Setup Time, $t_{SU;STA}$	0.6			µs	
Repeated Hold Time Start Condition, $t_{HD;STA}$	0.6			µs	After this period, the first clock pulse is generated
Stop Condition Setup Time, $t_{SU;STO}$	0.6			µs	
Low Period of the SCL Clock, t_{LOW}	1.3			µs	
High Period of the SCL Clock, t_{HIGH}	0.6			µs	
SCL/SDA Rise Time, t_R	$20 + 0.1 \times C_B$		300	ns	
SCL/SDA Fall Time, t_F	$20 + 0.1 \times C_B$		300	ns	
Data Setup Time, $t_{SU;DAT}$	100			ns	
Data Hold Time, $t_{HD;DAT}$	100			ns	
Capacitive Load for Each Bus Line, C_B			400	pF	

LOGIC INPUT SPECIFICATIONS (RESETB, M0 TO M6)

Table 19.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
RESETB					Valid for 3.3 V ≥ VDDIOA ≥ 1.8 V; internal 100 kΩ pull-up resistor
Input High Voltage (V_{IH})	VDDIOA − 0.4			V	
Input Low Voltage (V_{IL})			0.4	V	
Input Current High (I_{INH})		1		µA	
Input Current Low (I_{INL})		±15	±125	µA	
LOGIC INPUTS (M0 to M6)					Valid for 3.3 V ≥ VDDIOx ≥ 1.8 V; VDDIOA applies to the M5 pin and the M6 pin; VDDIOB applies to the M0, M1, M2, M3, and M4 pins; the M3 and M4 pins have internal 100 kΩ pull-down resistors
Frequency Range			51	MHz	
Input High Voltage (V_{IH})	VDDIOx − 0.4			V	
Input Low Voltage (V_{IL})			0.4	V	
Input Current (I_{INH}, I_{INL})		±15	±125	µA	

LOGIC OUTPUT SPECIFICATIONS (M0 TO M6)

Table 20.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
LOGIC OUTPUTS (M0 to M6)					Valid for 3.3 V ≥ VDDIOx ≥ 1.8 V; VDDIOA applies for the M5 and M6 pins; VDDIOB applies for M0 to M4; normal (default) output drive current setting for M0 through M6
Frequency Range			26	MHz	
Output High Voltage (V_{OH})	VDDIOx − 0.6			V	Load current = 10 mA
	VDDIOx − 0.2			V	Load current = 1 mA
Output Low Voltage (V_{OL})			0.6	V	Load current = 10 mA
			0.2	V	Load current = 1 mA

JITTER GENERATION (RANDOM JITTER)

Table 21.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
JITTER GENERATION					System clock doubler enabled; high phase margin mode enabled; there is not a significant jitter difference between driver modes
Channel 0—DPLL0, APLL0					Channel 1 powered down
RMS Jitter (12 kHz to 20 MHz)					
Configuration 1—155.52 MHz		223		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 38.88 MHz, f_{VCO} = 2488.32 MHz, f_{OUT} = 155.52 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
Configuration 2—245.76 MHz		220		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 30.72 MHz, f_{VCO} = 2457.6 MHz, f_{OUT} = 245.76 MHz, BW_{DPLL} = 50 Hz, internal zero delay operation
Configuration 3—491.52 MHz		235		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz temperature compensated crystal oscillator (TCXO), BW_{COMP} = 50 Hz, f_{REF} = 1 Hz, f_{VCO} = 2949.12 MHz, f_{OUT} = 491.52 MHz, BW_{DPLL} = 50 mHz, phase buildout operation
Configuration 4—125 MHz		213		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 125 MHz, f_{VCO} = 2500 MHz, f_{OUT} = 125 MHz, BW_{DPLL} = 0.1 Hz, phase buildout operation
Configuration 5—312.5 MHz		217		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 25 MHz, f_{VCO} = 2500 MHz, f_{OUT} = 312.5 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
Configuration 6—174.7030837 MHz		230		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 155.52 MHz, f_{VCO} = 2620.5463 MHz, f_{OUT} = (155.52 × 255/227) MHz, BW_{DPLL} = 50 Hz

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Channel 1—DPLL1, APLL1					Channel 0 powered down
RMS Jitter (12 kHz to 20 MHz)					
Configuration 1—155.52 MHz		247		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 38.88 MHz, f_{VCO} = 3265.92 MHz, f_{OUT} = 155.52 MHz, BW_{DPLL} = 50 Hz, phase buildout operation, half divide enabled
Configuration 2—245.76 MHz		280		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 30.72 MHz, f_{VCO} = 3686.4 MHz, f_{OUT} = 245.76 MHz, BW_{DPLL} = 50 Hz, half divide enabled, internal zero delay operation
Configuration 3—491.52 MHz		323		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 1 Hz, f_{VCO} = 3932.16 MHz, f_{OUT} = 491.52 MHz, BW_{DPLL} = 50 mHz, phase buildout operation
Configuration 4—125 MHz		243		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 125 MHz, f_{VCO} = 3250 MHz, f_{OUT} = 125 MHz, BW_{DPLL} = 0.1 Hz, phase buildout operation
Configuration 5—312.5 MHz		266		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 25 MHz, f_{VCO} = 3750 MHz, f_{OUT} = 312.5 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
Configuration 6—174.7030837 MHz		264		fs	Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 155.52 MHz, f_{VCO} = 3319.3586 MHz, f_{OUT} = (155.52 × 255/227) MHz, BW_{DPLL} = 50 Hz, phase buildout operation

PHASE NOISE

Table 22.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
PHASE NOISE					System clock doubler enabled; high phase margin mode enabled; there is not a significant jitter difference between driver modes
Channel 0—DPLL0, APLL0					Channel 1 powered down
RMS Jitter (12 kHz to 20 MHz)					
Configuration 1—155.52 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 38.88 MHz, f_{VCO} = 2488.32 MHz, f_{OUT} = 155.52 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
10 Hz Offset		−81		dBc/Hz	
100 Hz Offset		−98		dBc/Hz	
1 kHz Offset		−118		dBc/Hz	
10 kHz Offset		−128		dBc/Hz	
100 kHz Offset		−134		dBc/Hz	
1 MHz Offset		−144		dBc/Hz	
10 MHz Offset		−158		dBc/Hz	
Floor		−161		dBc/Hz	
Configuration 2—245.76 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 30.72 MHz, f_{VCO} = 2457.6 MHz, f_{OUT} = 245.76 MHz, BW_{DPLL} = 50 Hz, internal zero delay operation
10 Hz Offset		−77		dBc/Hz	
100 Hz Offset		−93		dBc/Hz	
1 kHz Offset		−114		dBc/Hz	
10 kHz Offset		−125		dBc/Hz	
100 kHz Offset		−130		dBc/Hz	
1 MHz Offset		−140		dBc/Hz	
10 MHz Offset		−156		dBc/Hz	
Floor		−161		dBc/Hz	

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Configuration 3—491.52 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 1 Hz, f_{VCO} = 2949.12 MHz, f_{OUT} = 491.52 MHz, BW_{DPLL} = 50 mHz, phase buildout operation
10 Hz Offset		−74		dBc/Hz	
100 Hz Offset		−89		dBc/Hz	
1 kHz Offset		−108		dBc/Hz	
10 kHz Offset		−119		dBc/Hz	
100 kHz Offset		−123		dBc/Hz	
1 MHz Offset		−134		dBc/Hz	
10 MHz Offset		−152		dBc/Hz	
Floor		−159			
Configuration 4—125 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 125 MHz, f_{VCO} = 2500 MHz, f_{OUT} = 125 MHz, BW_{DPLL} = 0.1 Hz, phase buildout operation
10 Hz Offset		−84		dBc/Hz	
100 Hz Offset		−106		dBc/Hz	
1 kHz Offset		−120		dBc/Hz	
10 kHz Offset		−131		dBc/Hz	
100 kHz Offset		−136		dBc/Hz	
1 MHz Offset		−147		dBc/Hz	
10 MHz Offset		−160		dBc/Hz	
Floor		−163		dBc/Hz	
Configuration 5—312.5 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 25 MHz, f_{VCO} = 2500 MHz, f_{OUT} = 312.5 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
10 Hz Offset		−74		dBc/Hz	
100 Hz Offset		−91		dBc/Hz	
1 kHz Offset		−112		dBc/Hz	
10 kHz Offset		−123		dBc/Hz	
100 kHz Offset		−128		dBc/Hz	
1 MHz Offset		−138		dBc/Hz	
10 MHz Offset		−154		dBc/Hz	
Floor		−161		dBc/Hz	
Configuration 6—174.7030837 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 155.52 MHz, f_{VCO} = 2620.5463 MHz, f_{OUT} = (155.52 × 255/227) MHz, BW_{DPLL} = 50 Hz
10 Hz Offset		−82		dBc/Hz	
100 Hz Offset		−99		dBc/Hz	
1 kHz Offset		−117		dBc/Hz	
10 kHz Offset		−127		dBc/Hz	
100 kHz Offset		−133		dBc/Hz	
1 MHz Offset		−143		dBc/Hz	
10 MHz Offset		−157		dBc/Hz	
Floor		−160		dBc/Hz	

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Channel 1—DPLL1, APLL1					Channel 0 powered down
RMS Jitter (12 kHz to 20 MHz)					
Configuration 1—155.52 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 38.88 MHz, f_{VCO} = 3265.92 MHz, f_{OUT} = 155.52 MHz, BW_{DPLL} = 50 Hz, phase buildout operation, half divide enabled
10 Hz Offset		−81		dBc/Hz	
100 Hz Offset		−98		dBc/Hz	
1 kHz Offset		−118		dBc/Hz	
10 kHz Offset		−128		dBc/Hz	
100 kHz Offset		−132		dBc/Hz	
1 MHz Offset		−144		dBc/Hz	
10 MHz Offset		−158		dBc/Hz	
Floor		−162		dBc/Hz	
Configuration 2—245.76 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 30.72 MHz, f_{VCO} = 3686.4 MHz, f_{OUT} = 245.76 MHz, BW_{DPLL} = 50 Hz, half divide enabled; internal zero delay operation
10 Hz Offset		−76		dBc/Hz	
100 Hz Offset		−93		dBc/Hz	
1 kHz Offset		−114		dBc/Hz	
10 kHz Offset		−124		dBc/Hz	
100 kHz Offset		−127		dBc/Hz	
1 MHz Offset		−138		dBc/Hz	
10 MHz Offset		−156		dBc/Hz	
Floor		−161		dBc/Hz	
Configuration 3—491.52 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 1 Hz, f_{VCO} = 3932.16 MHz, f_{OUT} = 491.52 MHz, BW_{DPLL} = 50 mHz, phase buildout operation
10 Hz Offset		−74		dBc/Hz	
100 Hz Offset		−90		dBc/Hz	
1 kHz Offset		−108		dBc/Hz	
10 kHz Offset		−118		dBc/Hz	
100 kHz Offset		−120		dBc/Hz	
1 MHz Offset		−131		dBc/Hz	
10 MHz Offset		−150		dBc/Hz	
Floor		−160		dBc/Hz	
Configuration 4—125 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{COMP} = 19.2 MHz TCXO, BW_{COMP} = 50 Hz, f_{REF} = 125 MHz, f_{VCO} = 3250 MHz, f_{OUT} = 125 MHz, BW_{DPLL} = 0.1 Hz, phase buildout operation
10 Hz Offset		−83		dBc/Hz	
100 Hz Offset		−106		dBc/Hz	
1 kHz Offset		−120		dBc/Hz	
10 kHz Offset		−131		dBc/Hz	
100 kHz Offset		−135		dBc/Hz	
1 MHz Offset		−145		dBc/Hz	
10 MHz Offset		−160		dBc/Hz	
Floor		−163		dBc/Hz	

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
Configuration 5—312.5 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 25 MHz, f_{VCO} = 3750 MHz, f_{OUT} = 312.5 MHz, BW_{DPLL} = 50 Hz, phase buildout operation
10 Hz Offset		−73		dBc/Hz	
100 Hz Offset		−91		dBc/Hz	
1 kHz Offset		−112		dBc/Hz	
10 kHz Offset		−122		dBc/Hz	
100 kHz Offset		−125		dBc/Hz	
1 MHz Offset		−137		dBc/Hz	
10 MHz Offset		−154		dBc/Hz	
Floor		−161		dBc/Hz	
Configuration 6—174.7030837 MHz					Device configuration: f_{SYSCLK} = 52 MHz XTAL, f_{REF} = 155.52 MHz, f_{VCO} = 3319.3586 MHz, f_{OUT} = (155.52 × 255/227) MHz, BW_{DPLL} = 50 Hz
10 Hz Offset		−77		dBc/Hz	
100 Hz Offset		−99		dBc/Hz	
1 kHz Offset		−117		dBc/Hz	
10 kHz Offset		−127		dBc/Hz	
100 kHz Offset		−131		dBc/Hz	
1 MHz Offset		−142		dBc/Hz	
10 MHz Offset		−158		dBc/Hz	
Floor		−161		dBc/Hz	

ABSOLUTE MAXIMUM RATINGS

Table 23.

Parameter	Rating
1.8 V Supply Voltage (VDD)	2 V
Input/Output Supply Voltage (VDDIOA, VDDIOB)	3.6 V
Input Voltage Range (XOA, XOB, REFA, REFAA, REFB, REFBB)	−0.5 V to VDD + 0.5 V
Digital Input Voltage Range	
SDO/M5, SCLK/SCL, SDIO/SDA, CSB/M6	−0.5 V to VDDIOA + 0.5 V
M0, M1, M2, M3, M4	−0.5 V to VDDIOB + 0.5 V
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range[1]	−40°C to +85°C
Lead Temperature (Soldering 10 sec)	300°C

[1] See the Thermal Resistance section for additional information.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

θ_{JA} is the junction to ambient thermal resistance, 0.0 m/sec airflow per JEDEC JESD51-2 (still air).

θ_{JMA} is the junction to ambient thermal resistance, 1.0 m/sec airflow or 2.5 m/sec airflow per JEDEC JESD51-6 (moving air).

θ_{JC} is the junction to case thermal resistance (die to heat sink) per MIL-STD 883, Method 1012.1.

Values of θ_{JA} are for package comparison and PCB design considerations. θ_{JA} provides for a first-order approximation of T_J per the following equation:

$$T_J = T_A + (\theta_{JA} \times PD)$$

where T_A is the ambient temperature (°C).

Values of θ_{JC} are for package comparison and PCB design considerations when an external heat sink is required.

Table 24. Thermal Resistance

Package Type	θ_{JA}	θ_{JMA}[1]	θ_{JC}	Unit
CP-48-13[2, 3]	23.9	19.4, 18.2	1.5	°C/W

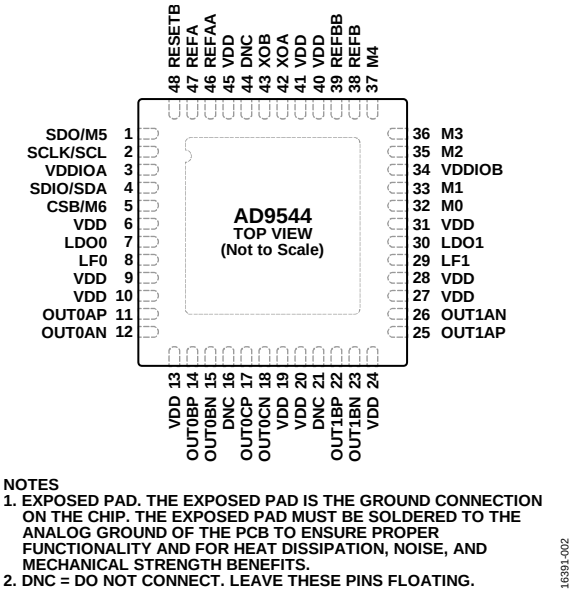
[1] θ_{JMA} is 19.4°C/W at 1.0 m/sec airflow and 18.2°C/W at 2.5 m/sec airflow.
[2] Thermal characteristics derived using a JEDEC51-7 plus JEDEC51-5 2S2P test board. The exposed pad on the bottom of the package must be soldered to ground to achieve the specified thermal performance.
[3] Results are from simulations. The PCB is a JEDEC multilayer type. Thermal performance for actual applications requires careful inspection of the conditions in the application to determine if they are similar to those assumed in these calculations.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES
1. EXPOSED PAD. THE EXPOSED PAD IS THE GROUND CONNECTION ON THE CHIP. THE EXPOSED PAD MUST BE SOLDERED TO THE ANALOG GROUND OF THE PCB TO ENSURE PROPER FUNCTIONALITY AND FOR HEAT DISSIPATION, NOISE, AND MECHANICAL STRENGTH BENEFITS.
2. DNC = DO NOT CONNECT. LEAVE THESE PINS FLOATING.

Figure 2. Pin Configuration

Table 25. Pin Function Descriptions

Pin No.	Mnemonic	Input/ Output	Pin Type	Description
1	SDO/M5	Output	CMOS	Serial Data Output (SDO). This pin is for reading serial data in 4-wire SPI mode. Changes to the VDDIOA supply voltage affect the V_{IH} and V_{OH} values for this pin. Configurable Input/Output (M5).This pin is a status and control pin when the device is not in 4-wire SPI mode.
2	SCLK/SCL	Input	CMOS	Serial Programming Clock (SCLK) Pin in SPI Mode. Changes to the VDDIOA supply voltage affect the V_{IH} and V_{OH} values for this pin. Serial Clock Pin (SCL) in I^2C Mode. Changes to the VDDIOA supply voltage affect the V_{IH} and V_{OH} values for this pin.
3	VDDIOA	Input	Power	Serial Port Power Supply. The valid supply voltage is 1.8 V, 2.5 V, or 3.3 V. The VDDIOA pin can be connected to the VDD supply bus if 1.8 V operation is desired.
4	SDIO/SDA	Input/ output	CMOS	Serial Data Input/Output in SPI Mode (SDIO). Write data to this pin in 4-wire SPI mode. This pin has no internal pull-up or pull-down resistor. Changes to the VDDIOA supply voltage affect the V_{IH} and V_{OH} values for this pin. Serial Data Pin in I^2C Mode (SDA).
5	CSB/M6	Input/ output	CMOS	Chip Select in SPI Mode (CSB). Active low input. Maintain a Logic 0 level on this pin when programming the device in SPI mode. This pin has an internal 10 kΩ pull-up resistor. Changes to the VDDIOA supply voltage affect the V_{IH} and V_{OH} values for this pin. Configurable Input/Output (M6). This pin is a status and control pin when the device is not in SPI mode.
6, 9, 10, 13, 19, 20, 24, 27, 28, 31, 40, 41, 45	VDD	Input	Power	1.8 V Power Supply.
7	LDO0	Input	LDO bypass	APLL0 Loop Filter Voltage Regulator. Connect a 0.22 µF capacitor from this pin to ground. This pin is the ac ground reference for the integrated APLL0 loop filter.
8	LF0	Input/ output	Loop filter for APLL0	Loop Filter Node for APLL0. Connect a 3.9 nF capacitor from this pin to Pin 7 (LDO0).
11	OUT0AP	Output	HCSL, LVDS, CML, CMOS	PLL0 Output 0A.
12	OUT0AN	Output	HCSL, LVDS, CML, CMOS	PLL0 Complementary Output 0A.

Pin No.	Mnemonic	Input/ Output	Pin Type	Description
14	OUT0BP	Output	HCSL, LVDS, CML, CMOS	PLL0 Output 0B.
15	OUT0BN	Output	HCSL, LVDS, CML, CMOS	PLL0 Complementary Output 0B.
16, 21, 44	DNC	DNC	No Connect	Do Not Connect. Leave these pins floating.
17	OUT0CP	Output	HCSL, LVDS, CML, CMOS	PLL0 Output 0C.
18	OUT0CN	Output	HCSL, LVDS, CML, CMOS	PLL0 Complementary Output 0C.
22	OUT1BP	Output	HCSL, LVDS, CML, CMOS	PLL1 Output 1B.
23	OUT1BN	Output	HCSL, LVDS, CML, CMOS	PLL1 Complementary Output 1B.
25	OUT1AP	Output	HCSL, LVDS, CML, CMOS	PLL1 Output 1A.
26	OUT1AN	Input/ Output	HCSL, LVDS, CML, CMOS	PLL1 Complementary Output 1A.
29	LF1	Input/ output	Loop filter for APLL1	Loop Filter Node for APLL1. Connect a 3.9 nF capacitor from this pin to Pin 30 (LDO1).
30	LDO1	Input	LDO bypass	APLL1 Loop Filter Voltage Regulator. Connect a 0.1 µF capacitor from this pin to ground. This pin is the ac ground reference for the integrated APLL1 loop filter.
32, 33, 35, 36, 37	M0, M1, M2, M3, M4	Input/ output	CMOS	Configurable Input/Output Pins. These are status and control pins. Changes to the VDDIOB supply voltage affect the V_{IH} and V_{OH} values for these pins. M3 and M4 have internal 100 kΩ pull-down resistors. M0, M1, and M2 do not have internal resistors.
34	VDDIOB	Input	Power	Mx Pin Power Supply. This power supply powers the digital section that controls the M0 to M4 pins. Valid supply voltages are 1.8 V, 2.5 V, or 3.3 V. The VDDIOB pin can be connected to the VDD supply bus if 1.8 V operation is desired.
38	REFB	Input	1.8 V single-ended or differential input	Reference B Input. This internally biased input is typically ac-coupled; when configured in this manner, it can accept any differential signal with a single-ended swing up to the VDD power supply. If dc-coupled, the input can be LVDS or single-ended 1.8 V CMOS.
39	REFBB	Input	1.8 V single-ended or differential input	Reference BB Input or Complementary Reference B Input. If REFB is in differential mode, the REFB complementary signal is on this pin. No connection is necessary to this pin if REFB is a single-ended input and REFBB is not used.
42	XOA	Input	Differential input	System Clock Input. XOA contains internal dc biasing and is ac-coupled with a 0.01 µF capacitor except when using a crystal. When a crystal is used, connect the crystal across XOA and XOB. A single-ended CMOS input is also an option, but it can produce spurious spectral content when the duty cycle is not 50%. When using XOA as a single-ended input, connect a 0.1 µF capacitor from XOB to ground.
43	XOB	Input	Differential input	Complementary System Clock Input. Complementary signal to XOA. XOB contains internal dc biasing and is ac-coupled with a 0.1 µF capacitor except when using a crystal. When a crystal is used, connect the crystal across XOA and XOB.
46	REFAA	Input	1.8 V single-ended or differential input	Reference AA input or Complementary REFA Input. If REFA is in differential mode, the REFA complementary signal is on this pin. No connection is necessary to this pin if REFA is a single-ended input and REFAA is not used. If dc-coupled, the input is single-ended 1.8 V CMOS.
47	REFA	Input	1.8 V single-ended or differential input	Reference A Input. This internally biased input is typically ac-coupled; when configured in this manner, it can accept any differential signal with a single-ended swing up to the VDD power supply. If dc-coupled, the input can be LVDS or single-ended 1.8 V CMOS.
48	RESETB	Input	1.8 V CMOS logic	Active Low Chip Reset. This pin has an internal 100 kΩ pull-up resistor. When asserted, the chip goes into reset. Changes to the VDDIOA supply voltage affect the V_{IH} values for this pin.
EP	EPAD	Output	Exposed pad	Exposed Pad. The exposed pad is the ground connection on the chip. The exposed pad must be soldered to the analog ground of the PCB to ensure proper functionality and for heat dissipation, noise, and mechanical strength benefits.

TYPICAL PERFORMANCE CHARACTERISTICS

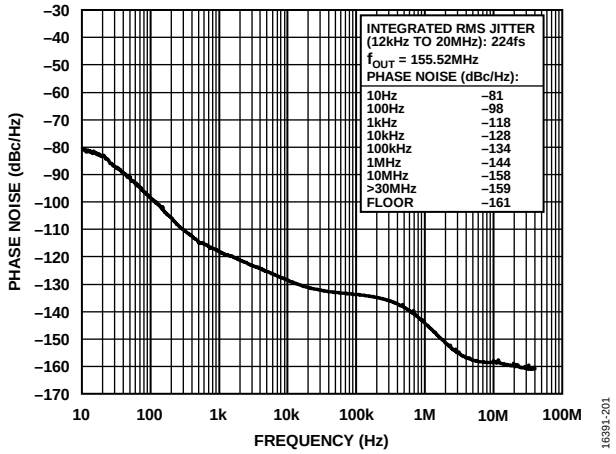


Figure 3. Absolute Phase Noise (PLL0, Configuration 1, HCSL Mode, f_{REF} = 38.88 MHz, f_{OUT} = 155.52 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz)

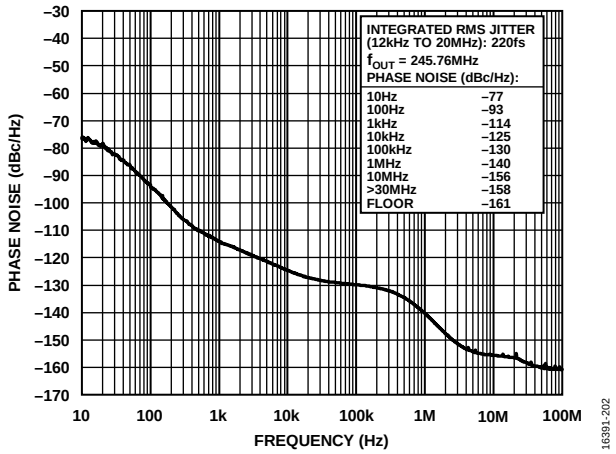


Figure 4. Absolute Phase Noise (PLL0, Configuration 2, HCSL Mode, f_{REF} = 30.72 MHz, f_{OUT} = 245.76 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz)

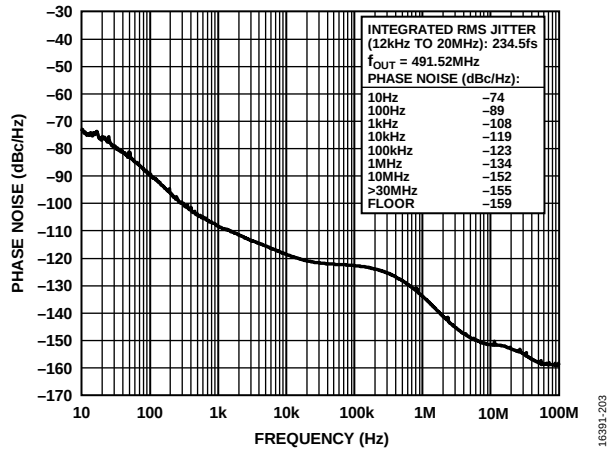


Figure 5. Absolute Phase Noise (PLL0, Configuration 3, HCSL Mode, f_{REF} = 1 Hz, f_{OUT} = 491.52 MHz, f_{COMP} = 19.2 MHz TCXO, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz)

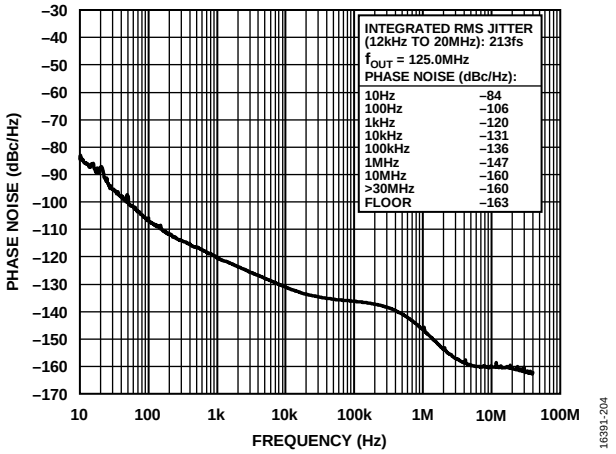


Figure 6. Absolute Phase Noise (PLL0, Configuration 4, HCSL Mode, f_{REF} = 125 MHz, f_{OUT} = 125.0 MHz, f_{COMP} = 19.2 MHz TCXO, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 0.1 Hz, Phase Buildout Mode)

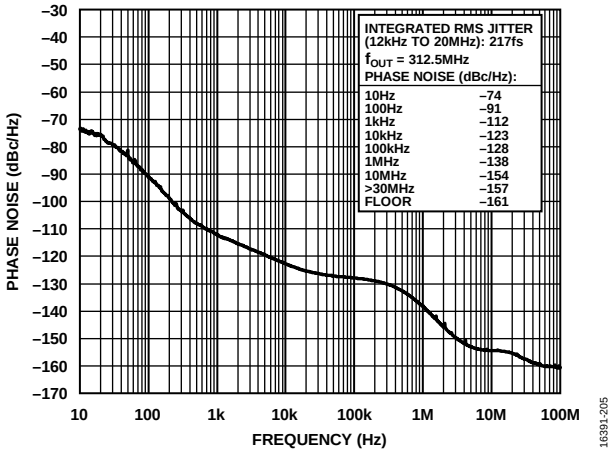


Figure 7. Absolute Phase Noise (PLL0, Configuration 5, HCSL Mode, f_{REF} = 25 MHz, f_{OUT} = 312.5 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz, Phase Buildout Mode)

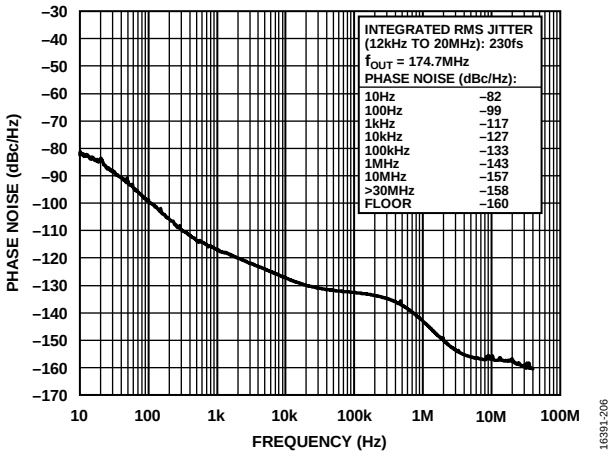


Figure 8. Absolute Phase Noise (PLL0, Configuration 6, HCSL Mode, f_{REF} = 155.52 MHz, f_{OUT} = 174.7 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz, Phase Buildout Mode)

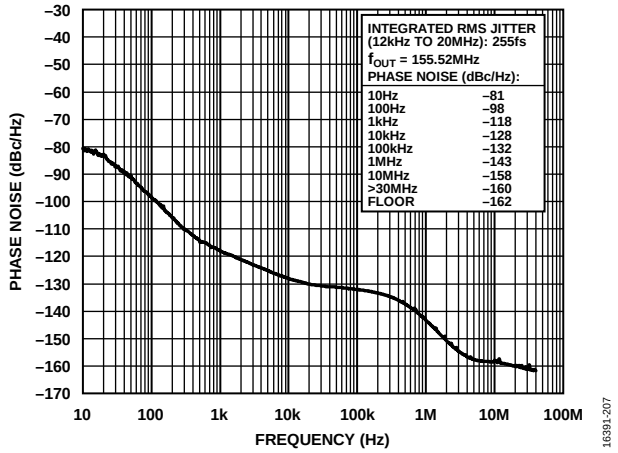


Figure 9. Absolute Phase Noise (PLL1, Configuration 1, HCSL Mode, f_{REF} = 38.88 MHz, f_{OUT} = 155.52 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz)

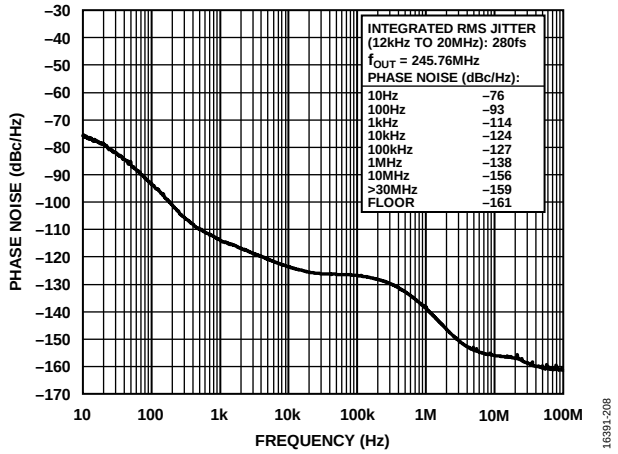


Figure 10. Absolute Phase Noise (PLL1, Configuration 2, HCSL Mode, f_{REF} = 30.72 MHz, f_{OUT} = 245.76 MHz, f_{SYS} = 52 MHz Crystal, 50 Hz DPLL BW)

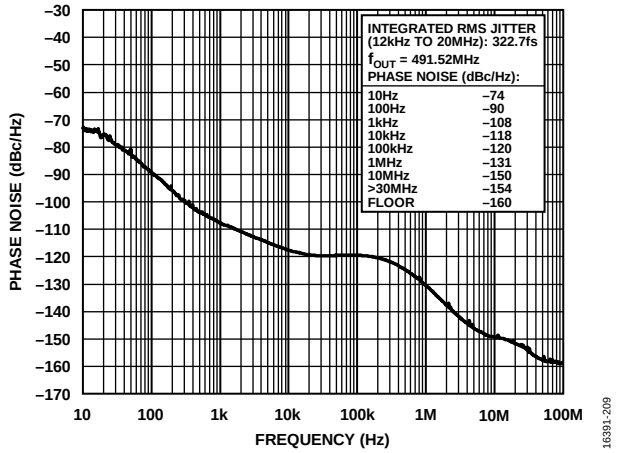


Figure 11. Absolute Phase Noise (PLL1, Configuration 3, HCSL Mode, f_{REF} = 1 Hz, f_{OUT} = 491.52 MHz, f_{COMP} = 19.2 MHz TCXO, f_{SYS} = 52 MHz Crystal, 50 MHz DPLL BW)

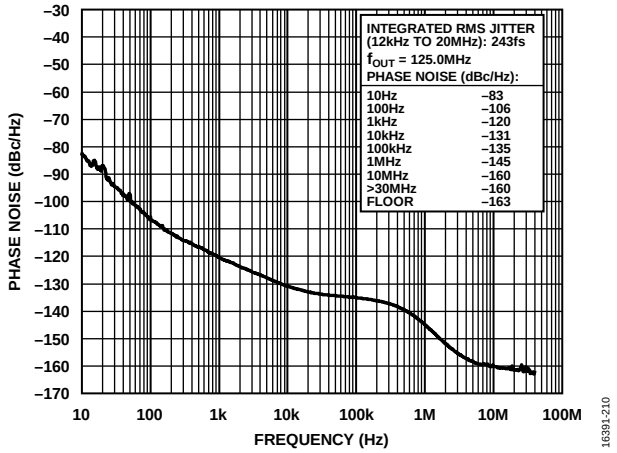


Figure 12. Absolute Phase Noise (PLL1, Configuration 4, HCSL Mode, f_{REF} = 125 MHz, f_{OUT} = 125 MHz, f_{COMP} = 19.2 MHz TCXO, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 0.1 Hz, Phase Buildout Mode)

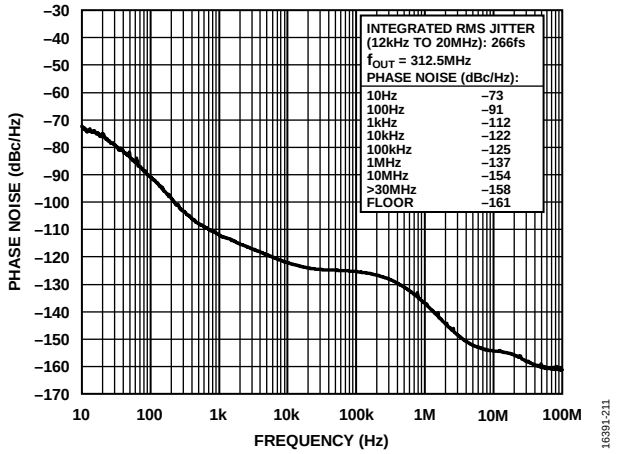


Figure 13. Absolute Phase Noise (PLL1, Configuration 5, HCSL Mode, f_{REF} = 25 MHz, f_{OUT} = 312.5 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz, Phase Buildout Mode)

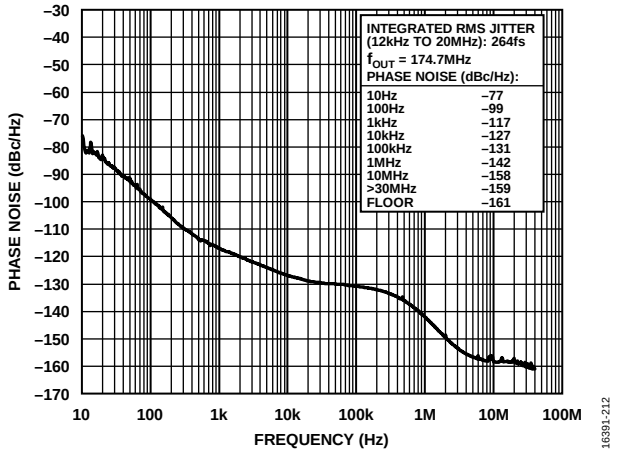


Figure 14. Absolute Phase Noise (PLL1, Configuration 6, HCSL Mode, f_{REF} = 155.52 MHz, f_{OUT} = 174.7 MHz, f_{SYS} = 52 MHz Crystal, BW_{DPLL} = 50 Hz, Phase Buildout Mode)

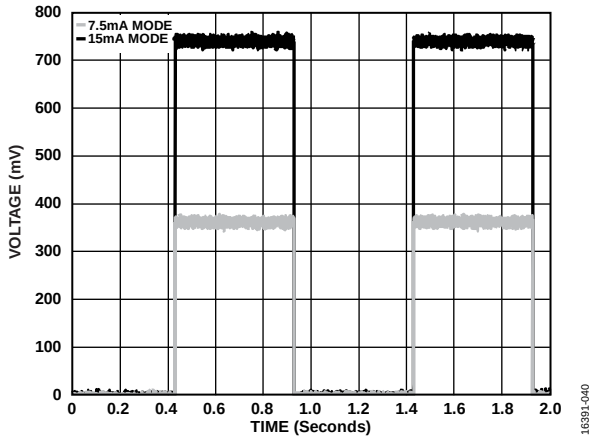


Figure 15. DC-Coupled, Single-Ended, 1 Hz Output Waveforms Using HCSL 7.5 mA and 15 mA Mode Terminated 50 Ω to GND per Figure 38; Slew Rate: ~7 V/ns for 15 mA Mode; ~3.5 V/ns for 7.5 mA Mode

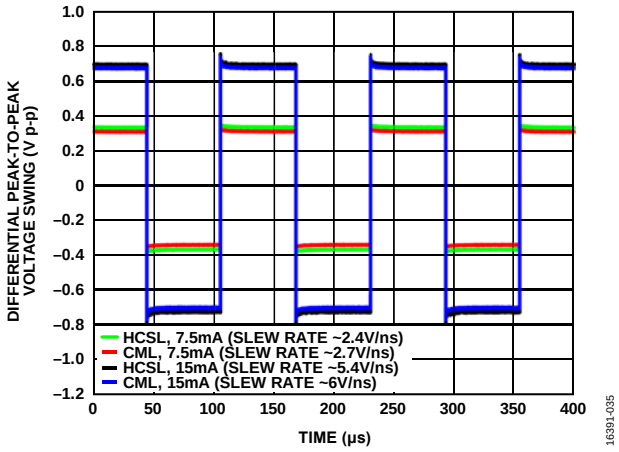


Figure 16. 8 kHz Output Waveforms for Various Driver Settings; HCSL Drivers Terminated 50 Ω to GND per Figure 32; CML Drivers Terminated 50 Ω to 1.8 V per Figure 33

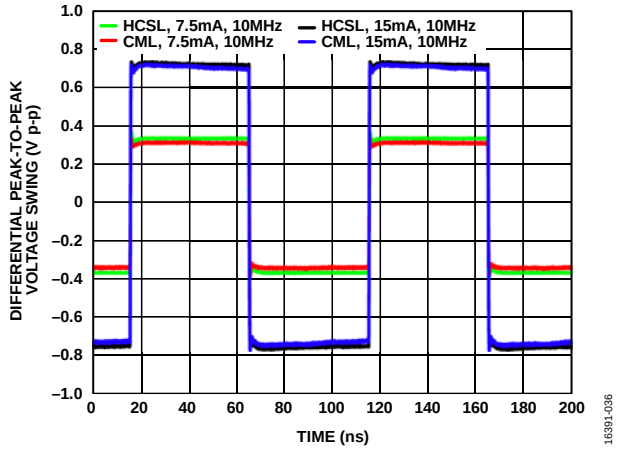


Figure 17. 10 MHz Output Waveforms for Various Driver Settings; HCSL Drivers Terminated 50 Ω to GND per Figure 32; CML Drivers Terminated 50 Ω to 1.8 V per Figure 33

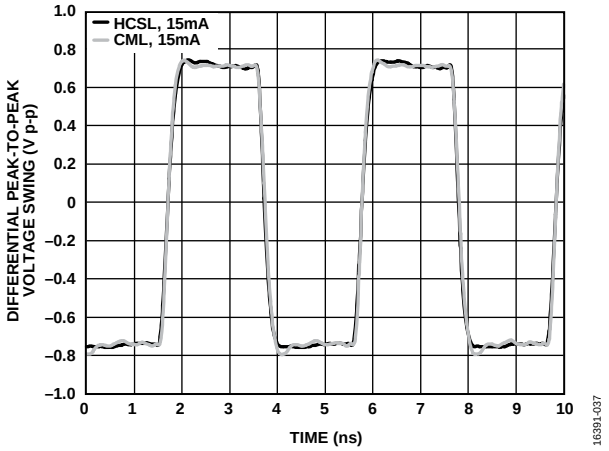


Figure 18. 245.76 MHz Output Waveform for 15 mA Driver Settings; HCSL Drivers Terminated 50 Ω to GND per Figure 32; CML Drivers Terminated 50 Ω to 1.8 V per Figure 33

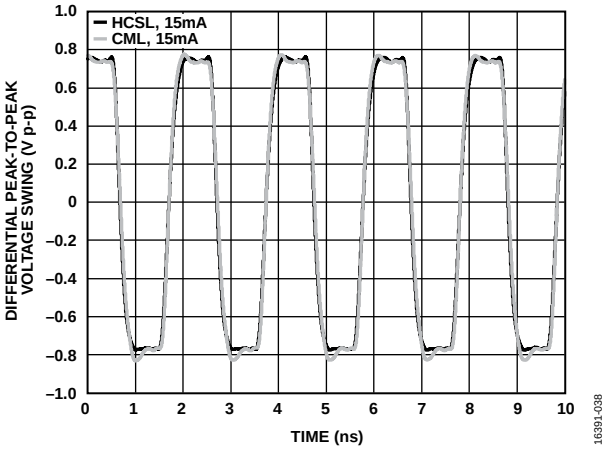


Figure 19. 491.52 MHz Output Waveform for15 mA Driver Settings; HCSL Drivers Terminated 50 Ω to GND per Figure 32; CML Drivers Terminated 50 Ω to 1.8 V per Figure 33

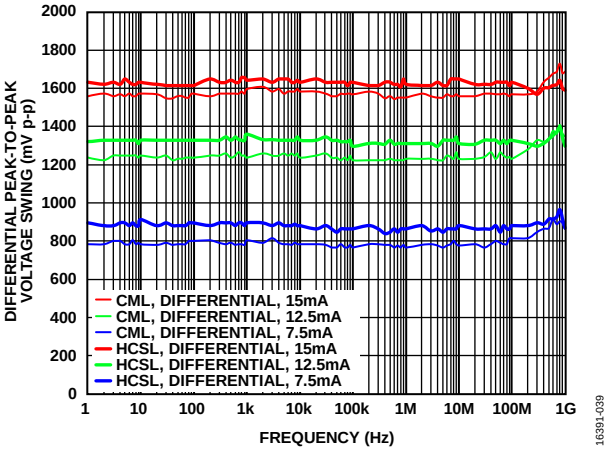


Figure 20. Differential Output Amplitude Waveforms; HCSL Drivers Terminated 50 Ω to GND per Figure 32; CML Drivers Terminated 50 Ω to 1.8 V per Figure 33

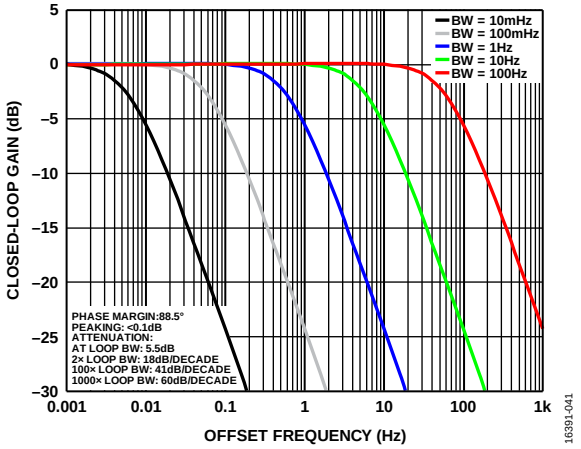


Figure 21. DPLL Closed-Loop Transfer Function Nominal Phase Margin Loop Filter Setting

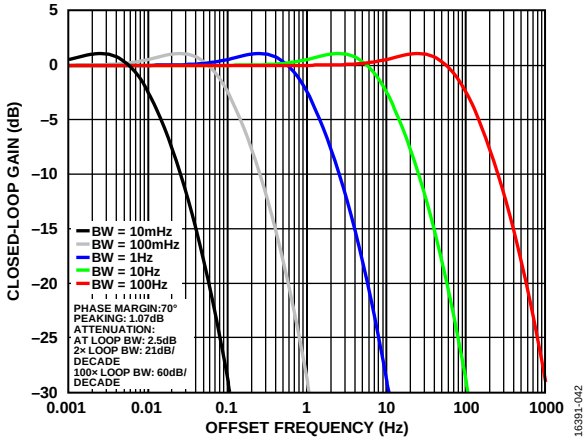


Figure 22. DPLL Closed-Loop Transfer Function High Phase Margin Loop Filter Setting

TERMINOLOGY

Zero Delay

Zero delay is seen in an integer-N PLL architecture that establishes zero (or nearly zero, but constant) phase offset between the final output signal and the signal appearing at the reference input of the PLL phase detector. A PLL with zero delay provides minimal input to output phase offset in the static (steady state) sense. That is, phase slewing at the output typically occurs any time the PLL is in the process of phase or frequency acquisition (for example, when a multiple input PLL switches from one input reference signal to another).

Hitless Switchover

Hitless switchover applies to PLLs with the ability to switch from one reference signal to another while maintaining a constant phase relationship from the active input to output. Hitless switchover is the ability of a PLL to switch between reference signals having an arbitrary initial instantaneous phase offset. In hitless switching, the output signal slews in a prescribed manner from its initial phase to the new phase, and the absolute phase relationship from active input to output is maintained. The reference switching scheme is hitless if the phase slewing is gradual enough to not cause traffic hits caused by the output clock phase slewing. A PLL employing hitless switchover capability requires the output/input frequency ratio to be an integer greater than or equal to 1. Hitless output phase transient limitation applies any time the PLL is in the process of phase or frequency acquisition (that is, it is not necessarily limited to reference switching).

Phase Buildout (PBO) Switchover

PBO only applies to PLLs with the ability to switch from one reference signal to another. PBO is the ability of a PLL to switch between two reference signals having an arbitrary initial instantaneous phase offset, whereby the phase of the output signal remains fixed. This mode of operation implies the ability of the PLL to absorb the phase difference between the two reference input signals, the goal being to prevent a phase disturbance at the output when switching between two reference signals. Prevention of a phase disturbance at the output means there is no guarantee of phase alignment between the input and output signals. Unlike hitless switchover, PBO places no restriction on the output/input frequency ratio. PBO output phase transient prevention applies any time the PLL is in the process of phase or frequency acquisition (that is, it is not necessarily limited to reference switching).

For more information, see the AN-1420 Application Note, *Phase Buildout and Hitless Switchover with Digital Phase-Locked Loops (DPLLs)*.

THEORY OF OPERATION

OVERVIEW

The AD9544 provides clocking outputs that are directly related in phase and frequency to the selected (active) reference but with jitter characteristics governed by the system clock, the DCO, and the analog output PLL (APLL). The AD9544 supports up to four reference inputs and input frequencies ranging from 1 Hz to 750 MHz. The cores of this device are two DPLLs. Each DPLL has a programmable digital loop filter that greatly reduces jitter transferred from the active reference to the output, and these four DPLLs operate completely independently of each other. The AD9544 supports both manual and automatic holdover. While in holdover, the AD9544 continues to provide an output as long as the system clock is present. The holdover output frequency is a time average of the output frequency history prior to the transition to the holdover condition. The device offers manual and automatic reference switchover capability if the active reference is degraded or fails completely.

The AD9544 includes a system clock multiplier and two DPLLs, each cascaded with its own APLL.

The input signal goes first to the DPLL, which performs the jitter cleaning and most of the frequency translation. Each DPLL features a 48-bit DCO output that generates a signal in the range of 162 MHz to 350 MHz.

The DCO output goes to the APLL, which multiplies the signal up to a range of 2.424 GHz to 3.232 GHz (for Channel 0) or 3.232 GHz to 4.040 GHz (for Channel 1). After division by 2, this signal is sent to the clock distribution section, which consists of the 32-bit Q divider and output driver for each output. Channel 0 has six Q dividers and Channel 1 has four Q dividers.

The XOA and XOB inputs provide the input for the system clock. These pins accept a reference clock in the 20 MHz to 300 MHz range or a 25 MHz to 52 MHz crystal connected directly across the XOA and XOB inputs. The system clock provides the clocks to the frequency monitors, the DPLLs, and internal logic.

The AD9544 has five differential output drivers. Each of the five output drivers has a dedicated 32-bit programmable Q divider. Each differential driver operates up to 500 MHz and is configurable as a CML driver with external pull-up resistors, or an HCSL driver with external pull-down resistors. There are three drive strengths:

- The 7.5 mA mode is used for CML and HCSL and ac-coupled LVDS. When used as an LVDS-compatible driver, it must be ac-coupled and terminated with a 100 Ω resistor across the differential pair.
- The 15 mA mode produces a voltage swing and is compatible with LVPECL. If LVPECL dc signal levels are required, the designer must ac couple and rebias the AD9544 output. The 15 mA mode can also be used with the termination scheme shown in Figure 34 and Figure 35 to produce an LVDS signal with the correct LVDS dc bias.
- The 12 mA mode is halfway in between the two other settings.

REFERENCE INPUT PHYSICAL CONNECTIONS

Two pairs of pins (REFA/REFAA and REFB/REFBB) provide access to the reference clock receivers. The user can reconfigure each differential pair into two single-ended reference inputs. To accommodate input signals with slow rising and falling edges, both the differential and single-ended input receivers employ hysteresis. Hysteresis also ensures that a disconnected or floating input does not cause the receiver to oscillate.

When configured for differential operation, the input receivers accommodate either ac-coupled or dc-coupled input signals. If the input receiver is configured for dc-coupled LVDS mode, the input receivers are capable of accepting dc-coupled LVDS signals. The receiver is internally dc biased to handle ac-coupled operation; however, there is no internal 50 Ω or 100 Ω termination.

INPUT/OUTPUT TERMINATION RECOMMENDATIONS

SYSTEM CLOCK INPUTS

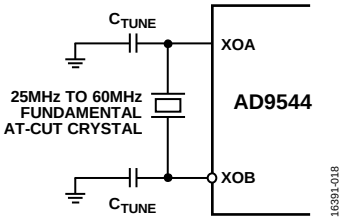


Figure 23. System Clock Input (XOA/XOB) in Crystal Mode (Each C_{TUNE} Shunt Capacitor Shown Must Equal 2× (C_{LOAD} – C_{STRAY}, Where Typical C_{STRAY} = 2 pF to 5 pF)

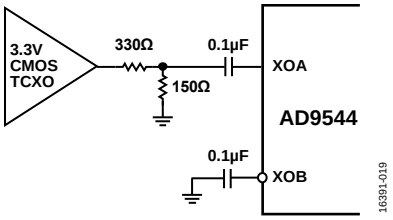


Figure 24. System Clock Input (XOA, XOB) when Using a TCXO/OCXO with 3.3 V CMOS Output

REFERENCE CLOCK INPUTS

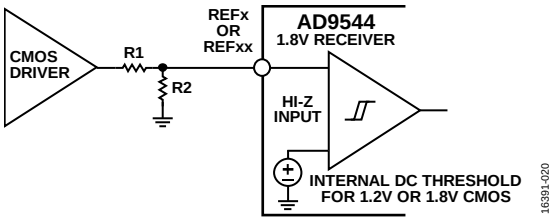


Figure 25. Single-Ended DC-Coupled Mode, 1.2 V or 1.8 V CMOS

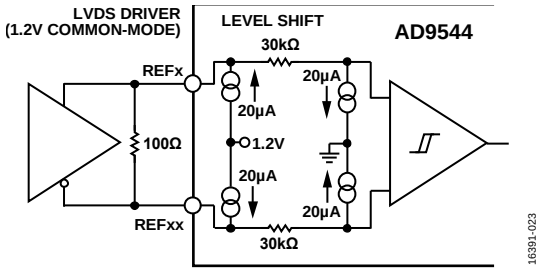


Figure 28. Differential LVDS Input Mode

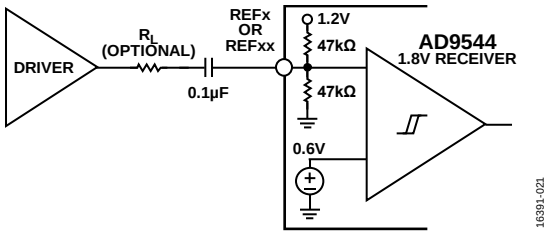


Figure 26. Single-Ended AC-Coupled Mode

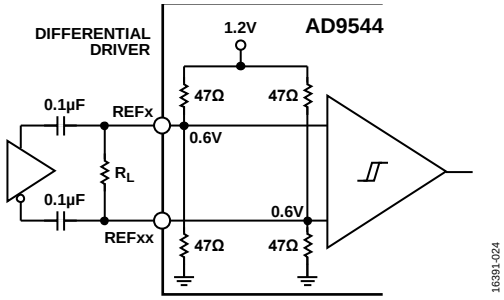


Figure 29. Differential AC-Coupled Mode (R_L = 100 Ω Is Recommended, Except For HCSL)

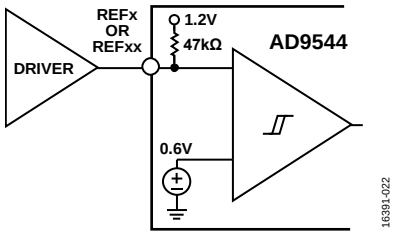


Figure 27. Single-Ended Internal Pull-Up Mode

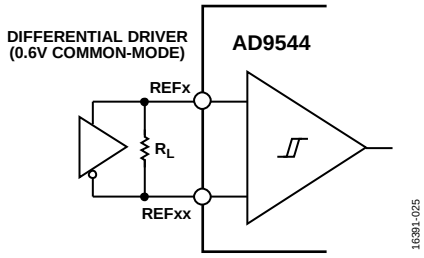


Figure 30. Differential DC-Coupled Mode

CLOCK OUTPUTS

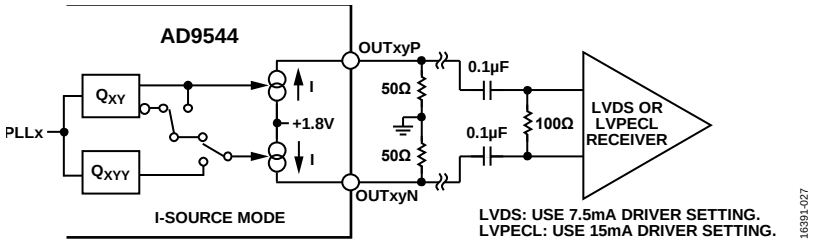


Figure 31. LVDS-Compatible Output Swing, AC-Coupled (V p-p ≈ 375 mV per Section for I = 15 mA

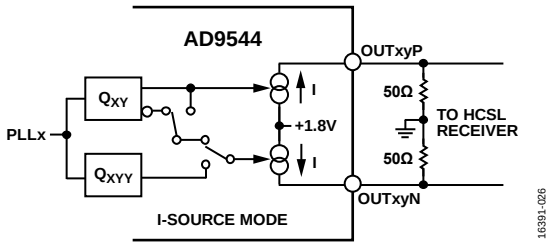


Figure 32. HCSL Output, V p-p ≈ 750 mV per Section (I = 15 mA)

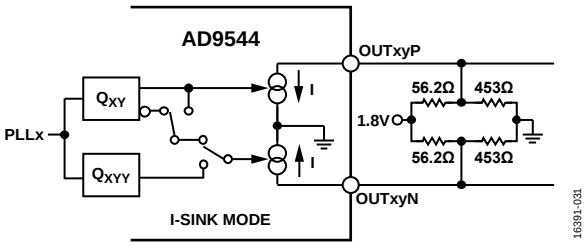


Figure 36. 2.5 V LVPECL or Double Amplitude LVDS-Compatible Boost Output, 1.5 V p-p, 1.24 V Common-Mode (I = 15 mA)

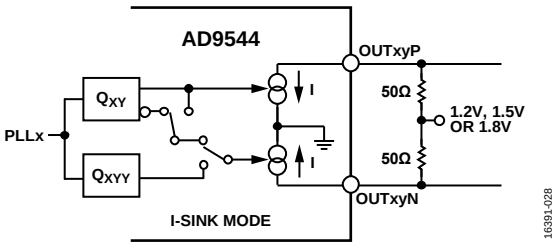


Figure 33. CML Output (I = 7.5 mA; I = 15 mA Options for 1.5 V or 1.8 V Supply)

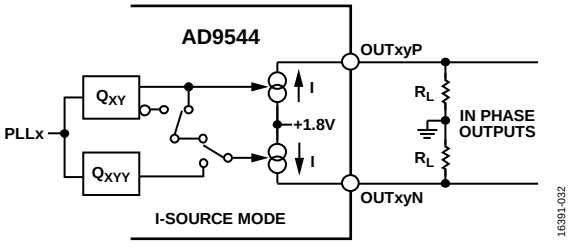


Figure 37. Single-Divider, Single-Ended Mode Providing In-Phase Outputs (Current Source Mode)

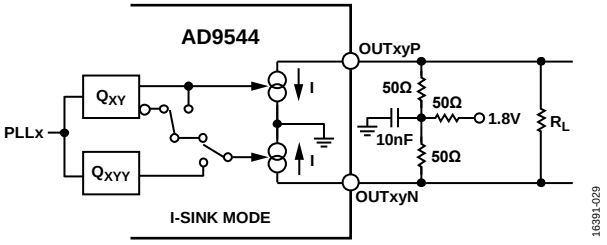


Figure 34. LVDS-Compatible Output, 1.24 V Common-Mode, T Network (I = 7.5 mA; I = 15 mA with Extra 100 Ω Termination, R_L)

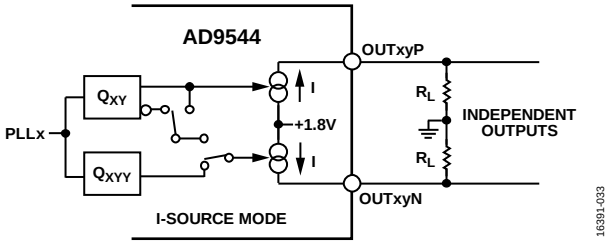


Figure 38. Dual-Divider, Single-Ended Mode Providing Independent Outputs (Current Source Mode); Note that Single-Ended CML Mode Is Also Available (See Figure 33)

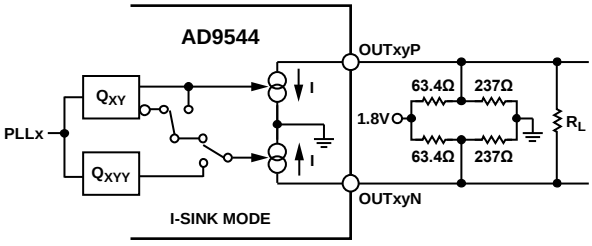


Figure 35. LVDS-Compatible Output, 1.2 V Common-Mode, Thevenin Bias Network (I = 7.5 mA; 15 mA With Extra 100 Ω Termination, R_L)

SYSTEM CLOCK PLL

Note that throughout the System Clock PLL section, unless otherwise specified, any referenced bits, registers, or bit fields reside in the system clock (SYSCLK) section of the register map (Register 0x0200 to Register 0x0209).

The system clock PLL (see Figure 39) comprises an integer-N frequency synthesizer with a fully integrated loop filter and voltage controlled oscillator (VCO). The VCO output is the AD9544 system clock with a frequency range of 2250 MHz to 2415 MHz. The XOA and XOB pins constitute the input to the system clock PLL to which a user connects a clock source or crystal resonator.

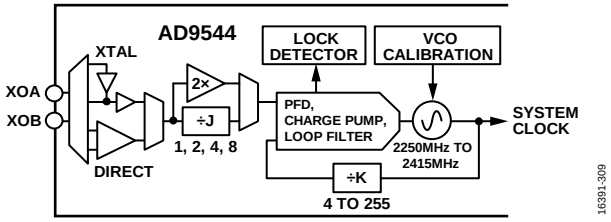


Figure 39. System Clock PLL Block Diagram

SYSTEM CLOCK INPUT FREQUENCY DECLARATION

Proper operation of the AD9544 requires the user to declare the input reference frequency to the system clock PLL. To do so, program the SYSCLK reference frequency bit field, which constitutes the nominal frequency of the system clock PLL input reference. The AD9544 evaluation software frequency planning wizard calculates this value for the user.

SYSTEM CLOCK SOURCE

The XOA and XOB pins serve as the input connection to the system clock PLL, giving the user access to a crystal path (see Figure 23) or a direct path (see Figure 24). Path selection is via the enable maintaining amplifier bit, where a Logic 0 (default) selects the direct path and Logic 1 selects the crystal path. The optimal reference source for the system clock input is a crystal resonator in the 50 MHz range or an ac-coupled square wave source (single-ended or differential) with 800 mV p-p amplitude.

Crystal Path

The crystal path supports crystal resonators in the 25 MHz to 60 MHz frequency range. An internal maintaining amplifier provides the negative resistance required to induce oscillation. The internal amplifier expects an AT cut, fundamental mode crystal with a maximum motional resistance of 100 Ω for crystals up to 52 MHz, and 50 Ω for crystals up to 60 MHz. The following crystals, listed in alphabetical order, may meet these criteria.

- AVX/Kyocera CX3225SB
- ECS, Inc. ECX-32
- Epson/Toyocom TSX-3225
- Fox FX3225BS
- NDK NX3225SA
- Siward SX-3225
- Suntsu SCM10B48-49.152 MHz

Analog Devices, Inc., does not guarantee the operation of the AD9544 with the aforementioned crystals, nor does Analog Devices endorse one crystal supplier over another. The AD9544 reference design uses a readily available high performance 49.152 MHz crystal with low spurious content.

Direct Path

The direct path has a differential receiver with a self bias of 0.6 V dc. Generally, the presence of the bias voltage necessitates the use of ac coupling between the external source and the XOA and XOB pins. Furthermore, when using a 3.3 V CMOS oscillator as the system clock PLL reference source, in addition to ac coupling, it is important to use a voltage divider to reduce the 3.3 V swing to a maximum of 1.14 V (note that the optimal voltage swing is 800 mV p-p). The external signal must exhibit a 50% duty cycle for best performance.

The direct path supports low frequency LVPECL, LVDS, CMOS, or sinusoidal clock sources as a reference to the system clock PLL. For a sinusoidal source, however, it is best to use a frequency of 50 MHz or greater. The low slew rate of lower frequency sinusoids tends to yield nonoptimal noise performance.

Applications requiring low DPLL loop bandwidth require the improved stability provided by a TCXO or OCXO. Loop bandwidths below approximately 50 Hz may prevent the PLL from locking or cause random loss of lock events when using a less stable PLL reference source.

Although one method to mitigate this problem is to use a high stability system clock source (such as an OCXO), the AD9544 provides integrated system clock compensation capability, which lessens the stability requirements on the system clock while providing the outstanding phase noise of the higher frequency crystal. To use this feature, connect a 40 MHz to 60 MHz crystal to the XOA/XOB pins (as in Figure 23), and connect either a TCXO or OCXO to either an unused reference input or an Mx pin (as shown in Figure 24).

2× FREQUENCY MULTIPLIER

The system clock PLL provides the user with the option of doubling the reference frequency via the enable SYSCLK doubler bit. Doubling the input reference frequency potentially reduces the PLL in-band noise. The reference frequency must be less than 150 MHz when using the 2× frequency multiplier to satisfy the 300 MHz maximum PFD rate. Furthermore, the 2× frequency multiplier requires the reference input signal to have very near to 50% duty cycle; otherwise, the resulting spurious content may prevent the system clock PLL from locking.

PRESCALE DIVIDER

The system clock PLL includes an input prescale divider programmable for divide ratios of 1 (default), 2, 4, or 8. The purpose of the divider is to provide flexible frequency planning for mitigating potential spurs in the output clock signals of the AD9544. The user selects the divide ratio via the 2-bit SYSCLK input divider ratio bit field in Register 0x0201. The corresponding divide value is 2^J, where J is the decimal value of the 2-bit number in the SYSCLK input divider ratio bit field.

For example, given that the SYSCLK input divider ratio bit field is 10 (binary), J = 2 (decimal), yielding a divide ratio of $2^J = 2^2 = 4$.

FEEDBACK DIVIDER

The output of the system clock PLL constitutes the system clock frequency, f_S. The system clock frequency depends on the value of the feedback divider. The feedback divide ratio has a range of 4 to 255, which the user programs via the 8-bit feedback divider ratio register (the register value is the divide ratio). For example, a programmed value of 100 (0x64 hexadecimal) yields a divide ratio of 100.

SYSTEM CLOCK PLL OUTPUT FREQUENCY

Calculate the system clock frequency as follows:

$$f_S = f_{SYSIN} \times \frac{K}{J}$$

where:
f_{SYSIN} is the input frequency.
K is the feedback divide ratio.
J is the input divide ratio. J = ½ when using the 2× frequency multiplier.

The user must choose f_{SYSIN}, K, and J such that f_S satisfies the VCO range of 2250 MHz to 2415 MHz.

SYSTEM CLOCK PLL LOCK DETECTOR

The system clock PLL features a simple lock detector that compares the time difference between the reference and feedback clock edges. The user can check the status of the lock detector via the SYSCLK locked bit in the status readback registers (Address 0x3000 to Address 0x300A) of the register map, where Logic 1 indicates locked and Logic 0 unlocked. The most common reason the system clock PLL fails to lock is due to the user employing the 2× frequency multiplier with a reference input clock that deviates from the 50% duty cycle.

SYSTEM CLOCK STABILITY TIMER

Because time processing blocks within the AD9544 depend on the system clock generating a stable frequency, the system clock PLL provides an indication of its status. The status of the system clock PLL is available to the user as well as directly to certain internal time keeping blocks.

At initial power-up, the system clock status is unknown and reported as being unstable. However, after the user programs the system clock registers and the system clock PLL VCO calibrates, the system clock PLL locks shortly thereafter.

SYSTEM CLOCK INPUT TERMINATION RECOMMENDATIONS

To connect a crystal resonator to the system clock PLL XOA and XOB inputs, refer to Figure 23. Be sure to program the enable maintaining amplifier bit = 1 to select the crystal path. The 15 pF shunt capacitors shown relate to the C_{LOAD} and C_{STRAY} associated with the crystal as follows:

$$C_{SHUNT} = 2 \times (C_{LOAD} - C_{STRAY})$$

For C_{LOAD} = 10 pF and C_{STRAY} = 2 pF to 5 pF, the value of C_{SHUNT} is approximately 15 pF.

To connect a TCXO or OCXO with a 3.3 V output, refer to Figure 24. Be sure to program the enable maintaining amplifier bit = 0 to select the direct path.

DIGITAL PLL (DPLL)

OVERVIEW

Note that throughout this section, unless otherwise specified, any referenced bits, registers, or bit fields reside in the DPLL Channel 0 and DPLL Channel 1 sections (Address 0x1000 to Address 0x102A, and Address 0x1400 to Address 0x142A) of the register map.

The DPLL is an all-digital implementation of a phase-locked loop (PLL). Figure 40 shows the fundamental building blocks of an APLL and a DPLL. An APLL typically relies on a VCO as the frequency element for generating an output signal, where the output frequency depends on an applied dc voltage. A DPLL, on the other hand, uses a numerically controlled oscillator (NCO), which relies on a digital frequency tuning word (FTW) to produce the output frequency. A VCO inherently produces a timing signal because it is, by definition, an oscillator, whereas the AD9544 NCO requires an external timing source, the system clock. The fundamental difference between an APLL and a DPLL is that the VCO in an APLL can tune to any frequency within its operating bandwidth, whereas the NCO in a DPLL can only tune to discrete frequencies (by virtue of the FTW).

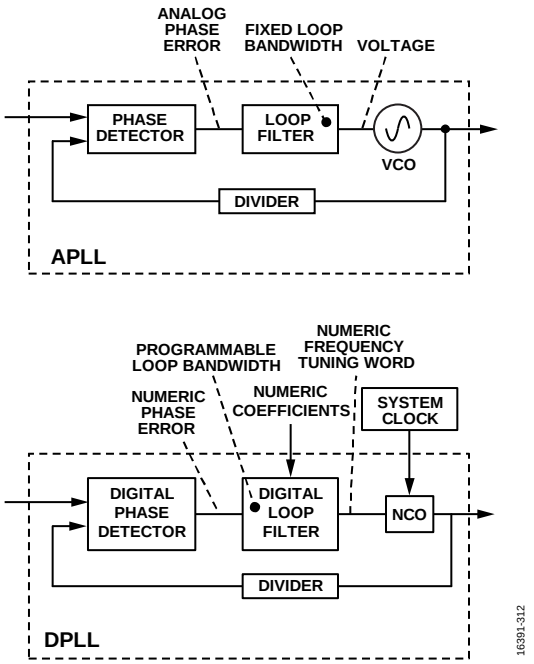


Figure 40. APLL vs. DPLL

The DPLLs in the AD9544 have a digital TDC-based phase detector and a digital loop filter with programmable bandwidth. The digital loop filter output yields a digital FTW (instead of a dc voltage, as in the case of an analog PLL) that produces a corresponding NCO output frequency.

DPLL PHASE/FREQUENCY LOCK DETECTORS

See the Lock Detectors section for details concerning the phase and frequency detectors of the DPLL.

DPLL LOOP CONTROLLER

The DPLL has several operating modes (including freerun, holdover, and active). To ensure seamless transition between modes, the DPLL has a loop controller. The loop controller sets the appropriate DPLL operating mode based on the prevailing requirements of automatic reference switching or manual control settings.

Switchover

Switchover occurs when the loop controller switches directly from one input reference to another. The AD9544 handles a reference switchover by briefly entering holdover mode, loading the new DPLL parameters, and then immediately recovering.

Holdover

Typically, the holdover state is in effect when all of the input references are invalid. However, the user can force the holdover mode even when one or more references are valid by setting the DPLLx force holdover bit (where x = 0 or 1) in the Operational Control Channel 0 and Operational Control Channel 1 sections of the register map to Logic 1. In holdover mode, the output frequency remains fixed (to the extent of the stability of the system clock). The accuracy of the AD9544 in holdover mode is dependent on the device programming and availability of the tuning word history.

Recovery from Holdover

When in holdover and an enabled translation profile becomes available, the device exits holdover operation. The loop controller restores the DPLL to closed-loop operation, locks to the selected reference, and sequences the recovery of all the loop parameters based on the profile settings for the active reference.

If the DPLLx force holdover bit (where x = 0 or 1) in the Operational Control Channel 0 and Operational Control Channel 1 sections of the register map is set to Logic 1, the device does not automatically exit holdover when a valid translation profile is available. However, automatic recovery can occur after clearing the DPLL force holdover bit.

APPLICATIONS INFORMATION

OPTICAL NETWORKING LINE CARD

In this application (shown in Figure 41), the AD9544 is used in a variety of ways.

In a loop timed (WAN) mode, one of the AD9544 DPLLs locks to the CDR and is used to remove jitter on the receiver path, sending that clock to the central timing card, as well as the framer. In some applications, the AD9544 can also perform a variety of frequency translation tasks, such as multiplying or dividing by an FEC ratio, and/or removing jitter from a gapped clock. The other DPLL cleans jitter and provides clocking to the transmitter path.

Other tasks include frequency translation and jitter cleaning of the reference clock from the timing card, as well as seamlessly managing the reference switching from Timing Card 1 to Timing Card 2.

Given the continually evolving nature of optical line card protocols and functions, the functions listed in this section are by no means exhaustive.

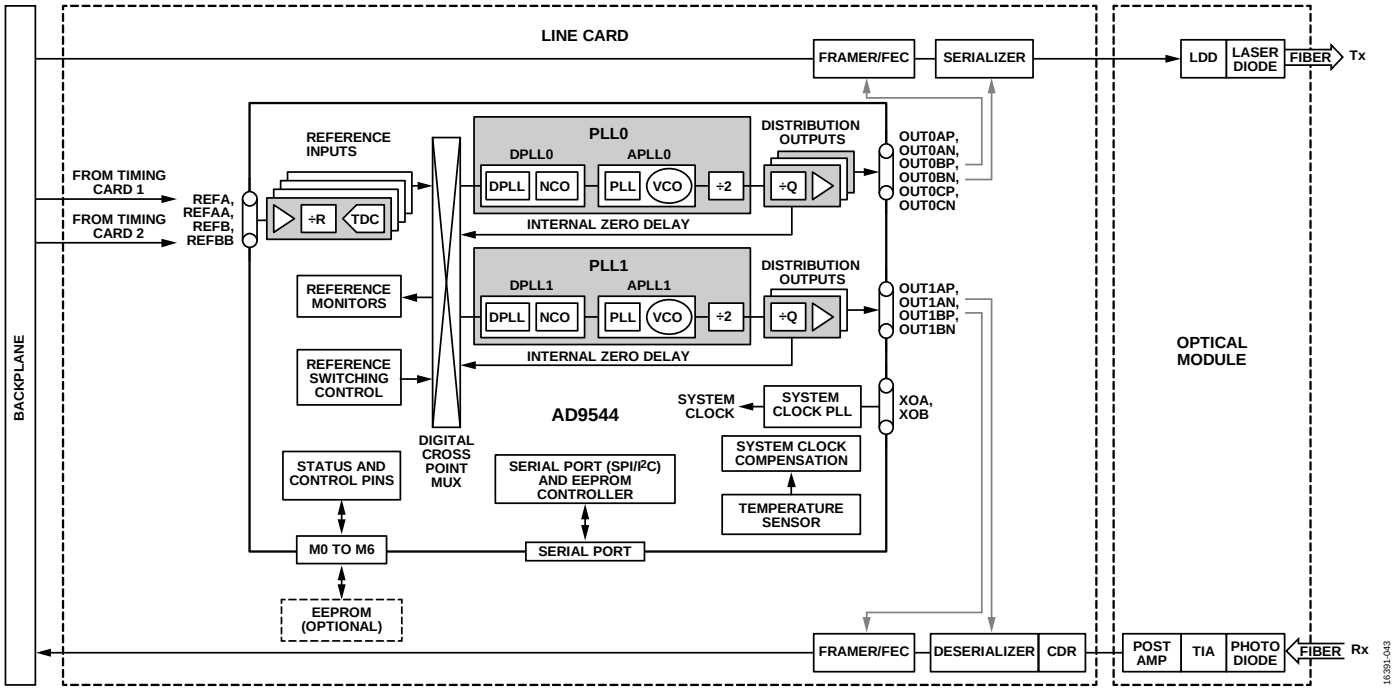


Figure 41. Optical Line Card Example

SMALL CELL BASE STATION

In this application (shown in Figure 42), the AD9544 provides all of the synchronization to the baseband unit of a small cell base station. The built in JESD204B support enables a particularly compact and efficient design.

The AD9544 can lock to any of the following: GPS, SyncE, or loop timed (if using SONET/SDH or passive optical network backhaul). The PLL0 of the AD9544 provides one device clock and up to four device system reference clocks that can be used to clock wireless transceivers, such as the AD9371.

The PLL1 of the AD9544 clocks the backhaul interface and, optionally, the CPU interface.

The EEPROM support of the AD9544 allows the AD9544 to load its configuration automatically at power-up.

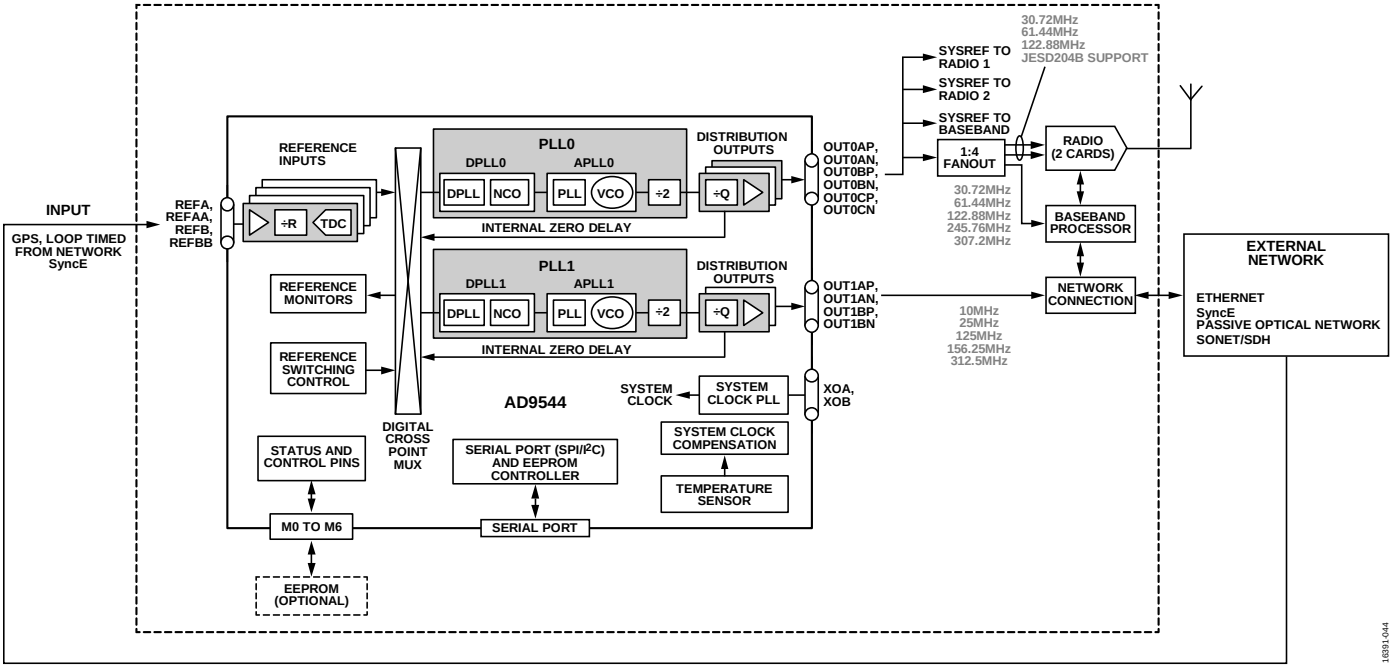


Figure 42. Small Cell Application

INITIALIZATION SEQUENCE

Figure 43, Figure 44, and Figure 45 describe the sequence for powering on and programming the AD9544.

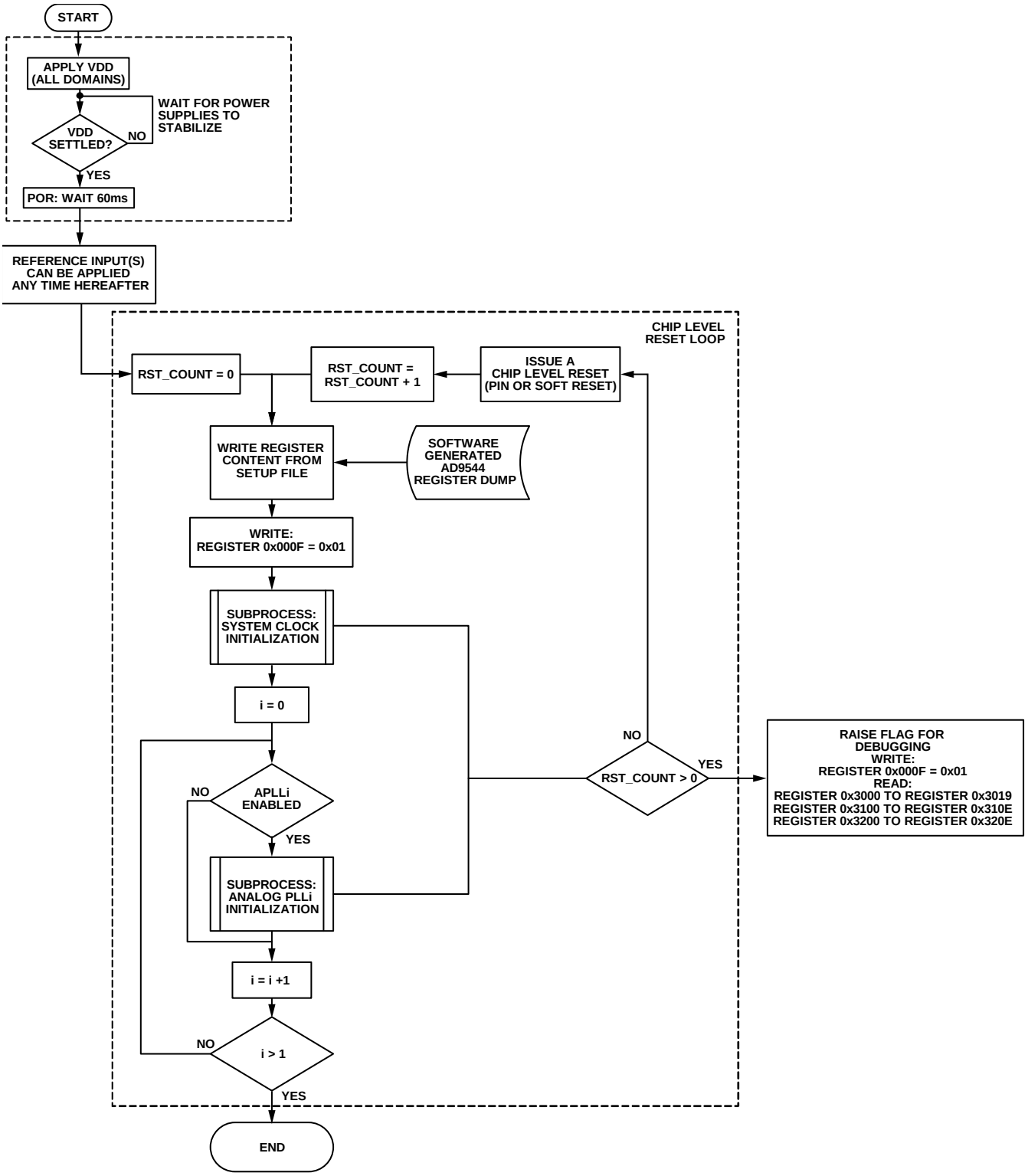
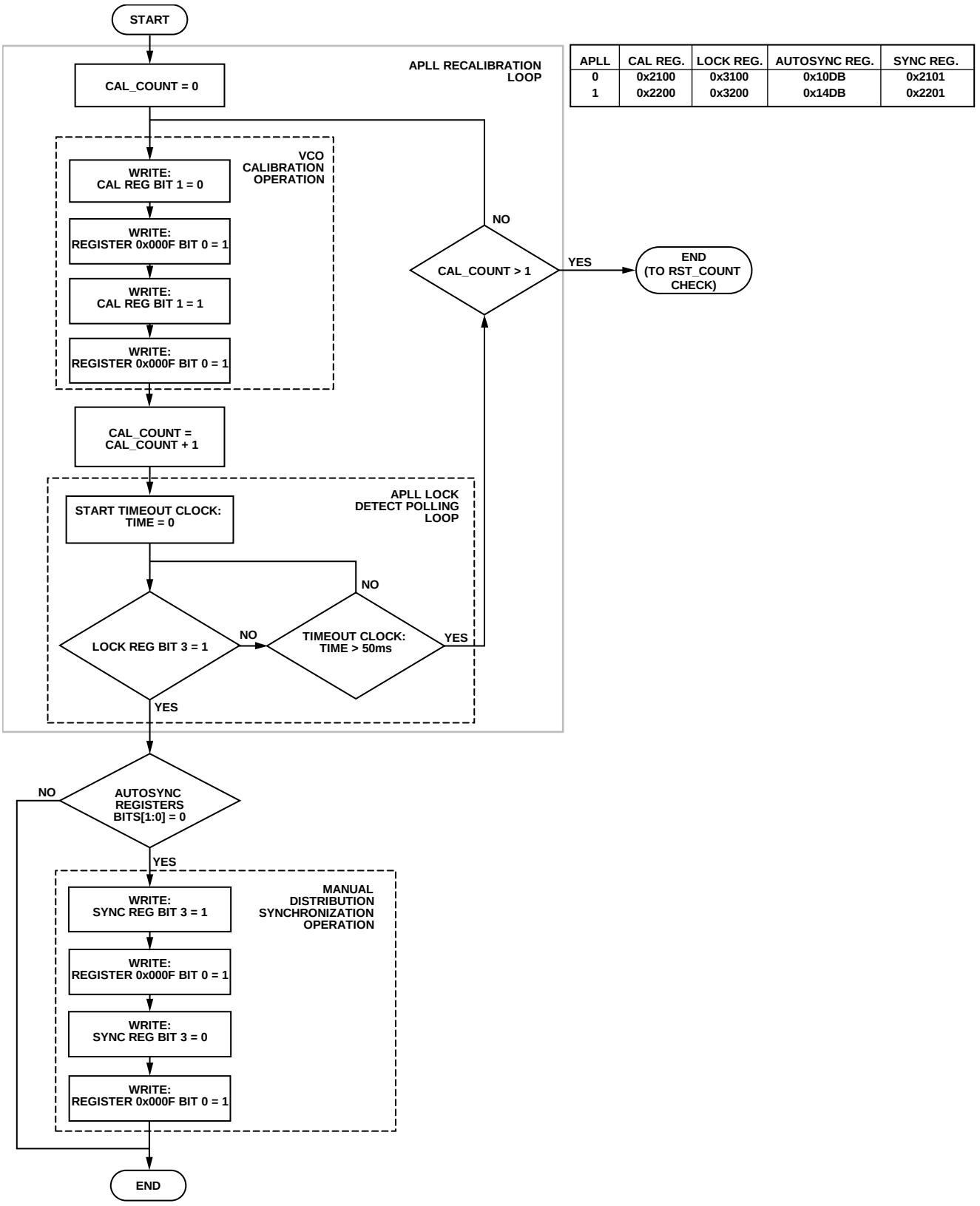
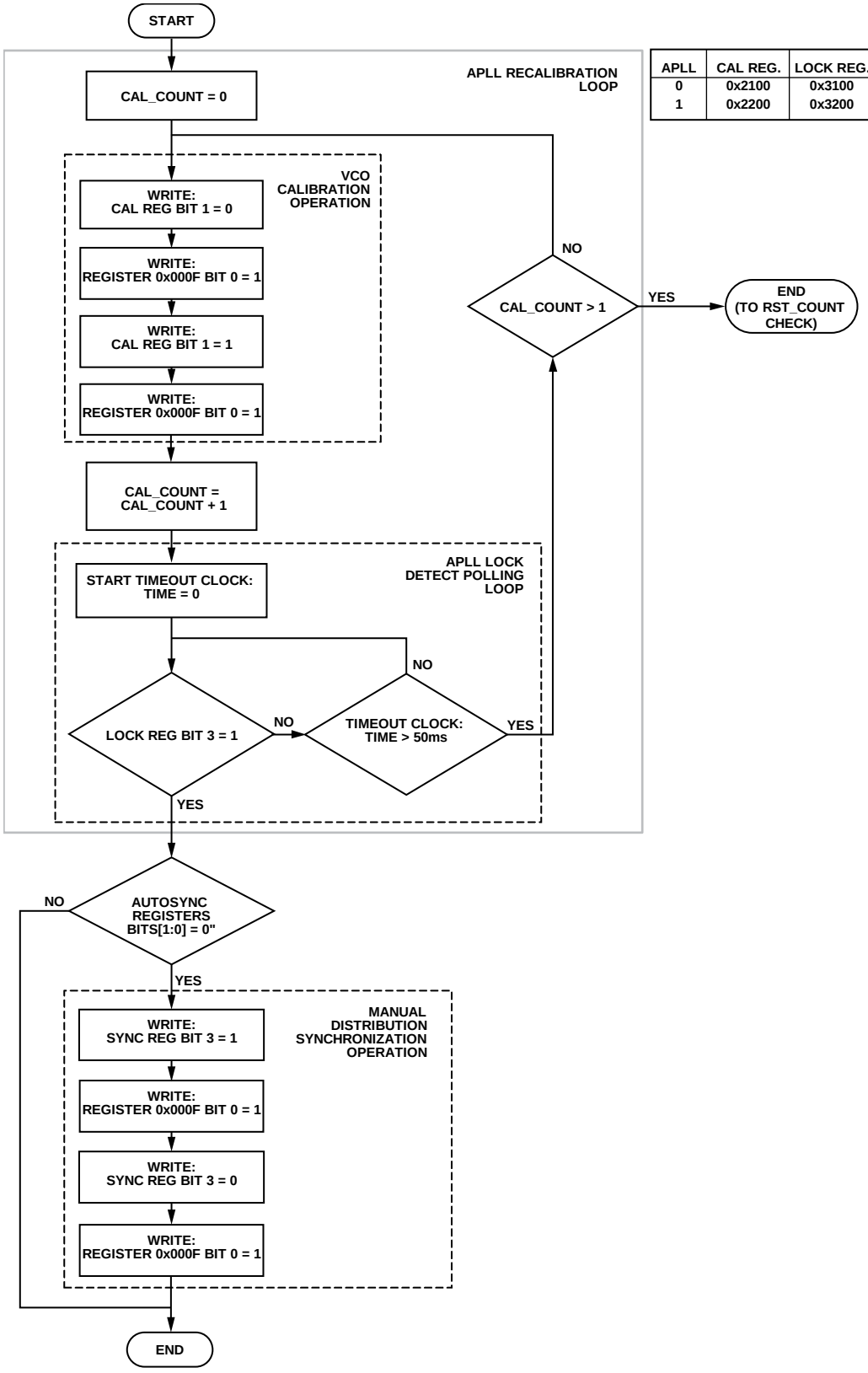


Figure 43. Programming Sequence Loop



APLL	CAL REG.	LOCK REG.	AUTOSYNC REG.	SYNC REG.
0	0x2100	0x3100	0x10DB	0x2101
1	0x2200	0x3200	0x14DB	0x2201

Figure 44. System Clock Initialization Subprocess



APLL	CAL REG.	LOCK REG.	AUTOSYNC REG.	SYNC REG.
0	0x2100	0x3100	0x10DB	0x2101
1	0x2200	0x3200	0x14DB	0x2201

16391-103

Figure 45. Analog PLL Initialization Subprocess

STATUS AND CONTROL PINS

The AD9544 features seven independently configurable digital CMOS status/control pins (M0 to M6). Configuring an Mx pin as a status pin causes that pin to be an output. Conversely, configuring an Mx pin as a control pin causes that pin to be an input. Register 0x0102 to Register 0x0108 control both the nature of the pin (either status or control via Bit D7), as well as the selection of the status source or control destination associated with the pin via Bits[D6:D0]. During power-up or reset, the Mx pins temporarily become inputs and only allow the device to autoconfigure. Figure 46 is a block diagram of the Mx pin functionality.

The Mx pin control logic uses special register write detection logic to prevent these pins from behaving unpredictably when the Mx pin function changes, especially when changing mode from input to output or vice versa.

When an Mx pin functions as an output, it continues operating according to the prior function, even after the user programs the corresponding registers. However, assertion of an input/output update causes the corresponding pins to switch to the new function according to the newly programmed register contents. Note that changing from one output function to another output function on an Mx pin does not require special timing to avoid input/output contention on the pin.

When an Mx pin functions as an input, programming a particular Mx pin function register causes all the Mx pin control functions to latch their values. Assertion of an input/output update switches to the newly programmed pin function, at which time normal behavior resumes. Note that, when switching from one input function to another input function on the same pin, the logic state driven at the input to the pin can change freely during the interval between writing the new function to the corresponding register and asserting the input/output update.

When switching the operation of an Mx pin from an input to an output function, the recommendation is that the external drive source become high impedance during the interval between writing the new function and asserting the input/output update.

When switching the operation of an Mx pin from an output to an input, the recommendation is as follows. First, program the Mx pin input function to no operation (NOOP) and assert the input/output update. This configuration avoids input/output contention on the Mx pin or other undesired behavior because, prior to the assertion of the input/output update, the device continues to drive the Mx pin. Following the assertion of the input/output update, the device releases the Mx pin but ignores the logic level on the pin due to the programmed NOOP function. Note that the recommendation is to avoid using a high impedance source on an Mx pin configured as an input because this may cause excessive internal current consumption. Second, drive the Mx pin with Logic 0 or Logic 1 via the desired external source and program the associated Mx pin register from NOOP to the desired function.

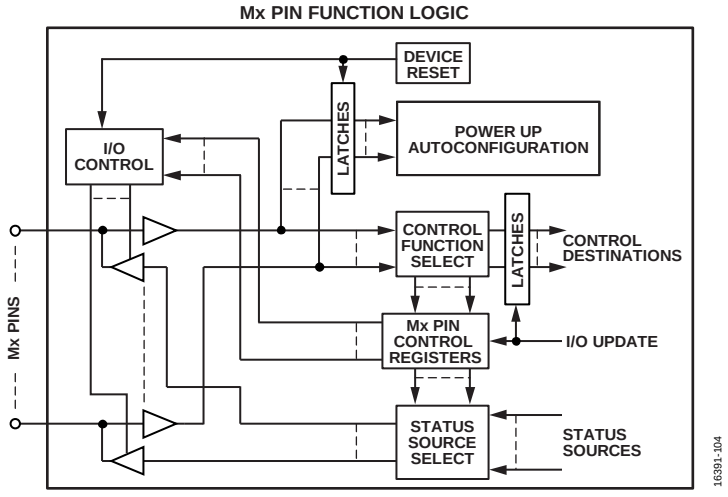


Figure 46. Mx Pin Logic

MULTIFUNCTION PINS AT RESET/POWER-UP

At power-up or in response to a reset operation, the Mx pins enter a special operating mode. For a brief interval following a power-up or reset operation, the Mx pins function only as inputs (the internal drivers enter a high impedance state during a power-up/reset operation). During this brief interval, the device latches the logic levels at the Mx inputs and uses this information to autoconfigure the device accordingly. The Mx pins remain high-Z until either an EEPROM operation occurs, in which case M1 or M2 become an I²C master, or the user (or EEPROM) programs them to be outputs.

If the user does not connect external pull-up/pull-down resistors to the Mx pins, the M3 and M4 pins have internal pull-down resistors to ensure a predictable start-up configuration. In the absence of external resistors, the internal pull-down resistors ensure that the device starts up with the serial port in SPI mode and without automatically loading data from an external EEPROM (see Table 26). Although the M0, M1, M2, M5, and M6 pins are high impedance at startup, connect external 100 kΩ pull-down or pull-up resistors to these pins to ensure robust operation.

The Mx pin start-up conditions are shown in Table 26. M0, M1, and M2 are excluded from Table 26 because these pins have no explicit function during a power-up or reset operation.

Table 26. Mx Pin Function at Startup or Reset

Mx Pin	Startup/Reset Function	Logic 1	Logic 0
M3	EEPROM load function	Load from EEPROM	Do not load from EEPROM (default)
M4	Serial port function	I²C mode	SPI mode (default)
M5	I²C address offset	See Table 27	See Table 27
M6	I²C address offset	See Table 27	See Table 27

When the start-up conditions select the serial port to be I²C mode (that is, M4 is Logic 1 at startup), the M5 and M6 pins determine the I²C port device address offset per Table 27. Note that the logic levels in Table 27 only apply during a power-up or reset operation.

Table 27. I²C Device Address Offset

M6	M5	M4	Address Offset
X[1]	X[1]	0	Not applicable
0	0	1	1001000 (0x48)
0	1	1	1001001 (0x49)
1	0	1	1001010 (0x4A)
1	1	1	1001011 (0x4B)

[1] X means don't care.

STATUS FUNCTIONALITY

Configuring an Mx pin as a status pin gives the user access to specific internal device status/IRQ functions in the form of a hardware pin that produces a logic signal. Each Mx pin has a corresponding Mx function register. To assign an Mx pin as a status pin, write a Logic 1 to the Mx output enable bit in the corresponding Mx pin function register.

To assign a specific status/IRQ function to an Mx pin configured as a status pin, program the appropriate 7-bit code (see Table 30) to Bits[D6:D0] of the corresponding Mx function register. See the Interrupt Request (IRQ) section for details regarding IRQ functionality.

When configured as a status pin, the output mode of an Mx pin depends on a 2-bit mode code per Table 28. The 2-bit codes reside in Register 0x0100 through Register 0x0101, where the 2-bit codes constitute the Mx receiver/driver bit fields. Note that the Mx receiver/driver bit fields perform a different function when the Mx pin is a control pin (see the Control Functionality section).

Table 28. Mx Receiver/Driver Bit Field Codes for Mx Status Pins

Code	Mode	Description
00	CMOS, active high	Output is Logic 0 when deasserted and Logic 1 when asserted (default operating mode).
01	CMOS, active low	Output is Logic 1 when deasserted and Logic 0 when asserted.
10	PMOS, open drain	Output is high impedance when deasserted and active high when asserted.
11	NMOS, open drain	Output is high impedance when deasserted and active low when asserted.

The PMOS open-drain mode requires an external pull-down resistor. The NMOS open-drain mode requires an external pull-up resistor. Note that the open-drain modes enable the implementation of wire-OR'ed functionality of multiple Mx status pins (including Mx status pins across multiple AD9544 devices or other compatible devices—for example, to implement an IRQ bus).

The drive strength of an Mx status pin is programmable via the corresponding Mx configuration bits (Bits[D6:D0] of the pin drive strength register). Logic 0 (default) selects normal drive strength (~6 mA) and Logic 1 selects weak drive strength (~3 mA).

CONTROL FUNCTIONALITY

Configuring an Mx pin as a control pin gives the user control of the specific internal device functions via an external hardware logic signal. Each Mx pin has a corresponding Mx function register. To assign an Mx pin as a control pin, write a Logic 0 to the Mx output enable bit in the corresponding Mx function register.

To assign an Mx control pin to a specific function, program the appropriate 7-bit code (see Table 30) to Bits[D6:D0] of the corresponding Mx function register. See the Interrupt Request (IRQ) section for details regarding IRQ functionality.

When configured as an Mx control pin, the logical level applied to the Mx pin translates to the selected device function. It is also possible to assign multiple Mx control pins to the same control function with the multiple pins implementing a Boolean expression. The Boolean operation associated with an Mx control pin depends on a 2-bit code per Table 29. The 2-bit codes reside in Register 0x100 through Register 0x101, where the 2-bit codes constitute the Mx receiver/driver bit fields. Note that the Mx receiver/driver bit fields perform a different function when the Mx pin is a status pin (see the Status Functionality section).

Table 29. Mx Receiver/Driver Bit Field Codes for Mx Control Pins

Code	Boolean	Description
00	AND	Logical AND the associated Mx control pin with the other Mx control pins assigned to the same control function.
01	NOT AND	Invert the logical state of the associated Mx control pin and AND it with the other Mx control pins assigned to the same control function.
10	OR	Logical OR the associated Mx control pin with the other Mx control pins assigned to the same control function.
11	NOT OR	Invert the logical state of the associated Mx control pin and OR it with the other Mx control pins assigned to the same control function.

The Boolean functionality of aggregated Mx control pins follows a hierarchy whereby logical OR operations occur before logical AND operations. The OR and NOT OR operations are collectively grouped into a single result. A logical AND is then performed using that result and the remaining AND and NOT AND operations.

Consider a case where M0, M2, M3, and M6 are all assigned to the input/output update control function; that is, Bits[D6:D0] in Register 0x0102 through Register 0x0108 = 0x01 (see Table 30). In addition, M0 is assigned for AND operation, M2 for NOT OR operation, M3 for NOT AND operation, and M6 for OR operation (that is, the 2-bit codes in Register 0x0100 and Register 0x0101 according to Table 29). With these settings, the input/output update function behaves according the following Boolean equation:

Input/output update = (!*M2* || *M6*) && *M0* && *!M3*

where:
! is logical NOT. Therefore, an input/output update occurs when M0 is Logic 1 and M3 is Logic 0, and either M2 is Logic 0 or M6 is Logic 1.
&& is logical AND.
|| is logical OR.

When an Mx control pin acts on a control function individually (rather than as part of a group, per the previous example), the Boolean functionality of the codes in Table 29 reduces to two possibilities. Namely, Code 00 and Code 10 specify a Boolean true (the Mx pin logic state applies to the corresponding control function directly), whereas Code 01 and Code 11 specify a Boolean false (the Mx pin logic state applies to the corresponding control function with a logical inversion).

Regarding the source and destination proxy columns in Table 30, the &&, || and ! symbols denote the Boolean AND, OR, and NOT operations, respectively.

Table 30. Mx Pin Status and Control Codes

Bits[D6:D0] (Hex)	Control Function	Destination Proxy	Status Function	Source Proxy (or Description)
0x00	No operation (NOOP)	Not applicable	Logic 0, static	Not applicable
0x01	IO_UPDATE	Register 0x000F, Bit D0	Logic 1, static	Not applicable
0x02	Device power down	Register 0x2000, Bit D0	Digital core clock	Not applicable
0x03	Clear watchdog timer	Register 0x2005, Bit D7	Watchdog timer timeout	Not applicable
0x04	Sync all	Register 0x2000, Bit D3	SYSCLK calibration in progress	Register 0x3001, Bit D2
0x05	Unassigned	Not applicable	SYSCLK lock detect	Register 0x3001, Bit D0
0x06	Unassigned	Not applicable	SYSCLK stable	Register 0x3001, Bit D1
0x07	Unassigned	Not applicable	Channel 0 and Channel 1 PLLs locked	Register 0x3001, Bit D4 && Bit D5
0x08	Unassigned	Not applicable	PLL0 locked	Register 0x3001, Bit D4
0x09	Unassigned	Not applicable	PLL1 locked	Register 0x3001, Bit D5
0x0A	Unassigned	Not applicable	EEPROM save in progress	Register 0x3000, Bit D0
0x0B	Unassigned	Not applicable	EEPROM load in progress	Register 0x3000, Bit D1
0x0C	Unassigned	Not applicable	EEPROM fault detected	Register 0x3000, Bit D2 || Bit D3
0x0D	Unassigned	Not applicable	Temperature sensor limit alarm	Register 0x3002, Bit D0
0x0E	Unassigned	Not applicable	Unassigned	Not applicable
0x0F	Unassigned	Not applicable	Unassigned	Not applicable
0x10	Clear all IRQ events	Register 0x2005, Bit D0	Any IRQ event	The logical OR of all triggered IRQ events

Bits[D6:D0] (Hex)	Control Function	Destination Proxy	Status Function	Source Proxy (or Description)
0x11	Clear common IRQ events	Register 0x2005, Bit D1	Common IRQ event	The logical OR of all triggered common IRQ events
0x12	Clear PLL0 IRQ events	Register 0x2005, Bit D2	PLL0 IRQ event	The logical OR of all triggered PLL0 IRQ events
0x13	Clear PLL1 IRQ events	Register 0x2005, Bit D3	PLL1 IRQ event	The logical OR of all triggered PLL1 IRQ events
0x14	Unassigned	Not applicable	REFA demodulator clock	Not applicable
0x15	Unassigned	Not applicable	Unassigned	Not applicable
0x16	Unassigned	Not applicable	REFAA demodulator clock	Not applicable
0x17	Unassigned	Not applicable	Unassigned	Not applicable
0x18	Unassigned	Not applicable	REFB demodulator clock	Not applicable
0x19	Unassigned	Not applicable	Unassigned	Not applicable
0x1A	Unassigned	Not applicable	REFBB demodulator clock	Not applicable
0x1B	Unassigned	Not applicable	Unassigned	Not applicable
0x1C	Unassigned	Not applicable	REFA reference (R) divider resync	Register 0x300D, Bit D3
0x1D	Unassigned	Not applicable	REFAA R divider resync	Register 0x300D, Bit D7
0x1E	Unassigned	Not applicable	REFB R divider resync	Register 0x300E, Bit D3
0x1F	Unassigned	Not applicable	REFBB R divider resync	Register 0x300E, Bit D7
0x20	Fault REFA	Register 0x2003, Bit D0	REFA faulted	Register 0x3005, Bit D3
0x21	Fault REFAA	Register 0x2003, Bit D1	REFAA faulted	Register 0x3006, Bit D3
0x22	Fault REFB	Register 0x2003, Bit D2	REFB faulted	Register 0x3007, Bit D3
0x23	Fault REFBB	Register 0x2003, Bit D3	REFBB faulted	Register 0x3008, Bit D3
0x24	Unassigned	Not applicable	REFA valid	Register 0x3005, Bit D4
0x25	Unassigned	Not applicable	REFAA valid	Register 0x3006, Bit D4
0x26	Unassigned	Not applicable	REFB valid	Register 0x3007, Bit D4
0x27	Unassigned	Not applicable	REFBB valid	Register 0x3008, Bit D4
0x28	Timeout REFA validation	Register 0x2002, Bit D0 (validate REFA if faulted; otherwise, no action)	REFA active	This function represents a logical combination of several registers and bits
0x29	Timeout REFAA validation	Register 0x2002, Bit D1 (validate REFAA if faulted; otherwise, no action)	REFAA active	This function represents a logical combination of several registers and bits
0x2A	Timeout REFB validation	Register 0x2002, Bit D2 (validate REFB if faulted; otherwise, no action)	REFB active	This function represents a logical combination of several registers and bits
0x2B	Timeout REFBB validation	Register 0x2002, Bit D3 (validate REFBB if faulted; otherwise, no action)	REFBB active	This function represents a logical combination of several registers and bits
0x2C	Unassigned	Not applicable	Not applicable	Not applicable
0x2D	Unassigned	Not applicable	Not applicable	Not applicable
0x2E	Unassigned	Not applicable	Feedback 0 active	Not applicable
0x2F	Unassigned	Not applicable	Feedback 1 active	Not applicable
0x30	Not applicable	Not applicable	DPLL0 phase locked	Register 0x3100, Bit D1
0x31	Not applicable	Not applicable	DPLL0 frequency locked	Register 0x3100, Bit D2
0x32	Not applicable	Not applicable	APLL0 locked	Register 0x3100, Bit D3
0x33	Unassigned	Not applicable	APLL0 calibration in progress	Register 0x3100, Bit D4
0x34	Unassigned	Not applicable	DPLL0 active	Register 0x3009, Bit D5 || Bit D4 || Bit D3 || Bit D2 || Bit D1 || Bit D0
0x35	Unassigned	Not applicable	DPLL0 freerun	Register 0x3101, Bit D0
0x36	Unassigned	Not applicable	DPLL0 holdover	Register 0x3101, Bit D1
0x37	Unassigned	Not applicable	DPLL0 switching	Register 0x3101, Bit D2

Bits[D6:D0] (Hex)	Control Function	Destination Proxy	Status Function	Source Proxy (or Description)
0x38	Unassigned	Not applicable	DPLL0 tuning word history status	Register 0x3102, Bit D0
0x39	Unassigned	Not applicable	DPLL0 tuning word history updated	Not applicable
0x3A	Unassigned	Not applicable	DPLL0 frequency clamped	Register 0x3102, Bit D1
0x3B	Unassigned	Not applicable	DPLL0 phase slew limited	Register 0x3102, Bit D2
0x3C	Unassigned	Not applicable	PLL0 distribution synchronized	Not applicable
0x3D	Unassigned	Not applicable	Unassigned	Not applicable
0x3E	Unassigned	Not applicable	DPLL0 phase step detected	Not applicable
0x3F	Unassigned	Not applicable	DPLL0 fast acquisition active	Register 0x3102, Bit D4
0x40	PLL0 power-down	Register 0x2100, Bit D0	DPLL0 fast acquisition complete	Register 0x3102, Bit D5
0x41	DPLL0 user freerun	Register 0x2105, Bit D0	DPLL0 feedback divider resync	Not applicable
0x42	DPLL0 user holdover	Register 0x2105, Bit D1	PLL0 distribution phase slew enable	Register 0x310D, logical OR of Bits[5:0]
0x43	DPLL0 clear tuning word history	Register 0x2107, Bit D1	PLL0 distribution configuration error	Register 0x310E, logical OR of Bits[5:0]
0x44	Synchronize PLL0 distribution dividers	Register 0x2101, Bit D3	Unassigned	Not applicable
0x45	DPLL0 translation profile select, Bit 0	Register 0x2105, Bit D4	Unassigned	Not applicable
0x46	DPLL0 translation profile select, Bit 1	Register 0x2105, Bit D5	Unassigned	Not applicable
0x47	DPLL0 translation profile select, Bit 2	Register 0x2105, Bit D6	Unassigned	Not applicable
0x48	Unassigned	Not applicable	Unassigned	Not applicable
0x49	Unassigned	Not applicable	Unassigned	Not applicable
0x4A	Unassigned	Not applicable	Unassigned	Not applicable
0x4B	Unassigned	Not applicable	Unassigned	Not applicable
0x4C	Unassigned	Not applicable	Unassigned	Not applicable
0x4D	Unassigned	Not applicable	Unassigned	Not applicable
0x4E	Unassigned	Not applicable	Unassigned	Not applicable
0x4F	Unassigned	Not applicable	Unassigned	Not applicable
0x50	Mute OUT0A	Register 0x2102, Bit D2	DPLL1 phase locked	Register 0x3200, Bit D1
0x51	Mute OUT0AA	Register 0x2102, Bit D3	DPLL1 frequency locked	Register 0x3200, Bit D2
0x52	Reset OUT0A/ OUT0AA driver	Register 0x2102, Bit D5	APLL1 locked	Register 0x3200, Bit D3
0x53	Mute OUT0B	Register 0x2103, Bit D2	APLL1 calibration in progress	Register 0x3200, Bit D4
0x54	Mute OUT0BB	Register 0x2103, Bit D3	DPLL1 active	Register 0x300A, Bit D5 || Bit D4 || Bit D3 || Bit D2 || Bit D1 || Bit D0
0x55	Reset OUT0B/ OUT0BB driver	Register 0x2103, Bit D5	DPLL1 freerun	Register 0x3201, Bit D0
0x56	Mute OUT0C	Register 0x2104, Bit D2	DPLL1 holdover	Register 0x3201, Bit D1
0x57	Mute OUT0CC	Register 0x2104, Bit D3	DPLL1 switching	Register 0x3201, Bit D2
0x58	Reset OUT0C/ OUT0CC driver	Register 0x2104, Bit D5	DPLL1 tuning word history status	Register 0x3202, Bit D0
0x59	Mute OUT0xP/ OUT0xN drivers	Register 0x2101, Bit D1	DPLL1 tuning word history updated	Not applicable
0x5A	Reset OUT0xP/ OUT0xN drivers	Register 0x2101, Bit D2	DPLL1 frequency clamped	Register 0x3202, Bit D1
0x5B	Channel 0 N-shot request	Register 0x2101, Bit D0	DPLL1 phase slew limited	Register 0x3202, Bit D2
0x5C	Unassigned	Not applicable	PLL1 distribution synchronized	Not applicable

Bits[D6:D0] (Hex)	Control Function	Destination Proxy	Status Function	Source Proxy (or Description)
0x5D	Unassigned	Not applicable	Unassigned	Not applicable
0x5E	Unassigned	Not applicable	DPLL1 phase step detected	Not applicable
0x5F	Unassigned	Not applicable	DPLL1 fast acquisition active	Register 0x3202, Bit D4
0x60	PLL1 power-down	Register 0x2200, Bit D0	DPLL1 fast acquisition complete	Register 0x3202, Bit D5
0x61	DPLL1 force freerun	Register 0x2205, Bit D0	DPLL1 feedback divider resync	Not applicable
0x62	DPLL1 force holdover	Register 0x2205, Bit D1	PLL1 distribution phase slew enable OR'ed	Register 0x320D, Logical OR of Bits[3:0]
0x63	DPLL1 clear tuning word history	Register 0x2207, Bit D1	PLL1 distribution phase control error OR'ed	Register 0x320E, Logical OR if Bits[3:0]
0x64	Synchronize PLL1 distribution dividers	Register 0x2201, Bit D3	Unassigned	Not applicable
0x65	DPLL1 translation profile select, Bit 0	Register 0x2205, Bit D4	Unassigned	Not applicable
0x66	DPLL1 translation profile select, Bit 1	Register 0x2205, Bit D5	Unassigned	Not applicable
0x67	DPLL1 translation profile select, Bit 2	Register 0x2205, Bit D6	Unassigned	Not applicable
0x68	Unassigned	Not applicable	Unassigned	Not applicable
0x69	Unassigned	Not applicable	Unassigned	Not applicable
0x6A	Unassigned	Not applicable	Unassigned	Not applicable
0x6B	Unassigned	Not applicable	Unassigned	Not applicable
0x6C	Unassigned	Not applicable	Unassigned	Not applicable
0x6D	Unassigned	Not applicable	Unassigned	Not applicable
0x6E	Unassigned	Not applicable	Unassigned	Not applicable
0x6F	Unassigned	Not applicable	Unassigned	Not applicable
0x70	Mute OUT1A	Register 0x2202, Bit D2	Not applicable	Not applicable
0x71	Mute OUT1AA	Register 0x2202, Bit D3	Not applicable	Not applicable
0x72	Reset OUT1A/OUT1AA driver	Register 0x2202, Bit D5	Not applicable	Not applicable
0x73	Mute OUT1B	Register 0x2203, Bit D2	Not applicable	Not applicable
0x74	Mute OUT1BB	Register 0x2203, Bit D3	Not applicable	Not applicable
0x75	Reset OUT1B/OUT1BB driver	Register 0x2203, Bit D5	Not applicable	Not applicable
0x76	Mute OUT1xP/OUT1xN drivers	Register 0x2201, Bit D1	Unassigned	Not applicable
0x77	Reset OUT1xP/OUT1xN drivers	Register 0x2201, Bit D2	Unassigned	Not applicable
0x78	Channel 1 N-shot request	Register 0x2201, Bit D0	Timestamp 0 event detected	Not applicable
0x79	Unassigned	Not applicable	Timestamp 1 event detected	Not applicable
0x7A	Unassigned	Not applicable	Skew measurement detected	Not applicable
0x7B	Unassigned	Not applicable	Unassigned	Not applicable
0x7C	Unassigned	Not applicable	Unassigned	Not applicable
0x7D	Unassigned	Not applicable	Unassigned	Not applicable
0x7E	Unassigned	Not applicable	Unassigned	Not applicable
0x7F	Unassigned	Not applicable	Unassigned	Not applicable

INTERRUPT REQUEST (IRQ)

The AD9544 monitors certain internal device events potentially allowing them to trigger an IRQ event. Three groups of registers (see Figure 47) control the IRQ functionality within the AD9544:

- IRQ monitor registers (Register 0x300B through Register 0x3019)
- IRQ mask registers (Register 0x010C through Register 0x011A)
- IRQ clear registers (Register 0x2006 through Register 0x2014)

The IRQ logic can indicate an IRQ event status result for any specific device event(s) via the logical OR of the status of all the IRQ monitor bits. In addition, the IRQ logic offers IRQ event status results for particular groups of specific IRQ events, namely, the PLL0 IRQs, PLL1 IRQs, and common IRQs (see Figure 47).

The PLL0 IRQ group includes all device events associated with DPLL0 and APLL0. The PLL1 IRQ group includes all device events associated with DPLL1 and APLL1. The common IRQ group includes events associated with the system clock, the watchdog timer, and the EEPROM.

IRQ MONITOR

The IRQ monitor registers (in the general status section of the register map) maintain a record of specific IRQ events. The occurrence of a specific device event results in the setting and latching of the corresponding bit in the IRQ monitor. The output of the IRQ monitor provides the mechanism for generating IRQ event status results (see the PLL0 IRQ, PLL1 IRQ, common IRQ, or any IRQ signal shown in Figure 47).

IRQ MASK

The IRQ mask registers (in the Mx pin status and control section of the register map) comprise a bit for bit correspondence with the specific IRQ event bits within the IRQ monitor. Writing a Logic 1 to a mask bit enables (unmasks) the corresponding specific device event to the IRQ monitor. A Logic 0 (default) disables (masks) the corresponding specific device event to the IRQ monitor. Therefore, a specific IRQ event is the result of a logical AND of a specific device event and its associated IRQ, mask bit.

The presence of the IRQ mask allows the user to select certain device events for generating an IRQ event, while ignoring (masking) all other specific device events from contributing to an IRQ event status result (PLL0 IRQ, PLL1 IRQ, common IRQ or any IRQ signal in Figure 47). Note that the default state of the IRQ mask register bits is Logic 0; therefore, the device is not capable of generating an IRQ event status result until the user populates the IRQ mask with a Logic 1 to unmask the desired specific IRQ events. Writing a Logic 1 to an IRQ mask bit may result in immediate indication of an IRQ status event result if the corresponding specific device event is already asserted (that is, the device previously registered the corresponding device event).

IRQ CLEAR

The IRQ clear registers (in the operational controls section of the register map) comprise a bit for bit correspondence with the IRQ monitor. Writing a Logic 1 to an IRQ clear bit forces the corresponding IRQ monitor bit to Logic 0, thereby clearing that specific IRQ event. Note that the IRQ clear registers are autoclearing; therefore, after writing a Logic 1 to an IRQ clear bit, the device automatically restores the IRQ clear bit to Logic 0. The IRQ event status results remain asserted until the user clears all of the bits in the IRQ monitor responsible for the IRQ status result (that is, the entire group of status bits associated with PLL0 IRQ, PLL1 IRQ, common IRQ, or any IRQ signal shown in Figure 47).

Although it is not recommended, in certain applications, it may be desirable to clear an entire IRQ group all at one time. Register 0x2005 provides four bits for clearing IRQ groups. Bit D0 clears all IRQ monitor bits. Bit D1 clears the common IRQ bits. Bit D2 clears the PLL0 IRQ bits. Bit D3 clears the PLL1 IRQ bits.

Alternately, the user can program any of the multifunction pins as an input for clearing an IRQ group, which allows clearing an IRQ group with an external logic signal rather than by writing to Register 0x2005 (see Figure 47).

The recommendation for clearing IRQ status events is to first service the specific IRQ event (as needed) and then clear the specific IRQ for that particular IRQ event. Clearing IRQ groups via Register 0x2005 or via an Mx pin requires great care. Clearing an IRQ group all at one time may result in the unintentional clearing of one or more asserted IRQ monitor bits. Clearing asserted IRQ monitor bits eliminates the record of the associated device events, subsequently erasing any history of those events having occurred.

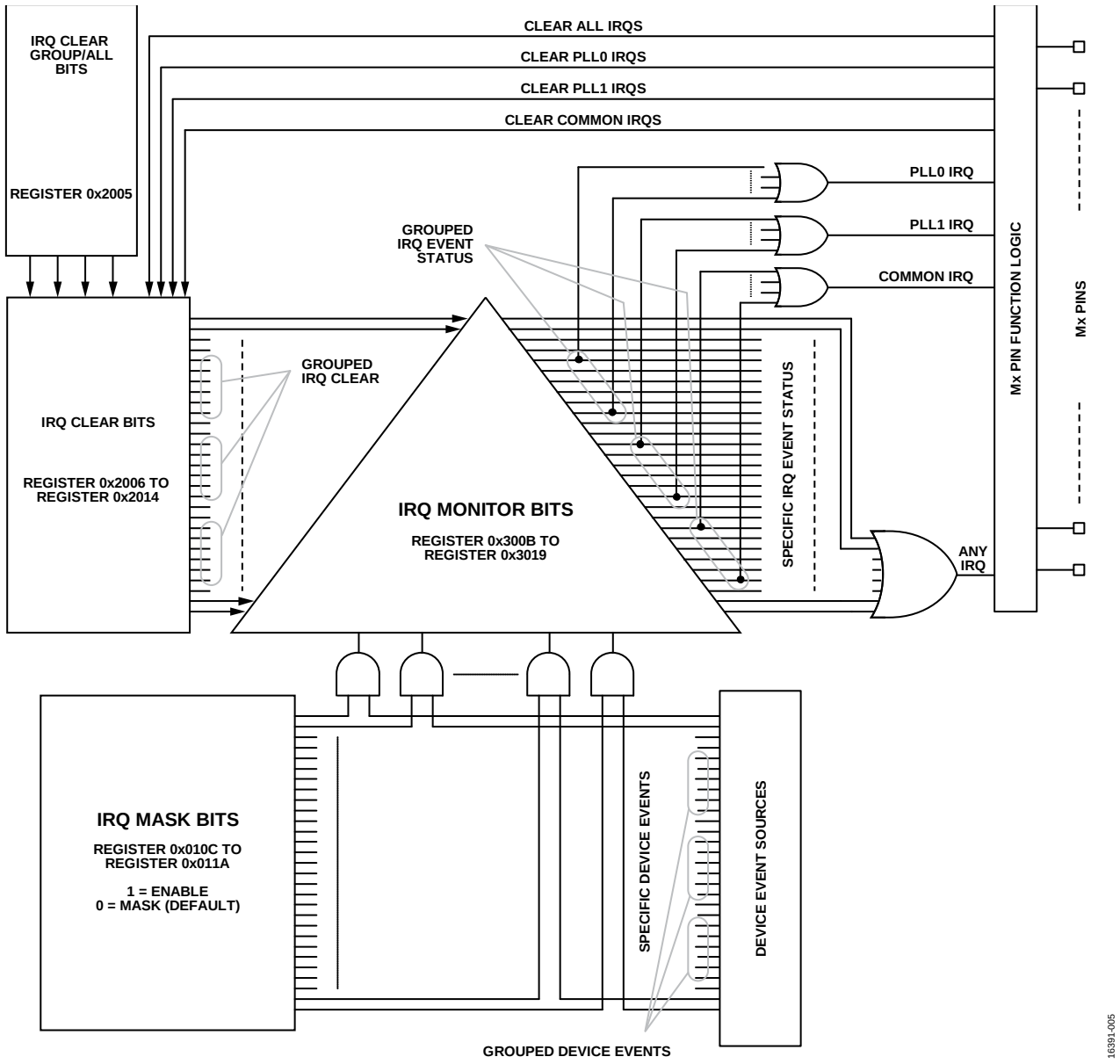


Figure 47. IRQ System Diagram

WATCHDOG TIMER

The watchdog timer is a general-purpose programmable timer capable of triggering a specific IRQ event (see Figure 48). The timer relies on the system clock, however; therefore, the system clock must be present and locked for the watchdog timer to be functional. The bit fields associated with the watchdog timer reside in the Mx pin status and control function section of the register map.

The user sets the period of the watchdog timer by programming the watchdog timer (ms) bit field with a 16-bit timeout value. A nonzero value sets the timeout period in units of milliseconds, providing a range of 1 ms to 65.535 sec, whereas a zero value (0x0000, the default value) disables the timer. The relative accuracy of the timer is approximately 0.1% with an uncertainty of 0.5 ms. Note that whenever the user writes a 16-bit timeout value to the watchdog timer, it automatically clears the timer, ensuring a correct timeout period (per the new value) starting from the moment of the bit field update.

The watchdog timer (ms) bit field relates to the timeout period as follows:

$$Watchdog\ Timer\ (\text{ms}) = Timeout\ Period \times 10^3$$

To determine the value of the watchdog timer (ms) bit field necessary for a timeout period of 10 sec,

$$Watchdog\ Timer\ (\text{ms}) = Timeout\ Period \times 103$$

$$= 10 \times 103$$

$$= 10{,}000$$

$$= 0x2710\ (\text{hexadecimal})$$

If enabled, the timer runs continuously and generates a timeout IRQ event when the timeout period expires. The user has access to the watchdog timer status via its associated IRQ monitor bit or by assigning it directly to an Mx status pin. In the case of an Mx status pin, the timeout event of the watchdog timer is a pulse spanning 96 system clock periods (approximately 40 ns).

There are two ways to reset the watchdog timer, thereby preventing it from indicating a timeout event. The first method is by writing a Logic 1 to the clear watchdog bit (an autoclearing bit) in the operational controls section of the register map. Alternatively, the user can program any of the multifunction pins as a control pin to reset the watchdog timer, which allows the user to reset the timer by means of a hardware pin rather than using the serial port.

There are two typical cases for employing the watchdog timer. Both cases assume that the watchdog timer output appears at the output of an appropriately configured Mx status pin (the watchdog timer output for the following case descriptions). The first case is for an external device (for example, an FPGA or microcontroller) to monitor the watchdog timer output using it as a signal to carry out periodic housekeeping functions. The second case is to have the watchdog timer output connected to the external device, such that the assertion of the watchdog output resets the external device. In this way, under normal operation, the external device repeatedly resets the watchdog timer by either writing Logic 1 to the clear watchdog bit or by asserting an Mx control pin configured for clearing the watchdog. In this way, as long as the external device keeps resetting the watchdog timer before it times out, the watchdog timer does not generate an output signal. As such, the watchdog timer does not reset the external device. However, if the external device fails to reset the watchdog timer before its timeout period expires, the watchdog timer eventually times out, resetting the external device via the appropriately configured Mx status pin.

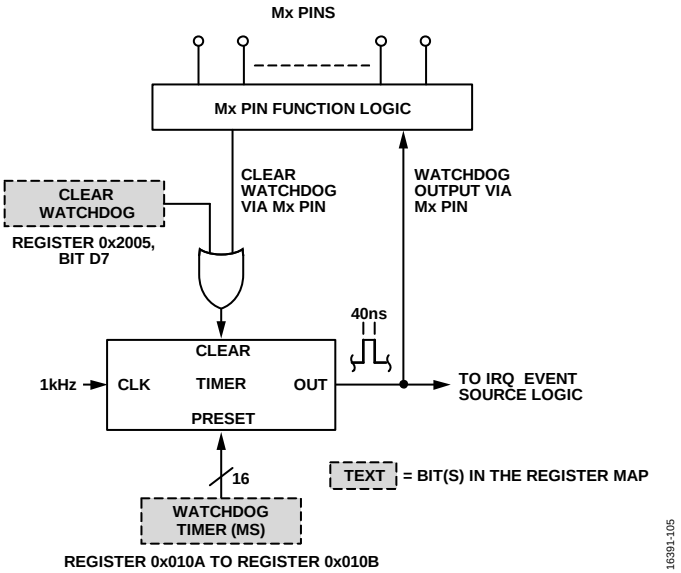


Figure 48. Watchdog Timer

LOCK DETECTORS

DPLL LOCK DETECTORS

DPLL Phase Lock Detector

Each DPLL channel (DPLL0 and DPLL1) contains an all digital phase lock detector. The user controls the threshold sensitivity and hysteresis of the phase detector via the source profiles.

The phase lock detector provides the user with two status bits in the status readback PLLx section of the register map. The DPLLx phase lock bit latches to Logic 1 when the DPLL changes state from not phase locked to phase locked. The DPLLx phase unlock bit latches to Logic 1 when the DPLL changes state from phase locked to not phase locked. The DPLLx phase lock bits are located in Register 0x3100 and 0x3200, respectively. Because these bits can change dynamically, it is strongly recommended that the user set an IRQ for these bits. When using the IRQ function, it is possible for the IRQ status to indicate Logic 1 for an IRQ function that was just enabled if that condition is true at the time the IRQ is enabled. Therefore, the user must clear the IRQ just enabled via the IRQ map DPLL0 clear (Register 0x200B to Register 0x200F) section and the IRQ map DPLL1 clear (Register 0x2010 to Register 0x2014) section of the register map to obtain visibility of subsequent state transitions of the phase lock detector.

The phase lock detector behaves in a manner analogous to water in a tub (see Figure 49). The total capacity of the tub is 4096 units, with −2048 denoting empty, 0 denoting the 50% point, and +2047 denoting full. The tub also has a safeguard to prevent overflow. Furthermore, the tub has a low water mark at −1025 and a high water mark at +1024. To change the water level, the phase lock detector adds water with a fill bucket or removes water with a drain bucket. To specify the size of the fill and drain buckets, use the unsigned 8-bit Profile x phase lock fill rate and Profile x phase lock fill rate bit field (where x is a value from 0 through 7, corresponding to a particular source profile).

The water level in the tub is what the lock detector uses to determine the lock and unlock conditions. When the water level is below the low water mark (−1025), the lock detector indicates an unlock condition. Conversely, when the water level is above the high water mark (+1024), the lock detector indicates a lock condition. When the water level is between the marks, the lock detector holds its last condition. Figure 49 shows this concept with an overlay of an example of the instantaneous water level (vertical) vs. time (horizontal) and the resulting lock/unlock states.

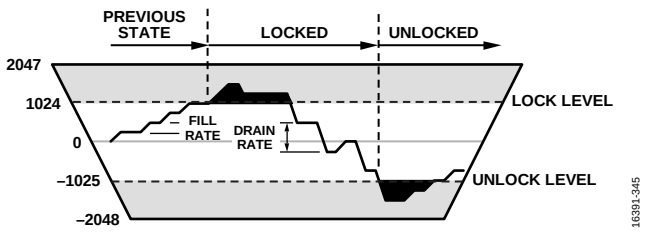


Figure 49. Lock Detector Diagram

During any given PFD phase error sample, the lock detector either adds water with the fill bucket or removes water with the drain bucket (one or the other, but not both). The decision of whether to add or remove water depends on the threshold level specified by the user in the 24-bit unsigned Profile x phase lock threshold bit field. The bit field value is the desired threshold in picoseconds. Thus, the phase lock threshold extends from 0 ps to 16.7 µs and represents the phase error at the output of the PFD. Though the programming range supports 0 ps as a lower limit, in practice, the minimum value must be greater than 50 ps.

The phase lock detector compares the absolute value of each phase error sample at the output of the PFD to the programmed phase threshold value. If the absolute value of the phase error sample is less than or equal to the programmed phase threshold value, the detector control logic adds one fill bucket into the tub. Otherwise, it removes one drain bucket from the tub. Note that it is the magnitude, relative to the phase threshold value, that determines whether to fill or drain the bucket, and not the polarity of the phase error sample.

An exception to the fill/drain process occurs when the phase slew limiter is active. When the phase slew limiter is actively in the limiting process, the lock detector blocks fill events, allowing only drain events to occur.

When more filling is taking place than draining, the water level in the tub eventually rises above the high water mark (+1024), which causes the lock detector to indicate lock. When more draining is taking place than filling, the water level in the tub eventually falls below the low water mark (−1024), which causes the lock detector to indicate unlock. The ability to specify the threshold level, fill rate, and drain rate enables the user to tailor the operation of the lock detector to the statistics of the timing jitter associated with the input reference signal. Note that, for debug purposes, the user can make the fill or drain rate zero to force the lock detector to indicate a lock or unlock state, respectively.

Note that whenever the AD9544 enters freerun or holdover mode, the DPLL phase lock detector indicates an unlocked state.

For more information on how to choose the appropriate phase lock threshold, fill rate, and drain rate values for a given application, refer to the AN-1061 Application Note.

DPLL Frequency Lock Detector

The operation of the frequency lock detector is identical to that of the phase lock detector, with two exceptions:

- The fill or drain decision is based on the period deviation between the reference of the DPLL and the feedback signals, instead of the phase error at the output of the PFD.
- The frequency lock detector is unaffected by the state of the phase slew limiter.

The frequency lock detector provides the user with two status bits in the IRQ map DPLLx mask section of the register map. The DPLLx frequency lock bit (where x is 0 or 1) latches to Logic 1 when the DPLL changes state from not frequency locked to frequency locked. The DPLLx frequency unlock bit latches to Logic 1 when the DPLL changes state from frequency locked to not frequency locked. Because these are latched bits, the user must clear them via the IRQ map DPLLx clear section of the register map to obtain visibility of subsequent state transitions of the frequency lock detector.

The frequency lock detector uses the 24-bit unsigned Profile x frequency lock threshold bit field (where x is a value from 0 through 7, corresponding to a particular source profile), specified in units of picoseconds. Thus, the frequency threshold value extends from 0 ps to 16.7 µs and represents the absolute value of the difference in period between the reference and feedback signals at the input to the DPLL.

$$Profile\ x\ Frequency\ Lock\ Threshold = |1/f_{REF} - 1/f_{FB}|/10^{-12}$$

where:
f_{REF} is the frequency of the signal at the DPLL PFD reference input.
f_{FB} is the frequency of the signal at the DPLL PFD feedback input.

Consider a case where it is desirable to set the Profile x frequency lock threshold bit field to meet the frequency threshold when the signal from the reference TDC is 80 kHz and the signal from the feedback TDC is 79.32 kHz (or vice versa).

$$Profile\ x\ Frequency\ Lock\ Threshold = |1/f_{REF} - 1/f_{FB}|/10^{-12}$$

$$= |1/80{,}000 - 1/79{,}320|/10^{-12}$$

= 170,161 (nearest integer)

= 0x0298B1 (hexadecimal)

For more information on how to choose the appropriate frequency lock threshold, fill rate, and drain rate values for a given application, refer to the AN-1061 Application Note.

PHASE STEP DETECTOR

PHASE STEP LIMIT

Although the AD9544 has the ability to switch between multiple reference inputs, some applications use only one input and handle reference switching externally (see Figure 50). Unfortunately, this arrangement forfeits the ability of the AD9544 to mitigate the output disturbance associated with a reference switchover, because the reference switchover is not under the control of the AD9544. However, the AD9544 offers a phase transient threshold detection feature to help identify when an external reference switchover occurs and to act accordingly.

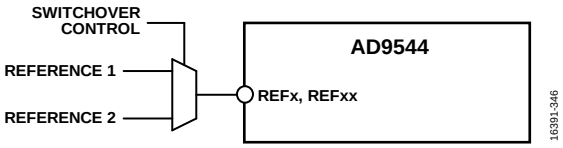


Figure 50. External Reference Switching

Phase transient threshold detection works by monitoring the output of the DPLL phase detector for phase transients, but in a manner that is somewhat jitter tolerant. Otherwise, the phase transient threshold detector is prone to false positives.

To activate the phase transient threshold detection, program the 32-bit unsigned Profile x phase step threshold bit field (where x is a value from 0 through 7, corresponding to a particular source profile). The default value is zero, which disables the phase transient threshold detector. A nonzero value denotes the desired phase step threshold in units of picoseconds per the following equation:

$$Phase\ Step\ Threshold = Profile\ x\ Phase\ Step\ Threshold \times 10^{-12}$$

Note that the phase transient threshold detector is not active unless the DPLL indicates frequency locked status.

As an example, determine the value of the Profile x phase step threshold bit field necessary for a 12 ns limit. Solving the previous equation for the phase step limit yields

$$Profile\ x\ Phase\ Step\ Threshold = (12 \times 10^{-9})/10^{-12}$$

$$= 12{,}000$$

$$= 0x00002EE0\ (hexadecimal)$$

To reduce the likelihood of jitter induced threshold violations, choose a phase step threshold of at least two times the expected rms jitter (σ_{JITTER}) associated with the input reference signal.

$$Profile\ x\ Phase\ Step\ Threshold \geq 2 \times \sigma_{JITTER}$$

As such, in the previous example with Profile x phase step threshold = 12,000, an input signal with 12 ns rms jitter is likely to produce false positives because the signal violates the previously described inequality. To reduce the likelihood of a false positive, the inequality indicates Profile x phase step threshold = 24,000 is a better choice. In fact, even with a value of 24,000, there is still a slight probability of a jitter sample exceeding 2 × σ_{JITTER}. As such, scaling σ_{JITTER} by four to six is an even better choice.

When a phase transient occurs that exceeds the prescribed value, one or both of the following two events occurs, depending on the state of the enable step detect reference fault bit in the operational control Channel 0 and Channel 1 (DPLL0 and DPLL1) sections of the register map:

- Logic 0: the DPLL initiates a new acquisition sequence.
- Logic 1: the reference monitor is reset.

When the enable step detect reference fault bit is Logic 0 (default), detection of a phase step causes only the first event to occur. By initializing a new DPLL acquisition sequence, the DPLL can take advantage of the fast acquisition feature, assuming it is active, which is especially helpful for very low loop bandwidth applications. In addition, a new acquisition manages the impact of the phase step by either building out the phase or slewing to the new phase in a hitless manner.

When the enable step detect reference fault bit is Logic 1, detection of a phase step causes both events to occur. Because exceeding the phase step threshold in this case implies an external switch to a new reference, resetting the reference monitor forces it to establish new reference statics.

The phase transient threshold detector provides the user with a live status bit in the status readback PLLx section of the register map, as well as a latched status bit in the IRQ map DPLLx read section of the register map. The DPLLx phase step detect bit (where x is 0 or 1) latches to Logic 1 on threshold violation of the phase transient threshold detector. Because this is a latched bit, the user must clear it via the IRQ map DPLLx clear section of the register map to obtain visibility of subsequent threshold violations detected by the phase step detector.

Mitigating Phase Step Limit False Positives

When enabled, the phase transient threshold detector operates continuously, as long as the associated reference is the active reference for the DPLL (DPLL0 or DPLL1, assuming the DPLL is frequency locked. As such, any phase disturbance at the input to the phase detector of the DPLL is subject to violating the threshold of the phase transient threshold detector. This violation includes a user induced phase adjustment via the DPLLx phase offset bit field or the Profile x phase skew bit field. To mitigate false triggering of the phase transient threshold detector (when enabled) due to intentional phase adjustments, the user can employ the phase slew rate limiter DPLL.

The following formula relates the maximum phase slew rate (MPSR) necessary to prevent inadvertent triggering of the phase transient threshold detector:

$$MPSR = (P + F)/7$$

where:
P is the phase transient threshold detector limit (in picoseconds).
F is the frequency (in Hz) at the input of the DPLL phase detector.

Note that this formula ignores other contributors to phase error, including jitter, frequency offset, and propagation delay variation.

If the user has a prior knowledge of the timing of an external event, such as the switching of the reference input clock source via an external mux, rather than using the phase transient step detector, a more robust solution is to invalidate the associated reference manually. To do so, force a reference fault condition via the appropriate operational controls bit field. Using this method imposes the least impact on the steady state operation of the device. The only steady state impact is that the validation timer of the associated reference must be set to a duration that is longer (with suitable margin) than the duration between the assertion of the force fault condition and the occurrence of the external event.

SKEW ADJUSTMENT

Skew adjustment allows the user to associate a fixed phase offset with a reference input, which, for example, is useful in applications with redundant global navigation satellite system (GNSS)/ global positioning system (GPS) reference sources. That is, a user may have two or more GNSS/GPS sources that have identical frequency but may exhibit a fixed time offset due to a mismatch between antenna cable lengths.

To activate the skew adjustment feature, program the 24-bit signed Profile x phase skew bit field (where x is the profile number, Profile 0 to Profile 7). The default value is zero, which disables the skew adjustment feature. A nonzero value enables the skew adjustment feature and denotes the desired time skew in units of picoseconds per the following equation:

$$Time\ Skew = Profile\ x\ Phase\ Skew \times 10^{-12}$$

As an example, determine the value of the Profile x phase skew bit field necessary for a time skew of −35 ns. Solving the previous equation for the Profile x phase skew yields

$$Profile\ x\ Phase\ Skew = (-35 \times 10^{-9})/10^{-12}$$

$$= -35{,}000$$

= 0xFF7748 (hexadecimal)

EEPROM USAGE

OVERVIEW

The AD9544 supports an external, I²C-compatible, EEPROM with dedicated access. With some restrictions, the AD9544 also supports multidevice access to a single external EEPROM on a shared I²C common bus. The AD9544 has an on-chip I²C master to interface to the EEPROM through the Mx pins.

Because the default register settings of the AD9544 do not define a particular frequency translation, the user must factory program the EEPROM content before it can be downloaded to the register map (either automatically or manually). If desired, the user can store custom device configurations by manually forcing an upload to the EEPROM via the register map.

EEPROM CONTROLLER GENERAL OPERATION

EEPROM Controller

The EEPROM controller governs all aspects of communication with the EEPROM. Because the I²C interface uses a 100 kHz (normal mode) or 400 kHz (fast mode) communication link, the controller runs synchronous to an on-chip generated clock source suitable for use as the I²C serial clock. The on-chip oscillator enables asynchronously immediately on a request for activation of the controller. When the oscillator starts, it notifies the controller of its availability, and the controller activates. After the requested controller operation is complete, the controller disables the clock generator and returns to an idle state.

EEPROM Download

An EEPROM download transfers contents from the EEPROM to the AD9544 programming registers and invokes specific actions per the instructions stored in the EEPROM (see Table 31). Automatic downloading is the most common method for initiating an EEPROM download sequence, which initiates at power-up of the AD9544, provided Pin M3 is Logic 1 at power-up (see the Multifunction Pins at Reset/Power-Up section). Alternatively, instead of cycling power to the AD9544 to initiate an EEPROM download, the user can force the RESETB pin to Logic 0, force Pin M3 to Logic 1, and then return the RESETB pin to Logic 1 and remove the drive source from Pin M3.

The user can also request an EEPROM download on demand (that is, without resetting or cycling power to the AD9544) by writing a Logic 1 to the EEPROM load bit in the EEPROM section of the register map.

Note that the load from EEPROM bit does not require an input/output update. Writing a Logic 1 to this bit immediately triggers a download sequence.

The EEPROM controller sets the EEPROM load in progress bit (in the general status section of the register map) to Logic 1 while the download sequence is in progress as an indication to the user that the controller is busy.

EEPROM Upload

To store the AD9544 register contents in the EEPROM, the user must write a Logic 1 to the EEPROM save bit in the EEPROM section of the register map. The EEPROM save bit does not require an input/output update. Writing a Logic 1 to this bit immediately triggers an upload sequence.

The AD9544 has the equivalent of a write protect feature in that the user must write a Logic 1 to the EEPROM write enable bit (in the EEPROM section of the register map) prior to requesting an upload to the EEPROM. Attempting to upload to the EEPROM without first setting the EEPROM write enable bit results in a fault indication (that is, the AD9544 asserts the EEPROM fault bit in the general status section of the register map).

A prerequisite to an EEPROM upload is the existence of an upload sequence stored in the 15-byte EEPROM sequence section of the register map. That is, the user must store a series of upload instructions (see the EEPROM Instruction Set section) in the EEPROM sequence section of the register map prior to executing an EEPROM upload.

The EEPROM controller performs an upload sequence by reading the instructions stored in the EEPROM sequence section of the register map byte by byte and executing them in order. That is, the data stored in the EEPROM sequence section of the register map are instructions to the EEPROM controller on what to store in the EEPROM (including operational commands and AD9544 register data).

Note that the EEPROM controller sets the EEPROM save in progress bit (in the status readback section of the register map) to Logic 1 while the upload sequence is in progress as an indication to the user that the controller is busy.

Because the EEPROM sequence section of the register map is only 15 bytes, it typically cannot hold enough instructions to upload a complete set of AD9544 data to the EEPROM. Therefore, most upload sequences necessitate that the user upload a series of subsequences. For example, to accomplish a required upload sequence consisting of 20 bytes of instructions, perform the following procedure:

1. Write the first 14 instructions to the EEPROM sequence registers in the EEPROM section of the register map, with the 15th instruction being a pause instruction (see Table 31).
2. Initiate an EEPROM upload by writing Logic 1 to the EEPROM save bit. When the EEPROM controller reaches the pause instruction, it suspends the upload process and waits for another assertion of the EEPROM save bit.
3. While the controller pauses, write the remaining six bytes of the upload sequence into the EEPROM sequence registers in the EEPROM section of the register map, followed by an end of data instruction (see Table 31).
4. Initiate an EEPROM upload by writing Logic 1 to the EEPROM save bit. When the EEPROM controller reaches the end of data instruction, it terminates the upload process.

The previous procedure is an example of an upload sequence consisting of two subsequences. Most upload sequences require more than two subsequences; however, the procedure is the same. Specifically, partition a long sequence into several subsequences by using the pause instruction at the end of each subsequence and the end of data instruction at the end of the final subsequence.

EEPROM Checksum

When the EEPROM controller encounters an end of data instruction (see Table 31) during an upload sequence, it computes a 32-bit cyclic redundancy check (CRC) checksum and appends it to the stored data in the EEPROM. Similarly, when the EEPROM controller executes a download sequence, it computes a checksum on the fly. At the end of a download sequence, the EEPROM controller compares the newly computed checksum to the one stored in the EEPROM. If the two checksums do not match, the EEPROM controller asserts the EEPROM CRC error bit in the status readback section of the register map.

To minimize the possibility of downloading a corrupted EEPROM data set, the user can execute a checksum test by asserting the verify EEPROM CRC bit in the EEPROM section of the register map, which causes the EEPROM controller to execute a download sequence, but without actually transferring data to the AD9544 registers. The controller still computes an on the fly checksum, performs the checksum comparison, and asserts the EEPROM CRC error bit if the checksums do not match. Therefore, after the device deasserts the EEPROM load in progress bit, the user can check the EEPROM CRC fault bit to determine if the test passed (that is, EEPROM CRC error = 0). However, even if the test fails, device operation is unaffected because there was no transfer of data to the AD9544 registers.

EEPROM Header

The EEPROM controller adds a header to stored data that carries information related to the AD9544, such as

- Vendor ID
- Chip type
- Product ID
- Chip revision

At the beginning of an EEPROM download sequence, the EEPROM controller compares the stored header values to the values in the corresponding registers of the AD9544. If the controller detects a mismatch, it asserts the EEPROM fault bit in the status readback section of the register map and terminates the download.

EEPROM INSTRUCTION SET

The EEPROM controller relies on a combination of instructions and data. An instruction consists of a single byte (eight bits). Some instructions require subsequent bytes of payload data. That is, some instructions are self contained operations, whereas others are directions on how to process subsequent payload data. A summary of the EEPROM controller instructions is shown in Table 31.

When the controller downloads the EEPROM contents to the AD9544 registers, it does so in a linear fashion, stepping through the instructions stored in the EEPROM. However, when the controller uploads to the EEPROM, the sequence is a nonlinear combination of various parts of the register map, as well as computed data that the controller calculates on the fly.

Table 31. EEPROM Controller Instruction Set Summary

Instruction Code (Hexadecimal)	Response	Comments
0x00 to 0x7F	Register transfer	Requires a 2-byte register address suffix
0x80	Input/output update	Assert input/output update during download
0x81 to 0x8F	Not applicable	Undefined
0x90	Calibrate APLLs	Calibrate the system clock PLL, APLL0, and APLL1 during download
0x91	Calibrate the system clock PLL	Calibrate only the system clock PLL during download
0x92	Calibrate APLL0	Calibrate only APLL0 during download
0x93	Calibrate APLL1	Calibrate only APLL1 during download
0x94 to 0x97	Not applicable	Reserved/unused
0x98	Force freerun	Force DPLL0 and DPLL1 to freerun during download
0x99	Force DPLL0 freerun	Force only DPLL0 to freerun during download
0x9A	Force DPLL1 freerun	Force only DPLL1 to freerun during download
0x9B to 0x9F	Not applicable	Reserved/unused
0xA0	Synchronize outputs	Synchronize all distribution outputs during download
0xA1	Synchronize Channel 0	Synchronize only Channel 0 distribution outputs during download
0xA2	Synchronize Channel 1	Synchronize only Channel 1 distribution outputs during download
0xA3 to 0xAF	Not applicable	Reserved/unused
0xB0	Clear condition	Apply Condition 0 and reset the condition map
0xB1 to 0xBF	Set condition	Apply Condition 1 to Condition 15, respectively
0xC0 to 0xFD	Not applicable	Undefined
0xFE	Pause	Pause the EEPROM upload sequence
0xFF	End of data	Marks the end of the instruction sequence

Register Transfer Instructions (0x00 to 0x7F)

Instructions with a hexadecimal value from 0x00 through 0x7F indicate a register transfer operation. Register transfer instructions require a 2-byte suffix, which constitutes the starting address of the AD9544 register targeted for transfer (where the first byte to follow the data instruction is the most significant byte of the register address). When the EEPROM controller encounters a data instruction, it knows to interpret the next two bytes as the register map target address.

Note that the value of the register transfer instruction encodes the payload length (number of bytes). That is, the EEPROM controller knows how many register bytes to transfer to/from the indicated register by adding 1 to the instruction value. For example, Data Instruction 0x1A has a decimal value of 26; therefore, the controller knows to transfer 27 bytes to and from the target register (that is, one more than the value of the instruction).

Input/Output Update Instruction (0x80)

When the EEPROM controller encounters an input/output update instruction during an upload sequence, it stores the instruction in EEPROM. When encountered during a download sequence, however, the EEPROM controller initiates an input/output update event (equivalent to the user asserting the IO_UPDATE bit in the serial port section of the register map).

Device Action Instructions (0x90 to 0xAF)

When the EEPROM controller encounters a device action instruction during an upload sequence, it stores the instruction in EEPROM. When encountered during a download sequence, however, the EEPROM controller executes the specified action per Table 31.

Conditional Instructions (0xB0 to 0xBF)

The conditional instructions allow conditional execution of EEPROM instructions during a download sequence. During an upload sequence, however, they are stored as is and have no effect on the upload process.

Conditional processing makes use of four elements:

- The conditional instruction.
- The condition value.
- The condition ID.
- The condition map.

Conditional Instruction

When the EEPROM controller encounters a conditional instruction during an upload sequence, it stores the instruction in the EEPROM. When the EEPROM controller detects a conditional instruction during a download sequence, it affects the condition map as well as the outcome of conditional processing.

Condition Value

The condition value has a one to one correspondence to the conditional instruction. Specifically, the condition value is the value of the conditional instruction minus 0xB0. Therefore, condition values have a range of 0 to 15. The EEPROM controller uses condition values in conjunction with the condition map, while the user uses a condition value to populate the EEPROM load condition bit field of the register map with a condition ID.

Condition ID

The condition ID is the value stored in the 4-bit EEPROM load condition bit field in the EEPROM section of the register map. The EEPROM controller uses the condition ID in conjunction with the condition map to determine which instructions to execute or ignore during a download sequence.

Condition Map

The condition map is a table maintained by the EEPROM controller consisting of a list of condition values. When the EEPROM controller encounters a conditional instruction during a download sequence, it determines the corresponding condition value of the instruction (0 to 15). If the condition value is nonzero, the EEPROM controller places the condition value in the condition map. Conversely, if the condition value is zero, the controller clears the condition map and applies Condition 0. Condition 0 causes all subsequent instructions to execute unconditionally (until the controller encounters a new conditional instruction that causes conditional processing).

Conditional Processing

While executing a download sequence, the EEPROM controller executes or skips instructions depending on the condition ID and the contents of the condition map (except for the conditional and end of data instructions, which always execute unconditionally).

If the condition map is empty or the condition ID is zero, all instructions execute unconditionally during download. However, if the condition ID is nonzero and the condition map contains a condition value matching the condition ID, the EEPROM controller executes the subsequent instructions. Alternatively, if the condition ID is nonzero but the condition map does not contain a condition value matching the condition ID, the EEPROM controller skips instructions until it encounters a conditional instruction with a condition value of zero or a condition value matching the condition ID.

Note that the condition map allows multiple conditions to exist at any given moment. This multiconditional processing mechanism enables the user to have one download instruction sequence with many possible outcomes, depending on the value of the condition ID and the order in which the controller encounters conditional instructions. An example of the use of conditional processing is shown in Table 32.

Table 32. Example Conditional Processing Sequence

Instruction	Operation
0x00 to 0x7F	A sequence of register transfer instructions that execute unconditionally
0xB1	Apply Condition 1
0x00 to 0x7F	A sequence of register transfer instructions that execute only if the condition ID is 1
0xB2	Apply Condition 2
0xB3	Apply Condition 3
0x00 to 0x7F	A sequence of register transfer instructions that execute only if the condition ID is 1, 2, or 3
0x91	Calibrate the system clock PLL
0xB0	Clear condition map
0x80	Input/output update
0xFF	Terminate sequence

Pause Instruction (0xFE)

The EEPROM controller only recognizes the pause instruction during an upload sequence. Upon encountering a pause instruction, the EEPROM controller enters an idle state, but preserves the current value of the EEPROM address pointer.

One use of the pause instruction is for saving multiple, yet distinct, values of the same AD9544 register, which is useful for sequencing power-up conditions.

The pause instruction is also useful for executing an upload sequence requiring more space than is available in the EEPROM sequence registers in the EEPROM section of the register map (see the EEPROM Upload section).

End of Data Instruction (0xFF)

When the EEPROM controller encounters an end of data instruction during an upload sequence, it stores the instruction in EEPROM along with the computed checksum, clears the EEPROM address pointer, and then enters an idle state. When encountered during a download sequence, however, the EEPROM controller clears the EEPROM address pointer, verifies the checksum, and then enters an idle state.

Note that during EEPROM downloads, condition instructions always execute unconditionally.

MULTIDEVICE SUPPORT

Multidevice support enables multiple AD9544 devices to share the contents of a single EEPROM. There are two levels of multidevice support. Level 1 supports a configuration where multiple AD9544 devices share a single EEPROM through a dedicated I²C bus. Level 2 supports a configuration where multiple AD9544 devices share a single EEPROM connected to a common I²C bus that includes other I²C master devices. Figure 51 and Figure 52 show the Level 1 and Level 2 configurations, respectively.

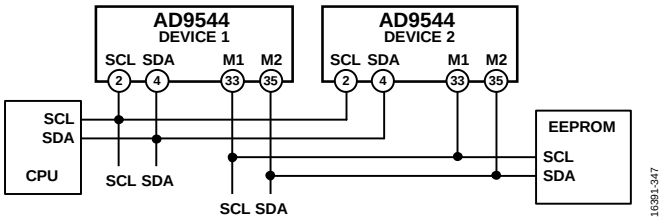


Figure 51. Level 1 Multidevice Configuration

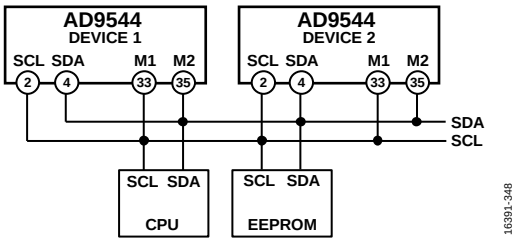


Figure 52. Level 2 Multidevice Configuration

Multidevice Bus Arbitration

The EEPROM controller implements bus arbitration by continuously monitoring the SDA and SCL bus signals for start and stop conditions. The controller can determine whether the bus is idle or busy. If the bus is busy, the EEPROM controller delays its pending I²C transfer until a stop condition indicates that the bus is available.

Bus arbitration is essential in cases where two I²C master devices simultaneously attempt an I²C transfer. For example, if one I²C master detects that SDA is Logic 0 when it is intended to be Logic 1, it assumes that another I²C master is active and immediately terminates its own attempt to transfer data. Similarly, if one I²C master detects that SCL is Logic 0 prior to entering a start state, it assumes that another I²C master is active and stalls its own attempt to drive the bus.

In either case, the prevailing I²C master completes its current transaction before releasing the bus. Because the postponed I²C master continuously monitors the bus for a stop condition, it attempts to seize the bus and carry out the postponed transaction on detection of such a stop condition.

The EEPROM controller includes an arbitration timer to optimize the bus arbitration process. Specifically, when the EEPROM controller postpones an I²C transfer as a result of detecting bus contention, it starts the arbitration timer. If the EEPROM controller fails to detect a stop condition within 255 SCL cycles, it attempts to force another transaction. If the bus is still busy, the EEPROM controller restarts the arbitration timer, and the process continues until the EEPROM controller eventually completes the pending transaction.

Multidevice Configuration Example

Consider two AD9544 devices (Device 1 and Device 2) that share a single EEPROM, and assume both devices have a common PLL0 configuration but differing PLL1 configurations.

A template for an EEPROM sequence that accomplishes this configuration is shown in Table 33. The sequence relies on conditional processing to differentiate between Device 1 and Device 2. Therefore, the user must program the condition ID of both devices prior to executing an EEPROM download. Specifically, the user must program the EEPROM load condition bit field of Device 1 with a condition ID of 1 and Device 2 with a condition ID of 2.

Table 33. Template for a Multidevice EEPROM Sequence

Instructions	Comment
0x00 to 0x7F	A sequence of register transfer instructions associated with the PLL0 configuration common to both devices
0xB1	Apply Condition 1
0x00 to 0x7F	A sequence of register transfer instructions associated with the PLL1 configuration specific to Device 1
0xB0	Clear the condition map
0xB2	Apply Condition 2
0x00 to 0x7F	A sequence of register transfer instructions associated with the PLL1 configuration specific to Device 2
0xB0	Clear the condition map
0x80	Input/output update
0xFF	End of sequence

SERIAL CONTROL PORT

The AD9544 serial control port is a flexible, synchronous serial communications port that provides a convenient interface to many industry-standard microcontrollers and microprocessors. The AD9544 serial control port is compatible with most synchronous transfer formats, including I²C, Motorola SPI, and Intel SSR protocols. The serial control port allows read/write access to the AD9544 register map.

The AD9544 uses the Analog Devices unified SPI protocol (see the Analog Devices Serial Control Interface Standard). The unified SPI protocol guarantees that all new Analog Devices products using the unified protocol have consistent serial port characteristics. The SPI port configuration is programmable via Register 0x00.

Unified SPI differs from the SPI port found on older Analog Devices products, such as the AD9557 and AD9558, in the following ways:

- Unified SPI does not have byte counts. A transfer is terminated when the CSB pin goes high. The W1 and W0 bits in the traditional SPI become the A12 and A13 bits of the register address. This is similar to streaming mode in the traditional SPI.
- The address ascension bit (Register 0x000) controls whether register addresses are automatically incremented or decremented regardless of the LSB/MSB first setting. In traditional SPI, LSB first mode dictated auto-incrementing and MSB first mode dictated auto-decrementing of the register address.
- The first 16 register addresses of devices that adhere to the unified serial port have a consistent structure.

SPI/I²C PORT SELECTION

Although the AD9544 supports both the SPI and I²C serial port protocols, only one is active following power-up (as determined by the M4 multifunction pin during the start-up sequence). The only way to change the serial port protocol is to reset (or power cycle) the device. See Table 27 for the I²C address assignments.

SPI SERIAL PORT OPERATION

Pin Descriptions

The serial clock (SCLK) pin serves as the serial shift clock. This pin is an input. SCLK synchronizes serial control port read and write operations. The rising edge SCLK registers write data bits, and the falling edge registers read data bits. The SCLK pin supports a maximum clock rate of 50 MHz.

The SPI port supports both 3-wire (bidirectional) and 4-wire (unidirectional) hardware configurations and both MSB first and LSB first data formats. Both the hardware configuration and data format features are programmable. The 3-wire mode uses the serial data input/output (SDIO) pin for transferring data in both directions. The 4-wire mode uses the SDIO pin for transferring data to the AD9544, and the SDO pin for transferring data from the AD9544.

The chip select (CSB) pin is an active low control that gates read and write operations. Assertion (active low) of the CSB pin initiates a write or read operation to the AD9544 SPI port. The user can transfer any number of data bytes in a continuous stream. The register address is automatically incremented or decremented based on the setting of the address ascension bit (Register 0x00). The user must deassert the CSB pin following the last byte transferred, thereby ending the stream mode. This pin is internally connected to a 10 kΩ pull-up resistor. When CSB is high, the SDIO and SDO pins enter a high impedance state.

Implementation Specific Details

The Analog Devices Serial Control Interface Standard provides a detailed description of the unified SPI protocol and covers items such as timing, command format, and addressing. The unified SPI protocol defines the following device specific items:

- Analog Devices unified SPI protocol revision: 1.0
- Chip type: 0x5
- Product ID: 0x012
- Physical layer: 3-wire and 4-wire supported and 1.5 V, 1.8 V, and 2.5 V operation supported
- Optional single-byte instruction mode: not supported
- Data link: not used
- Control: not used

Communication Cycle—Instruction Plus Data

The unified SPI protocol consists of a two-part communication cycle. The first part is a 16-bit instruction word coincident with the first 16 SCLK rising edges. The second part is the payload, the bits of which are coincident with SCLK rising edges. The instruction word provides the AD9544 serial control port with information regarding the payload. The instruction word includes the R/$\overline{W}$ bit that indicates the direction of the payload transfer (that is, a read or write operation). The instruction word also indicates the starting register address of the first payload byte.

Write

When the instruction word indicates a write operation, the payload is written into the serial control port buffer of the AD9544. Data bits are registered on the rising edge of SCLK. Generally, it does not matter what data is written to blank registers; however, it is customary to use 0s. Note that the user must verify that all reserved registers within a specific range have a default value of 0x00; however, Analog Devices makes every effort to avoid having reserved registers with nonzero default values.

Most of the serial port registers are buffered; therefore, data written into buffered registers does not take effect immediately. To transfer buffered serial control port contents to the registers that actually control the device requires an additional operation, an IO_UPDATE operation, implemented in one of two ways. One is to write a Logic 1 to Register 0x0F, Bit 0 (this bit is an

autoclearing bit). The other is to use an external signal via an appropriately programmed multifunction pin. The user can change as many register bits as desired before executing an input/output update. The input/output update operation transfers the buffer register contents to their active register counterparts.

Read

If the instruction word indicates a read operation, the next N × 8 SCLK cycles clock out the data starting from the address specified in the instruction word, where N is the number of data bytes to read. Read data appears on the appropriate data pin (SDIO or SDO) on the falling edge of SCLK. The user must latch the read data on the rising edge of SCLK. Note that the internal SPI control logic does not skip over blank registers during a readback operation.

A readback operation takes data from either the serial control port buffer registers or the active registers, as determined by Register 0x01, Bit 5.

SPI Instruction Word (16 Bits)

The MSB of the 16-bit instruction word is R/$\overline{W}$, which indicates whether the ensuing operation is read or write. The next 15 bits are the register address (A14 to A0), which indicates the starting register address of the read/write operation (see Table 35). Note that SPI controller ignores A14, treating it as Logic 0, because the AD9544 has no register addresses requiring more than a 14-bit address word.

SPI MSB-/LSB-First Transfers

The AD9544 instruction word and payload can be transferred MSB first or LSB first. The default for the AD9544 is MSB first. To invoke LSB first mode, write a Logic 1 to Register 0x00, Bit 6. Immediately after invoking LSB first mode, subsequent serial control port operations are LSB first.

Address Ascension

If the address ascension bit (Register 0x0000, Bit 5) is Logic 0, serial control port register addressing decrements from the specified starting address toward Address 0x0000. If the address ascension bit (Register 0x0000, Bit 5) is Logic 1, serial control port register addressing increments from the starting address toward Address 0x3A3B. Reserved addresses are not skipped during multibyte input/output operations; therefore, write the default value to a reserved register and Logic 0s to unmapped registers. Note that it is more efficient to issue a new write command than to write the default value to more than two consecutive reserved (or unmapped) registers.

Table 34. Streaming Mode (No Addresses Skipped)

Address Ascension	Stop Sequence
Increment	0x0000 … 0x3A3B
Decrement	0x3A3B … 0x0000

Table 35. Serial Control Port, 16-Bit Instruction Word

MSB															LSB
I15	I14	I13	I12	I11	I10	I9	I8	I7	I6	I5	I4	I3	I2	I1	I0
R/$\overline{W}$	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0

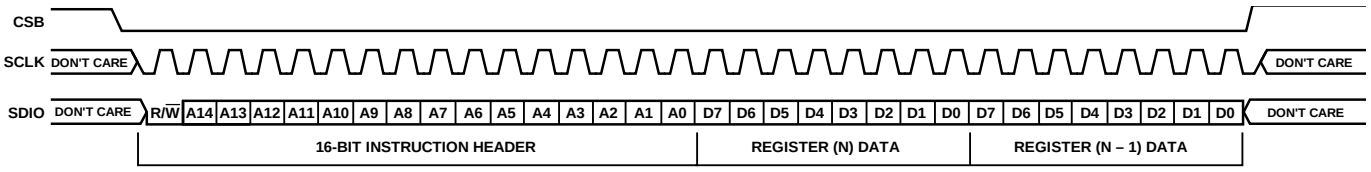


Figure 53. Serial Control Port Write—MSB First, Address Decrement, Two Bytes of Data

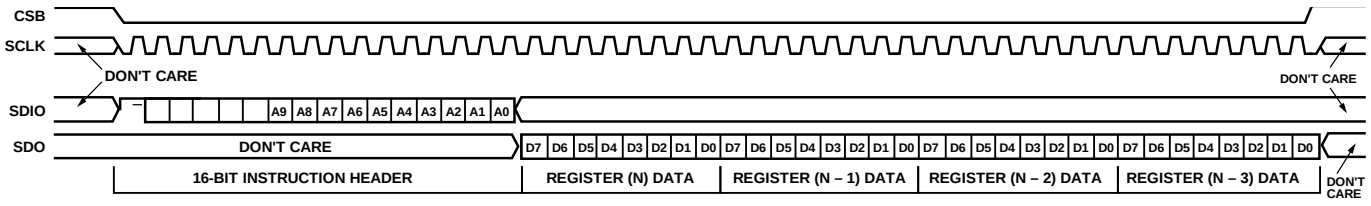


Figure 54. Serial Control Port Read—MSB First, Address Decrement, Four Bytes of Data

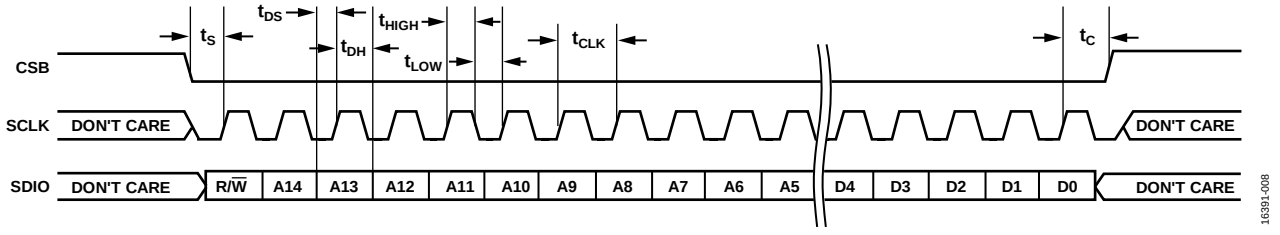


Figure 55. Timing Diagram for Serial Control Port Write—MSB First

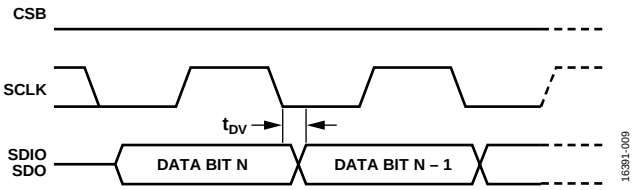


Figure 56. Timing Diagram for Serial Control Port Register Read—MSB First

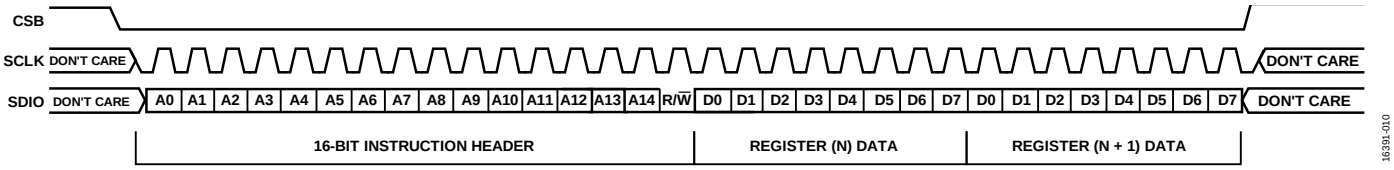


Figure 57. Serial Control Port Write—LSB First, Address Increment, Two Bytes of Data

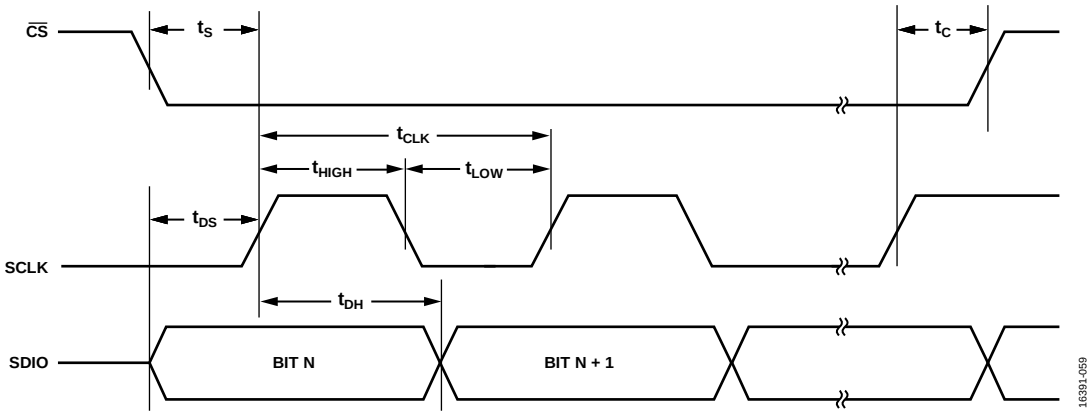


Figure 58. Serial Control Port Timing—Write

Table 36. Serial Control Port Timing

Parameter	Description
t_{DS}	Setup time between data and the rising edge of SCLK
t_{DH}	Hold time between data and the rising edge of SCLK
t_{CLK}	Period of the clock
t_S	Setup time between the CSB falling edge and the SCLK rising edge (start of the communication cycle)
t_C	Setup time between the SCLK rising edge and CSB rising edge (end of the communication cycle)
t_{HIGH}	Minimum period that SCLK is in a logic high state
t_{LOW}	Minimum period that SCLK is in a logic low state
t_{DV}	SCLK to valid SDIO (see Figure 56)

I²C SERIAL PORT OPERATION

The I²C interface is popular because it requires only two pins and easily supports multiple devices on the same bus. Its main disadvantage is its maximum programming speed of 400 kbps. The AD9544 I²C port supports the 400 kHz fast mode as well as the 100 kHz standard mode.

To support 1.5 V, 1.8 V, and 2.5 V I²C operation, the AD9544 does not strictly adhere to every requirement in the original I²C specification. In particular, it does not support specifications such as slew rate limiting and glitch filtering. Therefore, the AD9544 is I²C compatible, but not necessarily fully I²C compliant.

The AD9544 I²C port consists of a serial data line (SDA) and a serial clock line (SCL). In an I²C bus system, the AD9544 connects to the serial bus (data bus SDA and clock bus SCL) as a slave device; that is, the AD9544 does not generate an I²C clock. The AD9544 uses direct 16-bit memory addressing rather than 8-bit memory addressing, which is more common.

The AD9544 allows up to four unique slave devices to occupy the I²C bus via a 7-bit slave address transmitted as part of an I²C packet. Only the device with a matching slave address responds to subsequent I²C commands. Table 37 lists the supported device slave addresses.

I²C Bus Characteristics

A summary of the various I²C abbreviations appears in Table 37.

Table 37. I²C Bus Abbreviation Definitions

Abbreviation	Definition
S	Start
Sr	Repeated start
P	Stop
A	Acknowledge
$\overline{A}$	Nonacknowledge
$\overline{W}$	Write
R	Read

An example of valid data transfer appears in Figure 59. One clock pulse is required for each data bit transferred. The data on the SDA line must be stable during the high period of the clock. The high or low state of the data line can change only when the clock signal on the SCL line is low.

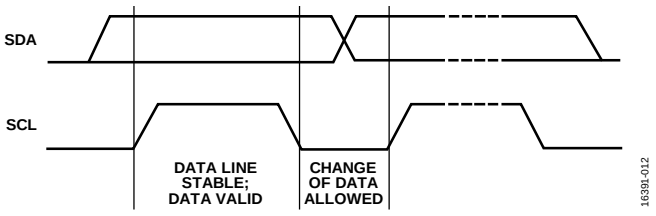


Figure 59. Valid Bit Transfer

Start and stop functionality appears in Figure 60. The start condition is a high to low transition on the SDA line while SCL is high. The master always generates the start condition to initialize a data transfer. The stop condition is a low to high transition on the SDA line while SCL is high. The master always generates the stop condition to terminate a data transfer. The SDA line must always transfer eight bits (one byte). Each byte must be followed by an acknowledge bit; bytes are sent MSB first.

The acknowledge bit (A) is the ninth bit attached to any 8-bit data byte. An acknowledge bit is always generated by the receiver to inform the transmitter that the byte has been received. Acknowledgement consists of pulling the SDA line low during the ninth clock pulse after each 8-bit data byte.

The nonacknowledge bit ($\overline{A}$) is the ninth bit attached to any 8-bit data byte. A nonacknowledge bit is always generated by the receiver to inform the transmitter that the byte has not been received. Nonacknowledgment consists of leaving the SDA line high during the ninth clock pulse after each 8-bit data byte. After issuing a nonacknowledge bit, the AD9544 I²C state machine goes into an idle state.

Data Transfer Process

The master initiates data transfer by asserting a start condition, which indicates that a data stream follows. All I²C slave devices connected to the serial bus respond to the start condition.

The master then sends an 8-bit address byte over the SDA line, consisting of a 7-bit slave address (MSB first) plus a R/$\overline{W}$ bit. This bit determines the direction of the data transfer, that is, whether data is written to or read from the slave device (Logic 0 indicates write, and Logic 1 indicates read).

The peripheral whose address corresponds to the transmitted address responds by sending an acknowledge bit. All other devices on the bus remain idle while the selected device waits for data to be read from or written to it. If the R/$\overline{W}$ bit is Logic 0, the master (transmitter) writes to the slave device (receiver). If the R/$\overline{W}$ bit is Logic 1, the master (receiver) reads from the slave device (transmitter). The format for these commands appears in the Data Transfer Format section.

Data is then sent over the serial bus in the format of nine clock pulses, one data byte (eight bits) from either master (write mode) or slave (read mode), followed by an acknowledge bit from the receiving device. The protocol allows a data transfer to consist of any number of bytes (that is, the payload size is unrestricted). In write mode, the first two data bytes immediately after the slave address byte are the internal memory (control registers) address bytes (the higher address byte first). This addressing scheme gives a memory address of up to $2^{16} - 1 = 65{,}535$. The data bytes after these two memory address bytes are register data written to or read from the control registers. In read mode, the data bytes following the slave address byte consist of register data written to or read from the control registers.

When all the data bytes are read or written, stop conditions are established. In write mode, the master device (transmitter) asserts a stop condition to end data transfer during the clock pulse following the acknowledge bit for the last data byte from the slave device (receiver). In read mode, the master device (receiver) receives the last data byte from the slave device (transmitter) but does not pull SDA low during the ninth clock pulse (a nonacknowledge bit). By receiving the nonacknowledge bit, the slave device knows that the data transfer is finished and enters idle mode. The master device then takes the data line low during the low period before the 10th clock pulse, and high during the 10th clock pulse to assert a stop condition.

A start condition can be used instead of a stop condition. Furthermore, a start or stop condition can occur at any time, and partially transferred bytes are discarded.

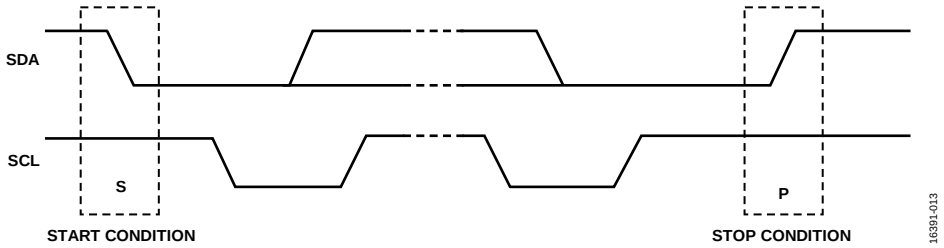


Figure 60. Start and Stop Conditions

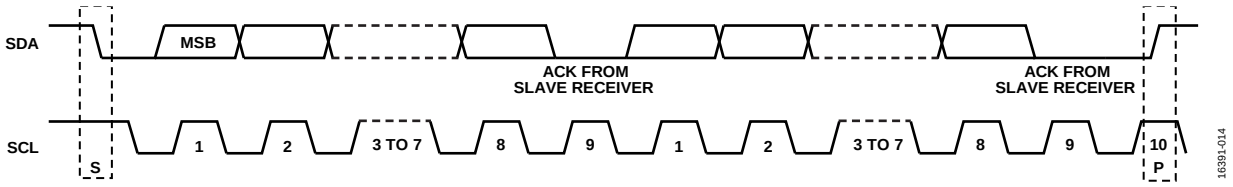


Figure 61. Acknowledge Bit

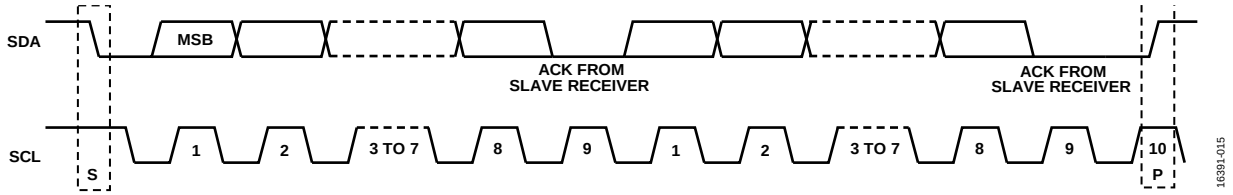


Figure 62. Data Transfer Process (Master Write Mode, 2-Byte Transfer)

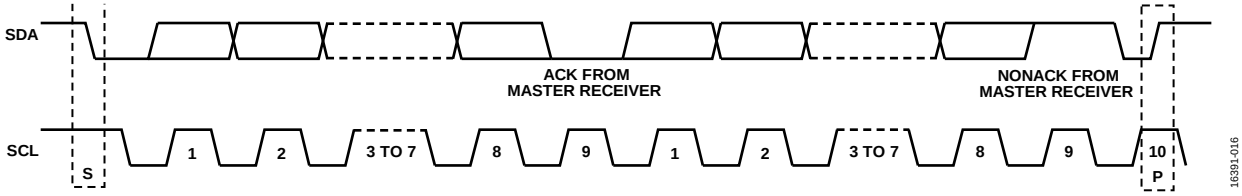


Figure 63. Data Transfer Process (Master Read Mode, 2-Byte Transfer), First Acknowledge From Slave

Data Transfer Format

The write byte format is used to write a register address to the RAM starting from the specified RAM address (see Table 38). The send byte format is used to set up the register address for subsequent reads (see Table 39). The receive byte format is used to read the data byte(s) from RAM starting from the current address (see Table 40). The read byte format is the combined format of the send byte and the receive byte (see Table 41).

Table 38. Write Byte Format

S	Slave address	$\overline{W}$	A	RAM address high byte	A	RAM address low byte	A	RAM Data 0	A	RAM Data 1	A	RAM Data 2	A	P

Table 39. Send Byte Format

S	Slave address	$\overline{W}$	A	RAM address high byte	A	RAM address low byte	A	P

Table 40. Receive Byte Format

S	Slave address	R	A	RAM Data 0	A	RAM Data 1	A	RAM Data 2	$\overline{A}$	P

Table 41. Read Byte Format

S	Slave address	$\overline{W}$	A	RAM address high byte	A	RAM address low byte	A	Sr	Slave address	R	A	RAM Data 0	A	RAM Data 1	A	RAM Data 2	$\overline{A}$	P

I^2C Serial Port Timing

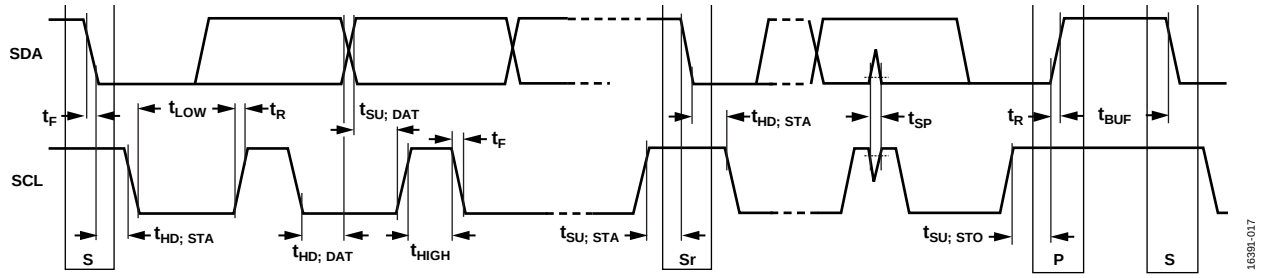
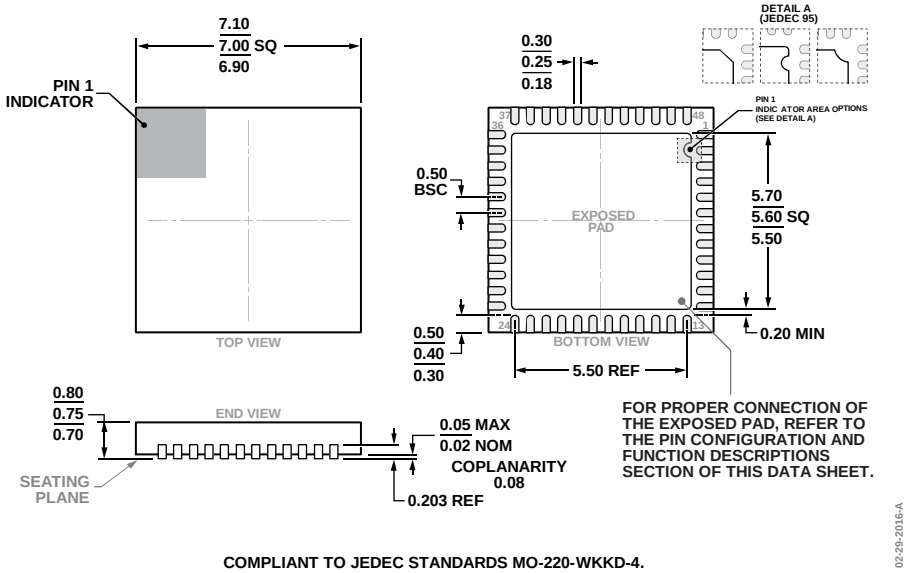


Figure 64. I^2C Serial Port Timing

Table 42. I^2C Timing Definitions

Parameter	Description
f_{SCL}	Serial clock
t_{BUF}	Bus free time between stop and start conditions
$t_{HD; STA}$	Repeated hold time start condition
$t_{SU; STA}$	Repeated start condition setup time
$t_{SU; STO}$	Stop condition setup time
$t_{HD; DAT}$	Data hold time
$t_{SU; DAT}$	Data setup time
t_{LOW}	SCL clock low period
t_{HIGH}	SCL clock high period
t_R	Minimum/maximum receive SCL and SDA rise time
t_F	Minimum/maximum receive SCL and SDA fall time
t_{SP}	Pulse width of voltage spikes that must be suppressed by the input filter

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WKKD-4.

Figure 65. 48-Lead Lead Frame Chip Scale Package [LFCSP]
7 mm × 7 mm Body and 0.75 mm Package Height
(CP-48-13)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Package Description	Package Option
AD9544BCPZ	−40°C to +85°C	48-Lead Lead Frame Chip Scale Package [LFCSP]	CP-48-13
AD9544BCPZ-REEL7	−40°C to +85°C	48-Lead Lead Frame Chip Scale Package [LFCSP]	CP-48-13
AD9544/PCBZ		Evaluation Board	

[1] Z = RoHS Compliant Part.

I²C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

©2017 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.
D16391-0-10/17(0)